Technical documentation

13 Design \＆ development

Texas
ADC32RF80，ADC32RF83
INSTRUMENTS

## ADC32RF8x 双通道，3GSPS 电信接收器和反馈器件

## 1 特性

- 14 位双通道 3GSPS ADC
- 本底噪声：－155dBFS／Hz
- 射频（RF）输入支持的频率最高可达 4.0 GHz
- 孔径抖动 ： $90 \mathrm{f}_{\mathrm{S}}$
- 通道隔离： $\mathrm{f}_{\mathrm{IN}}=1.8 \mathrm{GHz}$ 时为 95 dB
- 频谱性能（ $\mathrm{f}_{\mathrm{IN}}=900 \mathrm{MHz},-2 \mathrm{dBFS}$ ）：
－SNR：60．1dBFS
－SFDR：66dBc HD2，HD3
- SFDR：76dBc 最严重毛刺
- 频谱性能（ $\mathrm{f}_{\mathrm{IN}}=1.85 \mathrm{GHz},-2 \mathrm{dBFS}$ ）：
－SNR：58．9dBFS
－SFDR：67dBc HD2，HD3
- SFDR：76dBc 最严重毛刺
- 片上数字下变频器：
- 最多 4 个下变频器（DDC）（双频带模式）
- 每个 DDC 最多配有 3 个独立数控振荡器（NCO）
- 提供过压保护的片上输入针位
- 带有报警引脚的可编程片上功率检测器，支持自动增益控制（AGC）
- 片上抖动
- 片上输入端接电阻
- 满量程输入： $1.35 \mathrm{~V} \mathrm{~V}_{\mathrm{PP}}$
- 支持多芯片同步
- JESD204B 接口：
- 基于子类 1 的确定性延迟
- 12.5 Gbps 时每条通道具有 4 条信道
- 功率耗散：3．0GSPS 时为 $3.2 \mathrm{~W} /$ 通道
- 72 引脚 VQFN 封装（ $10 \mathrm{~mm} \times 10 \mathrm{~mm}$ ）

2 应用

- 多载波 GSM 蜂窝基础设施基站
- 电信接收器
- 数字预失真（DPD）观测接收器
- 回程接收器
- 射频中继器和分布式天线系统


## 3 说明

ADC32RF8x（ADC32RF80 和 ADC32RF83）是 14位 3GSPS 双通道电信接收器和反馈器件系列，支持输入频率高达 4 GHz 及以上的射频采样。ADC32RF8x 系列的设计旨在追求高信噪比（SNR），其在宽输入频率范围内兼具 $-155 \mathrm{dBFS} / \mathrm{Hz}$ 的噪声频谱密度与动态范围，同时可提供通道隔离。经缓冲的模拟输入配有片上端接电阻，可在较宽频率范围内提供统一输入阻抗并最大程度地降低采样和保持毛刺脉冲能量。

每条通道均可连接到一个双频带数字下变频器 （DDC），每个 DDC 最多连接三个独立的 16 位数控振荡器（NCO）用于相位相干跳频。此外，ADC 还配有前端峰值和 RMS 功率检测器及报警功能，用以支持外部自动增益控制（AGC）算法。
ADC32RF8x 支持具有基于子类 1 确定性延迟的 JESD204B 串行接口，其数据速率高达 12.5 Gbps ，每个 ADC 最多具有四条信道。该器件采用 72 引脚 VQFN 封装（ $10 \mathrm{~mm} \times 10 \mathrm{~mm}$ ），支持工业级温度范围 （ $-40^{\circ} \mathrm{C}$ 至 $+85^{\circ} \mathrm{C}$ ）。

器件信息 ${ }^{(1)}$

| 器器件型号 | 封装 | 封装尺寸（标称值 ） |
| :---: | :---: | :---: |
| ADC32RF8x | $\operatorname{VQFN}$（72） | $10.00 \mathrm{~mm} \times 10.00 \mathrm{~mm}$ |

（1）如需了解所有可用封装，请参阅数据表末尾的可订购产品附录。


简化版方框图

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## 5 Pin Configuration and Functions



图 5-1. RMP or RHH Package 72-Pin VQFN Top View
表 5-1. Pin Functions

| NAME | NO. | I/O | DESCRIPTION |
| :--- | :---: | :---: | :--- |
| INPUT, REFERENCE |  |  |  |
| INAM | 41 | I | Differential analog input for channel A |
| INAP | 42 |  |  |
| INBM | 14 |  | Differential analog input for channel B |
| INBP | 13 |  |  |
| CM | 22 | 0 | Common-mode voltage for analog inputs, 1.2 V |

表 5-1. Pin Functions (continued)

| NAME | NO. | I/O | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| CLOCK, SYNC |  |  |  |
| CLKINM | 28 | I | Differential clock input for the analog-to-digital converter (ADC). This pin has an internal differential $100-\Omega$ termination. |
| CLKINP | 27 |  |  |
| SYSREFM | 34 | I | External SYSREF input. This pin has an internal, differential $100-\Omega$ termination and requires external biasing. |
| SYSREFP | 33 |  |  |
| GPIO1 | 19 | I/O | GPIO control pin; configured through the SPI. This pin can be configured to be either a fast overrange output for channel A and B , a fast detect alarm signal from the peak power detect, or a numerically-controlled oscillator (NCO) control. GPIO 4 (pin 63) can also be configured as a single-ended SYNCB input. |
| GPIO2 | 20 |  |  |
| GPIO3 | 21 |  |  |
| GPIO4 | 63 |  |  |
| CONTROL, SERIAL |  |  |  |
| RESET | 48 | I | Hardware reset; active high. This pin has an internal 20-k $\Omega$ pulldown resistor. |
| SCLK | 6 | I | Serial interface clock input. This pin has an internal 20-k $\Omega$ pulldown resistor. |
| SDIN | 5 | I/O | Serial interface data input. This pin has an internal 20-k $\Omega$ pulldown resistor. SDIN can be data input in 4-wire mode, data input and output in 3 wire-mode. |
| SEN | 7 | 1 | Serial interface enable. This pin has an internal 20-k $\Omega$ pullup resistor to DVDD. |
| SDOUT | 11 | O | Serial interface data output in 4-wire mode |
| PDN | 50 | 1 | Power down; active high. This pin can be configured through an SPI register setting and can be configured to a fast overrange output channel B through the SPI. This pin has an internal 20-k $\Omega$ pulldown resistor. |
| DATA INTERFACE |  |  |  |
| DAOM | 62 | 0 | JESD204B serial data output for channel A |
| DA0P | 61 |  |  |
| DA1M | 59 |  |  |
| DA1P | 58 |  |  |
| DA2M | 56 |  |  |
| DA2P | 55 |  |  |
| DA3M | 54 |  |  |
| DA3P | 53 |  |  |
| DB0M | 65 | 0 | JESD204B serial data output for channel B |
| DB0P | 66 |  |  |
| DB1M | 68 |  |  |
| DB1P | 69 |  |  |
| DB2M | 71 |  |  |
| DB2P | 72 |  |  |
| DB3M | 1 |  |  |
| DB3P | 2 |  |  |
| SYNCBM | 36 | 1 | Synchronization input for the JESD204B port. This pin has an LVDS or 1.8-V logic input, an optional on-chip 100- $\Omega$ termination, and is selectable through the SPI. This pin requires external biasing. |
| SYNCBP | 35 |  |  |
| POWER SUPPLY |  |  |  |
| AVDD19 | 10, 16, 24, 31, 39, 45 | I | Analog 1.9-V power supply |
| AVDD | $\begin{gathered} 9,12,15,17,25,30 \\ 38,40,43,44,46 \end{gathered}$ | 1 | Analog 1.15-V power supply |
| DVDD | 4, 8, 47, 51, 57, 64, 70 | I | Digital 1.15 V-power supply, including the JESD204B transmitter |
| GND | $\begin{gathered} 3,18,23,26,29,32, \\ 37,49,52,60,67 \end{gathered}$ | 1 | Ground; shorted to thermal pad inside device |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) ${ }^{(1)}$

|  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage range | AVDD19 | -0.3 | 2.1 | V |
|  | AVDD | -0.3 | 1.4 |  |
|  | DVDD | -0.3 | 1.4 |  |
| Voltage applied to input pins | INAP, INAM and INBP, INBM | -0.3 | AVDD19 + 0.3 | V |
|  | CLKINP, CLKINM | -0.3 | AVDD + 0.6 |  |
|  | SYSREFP, SYSREFM, SYNCBP, SYNCBM | -0.3 | AVDD + 0.6 |  |
|  | SCLK, SEN, SDIN, RESET, PDN, GPIO1, GPIO2, GPIO3, GPIO4 | -0.2 | AVDD19 + 0.2 |  |
| Voltage applied to output pins |  | -0.3 | 2.2 | V |
| Temperature | Operating free-air, $\mathrm{T}_{\mathrm{A}}$ | -40 | 85 | ${ }^{\circ} \mathrm{C}$ |
|  | Storage, $\mathrm{T}_{\text {stg }}$ | -65 | 150 |  |

(1) Stresses beyond those listed under 节 6.1 may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under 节 6.3. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

| $\mathrm{V}_{(\text {ESD })}$ |  |  | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 |
| :--- | :--- | :---: | :---: | :---: |
|  | Charged-device model (CDM), per JEDEC specification JESD22-C101 | (2) | $\pm 500$ | V |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage ${ }^{(2)}$ | AVDD19 | 1.8 | 1.9 | 2.0 | V |
|  | AVDD | 1.1 | 1.15 | 1.25 |  |
|  | DVDD | 1.1 | 1.15 | 1.2 |  |
| Temperature | Operating free-air, $\mathrm{T}_{\mathrm{A}}$ | -40 |  | 85 | ${ }^{\circ} \mathrm{C}$ |
|  | Operating junction, $\mathrm{T}_{\mathrm{J}}$ |  | $105{ }^{(1)}$ | 125 |  |

(1) Prolonged use above this junction temperature may increase the device failure-in-time (FIT) rate.
(2) Always power up the DVDD supply (1.15 V) before the AVDD19 (1.9 V ) supply. The AVDD (1.15 V$)$ supply can come up in any order.

### 6.4 Thermal Information

| THERMAL METRIC ${ }^{(1)}$ |  | ADC32RF80 |  | UNIT |
| :---: | :---: | :---: | :---: | :---: |
|  |  | RMP (VQFN) | RHH (VQFN) |  |
|  |  | 72 PINS | 72 PINS |  |
| $\mathrm{R}_{\theta \mathrm{JA}}$ | Junction-to-ambient thermal resistance | 21.8 | 17.7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\theta \text { JC(top) }}$ | Junction-to-case (top) thermal resistance | 4.4 | 4.9 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\theta \mathrm{JB}}$ | Junction-to-board thermal resistance | 2.0 | 4.1 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\psi_{\text {JT }}$ | Junction-to-top characterization parameter | 0.1 | 0.1 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\psi_{\text {JB }}$ | Junction-to-board characterization parameter | 2.0 | 3.9 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\theta \mathrm{JC} \text { (bot) }}$ | Junction-to-case (bottom) thermal resistance | 0.2 | 0.2 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

### 6.5 Electrical Characteristics

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and chip sampling rate $=2949.12 \mathrm{MSPS}, 50 \%$ clock duty cycle, DDC-bypassed performance, $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=1.15 \mathrm{~V}, \mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| POWER CONSUMPTION ${ }^{(4)}$ (Dual-Channel Operation, Both Channels A and B are Active; Divide-by-4, Complex Output Mode ${ }^{(3)}$ ) |  |  |  |  |  |
| $\mathrm{I}_{\text {AVDD19 }}$ | 1.9-V analog supply current | $\mathrm{f}_{\mathrm{S}}=2949.12 \mathrm{MSPS}$ | 1777 | 1989 | mA |
| $\mathrm{I}_{\text {AVDD }}$ | $1.15-\mathrm{V}$ analog supply current | $\mathrm{f}_{\mathrm{S}}=2949.12 \mathrm{MSPS}$ | 970 | 1103 | mA |
| IDVDD | 1.15-V digital supply current | $\mathrm{f}_{\mathrm{S}}=2949.12 \mathrm{MSPS}$ | 1785 | 1955 | mA |
| $\mathrm{P}_{\mathrm{D}}$ | Power dissipation | $\mathrm{f}_{\mathrm{S}}=2949.12 \mathrm{MSPS}$ | 6.54 | 7.07 | W |
|  | Global power-down power dissipation |  | 360 |  | mW |
| ANALOG INPUTS |  |  |  |  |  |
|  | Resolution |  | 14 |  | Bits |
|  | Differential input full-scale |  | 1.35 |  | $V_{\text {PP }}$ |
| $\mathrm{V}_{1 \mathrm{C}}$ | Input common-mode voltage |  | $1.2{ }^{(5)}$ |  | V |
| $\mathrm{R}_{\mathrm{IN}}$ | Input resistance | Differential resistance at dc | 65 |  | $\Omega$ |
| $\mathrm{C}_{\text {IN }}$ | Input capacitance | Differential capacitance at dc | 2 |  | pF |
|  | $\mathrm{V}_{\mathrm{CM}}$ common-mode voltage output |  | 1.2 |  | V |
|  | Analog input bandwidth ( - 3-dB point) | ADC driven with $50-\Omega$ source | 3200 |  | MHz |
| ISOLATION |  |  |  |  |  |
| Crosstalk isolation between channel $A$ and channel $B^{(1)}$ |  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$ | 100 |  | dBc |
|  |  | $\mathrm{fiN}^{\mathrm{IN}}=900 \mathrm{MHz}$ | 99 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=1800 \mathrm{MHz}$ | 95 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2700 \mathrm{MHz}$ | 86 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=3500 \mathrm{MHz}$ | 85 |  |  |
| CLOCK INPUT ${ }^{(2)}$ |  |  |  |  |  |
|  | Input clock frequency |  | 1.5 3 |  | GSPS |
|  | Differential (peak-to-peak) input clock amplitude |  | $\begin{array}{ll}0.5 & 1.5\end{array}$ | 2.5 | $V_{\text {PP }}$ |
|  | Input clock duty cycle |  | 45\% 50\% | 55\% |  |
|  | Internal clock biasing |  | 1.0 |  | V |
|  | Internal clock termination (differential) |  | 100 |  | $\Omega$ |

(1) Crosstalk is measured with a - $2-\mathrm{dBFS}$ input signal on aggressor channel and no input on the victim channel.
(2) See 图 7-1.
(3) Full-scale signal is applied to the analog inputs of all active channels.
(4) See the 节 9.1 .4 section for more details.
(5) When used in dc-coupling mode, the common-mode voltage at the analog inputs should be kept within $\mathrm{V}_{\mathrm{CM}} \pm 25 \mathrm{mV}$ for best performance.

### 6.6 AC Performance Characteristics: $\mathrm{f}_{\mathrm{S}}=\mathbf{2 9 4 9 . 1 2}$ MSPS

typical values specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and chip sampling rate $=2949.12 \mathrm{MSPS}, 50 \%$ clock duty cycle, DDC-bypassed performance ${ }^{(5)}$, $\operatorname{AVDD} 19=1.9 \mathrm{~V}, \mathrm{AVDD}=1.15 \mathrm{~V}, \mathrm{DVDD}=1.15 \mathrm{~V}$, -2 -dBFS differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | $\mathbf{M I N}{ }^{(3)}$ | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SNR | Signal-to-noise ratio | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 62.6 |  | dBFS |
|  |  | $\mathrm{f}_{\text {IN }}=900 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 61.1 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ | 55.4 | 58.9 |  |  |
|  |  | $\mathrm{fIN}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ |  | 58.2 |  |  |
|  |  | $\mathrm{f}_{\text {IN }}=2600 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 56.8 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 54.1 |  |  |
| NSD | Noise spectral density averaged across the Nyquist zone | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 154.3 |  | dBFS/Hz |
|  |  | $\mathrm{f}_{\mathrm{IN}}=900 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 152.8 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 147.1 | 150.6 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 149.9 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2600 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 148.5 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 145.8 |  |  |
|  | Small-signal SNR | $\mathrm{f}_{\text {IN }}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-40 \mathrm{dBFS}$ |  | 63.1 |  | dBFS |
| $\mathrm{NF}^{(1)}$ | Noise figure | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-40 \mathrm{dBFS}$ |  | 24.7 |  | dB |
| SINAD | Signal-to-noise and distortion ratio | $\mathrm{f}_{\text {IN }}=100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 61.7 |  | dBFS |
|  |  | $\mathrm{f}_{\text {IN }}=900 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 60.2 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 58.4 |  |  |
|  |  | $\mathrm{fIN}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ |  | 57.6 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2600 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 54.8 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 53.6 |  |  |
| ENOB | Effective number of bits | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 10.0 |  | Bits |
|  |  | $\mathrm{fiN}_{\text {I }}=900 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 9.7 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 9.4 |  |  |
|  |  | $\mathrm{f}_{\text {IN }}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 9.3 |  |  |
|  |  | $\mathrm{f}_{\text {IN }}=2600 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 8.8 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 8.6 |  |  |
| SFDR | Spurious-free dynamic range | $\mathrm{f}_{\text {IN }}=100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 68.0 |  | dBc |
|  |  | $\mathrm{f}_{\text {IN }}=900 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 66.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 58 | 67.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 64.0 |  |  |
|  |  | $\mathrm{fiN}^{\text {a }}=2600 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 58.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 62.0 |  |  |
| HD2 ${ }^{(4)}$ | Second-order harmonic distortion | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 72.0 |  | dBc |
|  |  | $\mathrm{f}_{\text {IN }}=900 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 73.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 58 | 67.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 64.0 |  |  |
|  |  | $\mathrm{f}_{\text {IN }}=2700 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 58.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 62.0 |  |  |

typical values specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and chip sampling rate $=2949.12 \mathrm{MSPS}, 50 \%$ clock duty cycle, DDC-bypassed performance ${ }^{(5)}$, $\operatorname{AVDD} 19=1.9 \mathrm{~V}, \mathrm{AVDD}=1.15 \mathrm{~V}, \mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS | $\mathbf{M I N}{ }^{(3)}$ | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HD3 | Third-order harmonic distortion | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}$, $\mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ |  | 68.0 |  | dBc |
|  |  | $\mathrm{fin}=900 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 66.0 |  |  |
|  |  | $\mathrm{fiN}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 61 | 73.0 |  |  |
|  |  | $\mathrm{fiN}_{\text {IN }}=2100 \mathrm{MHz}$, $\mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ |  | 80.0 |  |  |
|  |  | $\mathrm{ff}_{\mathrm{IN}}=2600 \mathrm{MHz}$, $\mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ |  | 72.0 |  |  |
|  |  | $\mathrm{fiN}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 65.0 |  |  |
| HD4, HD5 | Fourth- and fifth-order harmonic distortion | $\mathrm{fin}=100 \mathrm{MHz}$, $\mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 85.0 |  | dBc |
|  |  | $\mathrm{fin}=900 \mathrm{MHz}$, $\mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 81.0 |  |  |
|  |  | $\mathrm{fin}_{\text {IN }}=1850 \mathrm{MHz}$, $\mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 61 | 84.0 |  |  |
|  |  | $\mathrm{fin}^{\text {I }}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 84.0 |  |  |
|  |  | $\mathrm{fiN}_{\text {IN }}=2600 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 80.0 |  |  |
|  |  | $\mathrm{f}_{\text {IN }}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 87.0 |  |  |
| IL spur | Interleaving spurs: <br> $\mathrm{f}_{\mathrm{S}} / 2-\mathrm{f}_{\mathrm{IN}}$, <br> $\mathrm{f}_{\mathrm{S}} / 4 \pm \mathrm{f}_{\mathrm{IN}}$ | $\mathrm{fin}=100 \mathrm{MHz}$, $\mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ |  | 90.0 |  | dBc |
|  |  | $\mathrm{fin}^{\text {¢ }}=900 \mathrm{MHz}$, $\mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 77.0 |  |  |
|  |  | $\mathrm{fiN}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 69 | 79.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 76.0 |  |  |
|  |  | $\mathrm{fin}_{\text {IN }}=2600 \mathrm{MHz}$, $\mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ |  | 77.0 |  |  |
|  |  | $\mathrm{fiN}_{\text {I }}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 77.0 |  |  |
| HD2 IL | Interleaving spur for HD2:$\mathrm{f}_{\mathrm{S}} / 2-\mathrm{HD} 2$ | $\mathrm{fin}=100 \mathrm{MHz}$, $\mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 84.0 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=900 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 82.0 |  |  |
|  |  | $\mathrm{fiN}_{\text {I }}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 62 | 80.0 |  |  |
|  |  | $\mathrm{fin}_{\mathrm{IN}}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ |  | 76.0 |  |  |
|  |  | $\mathrm{fiN}_{\text {I }}=2600 \mathrm{MHz}, \mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ |  | 65.0 |  |  |
|  |  | $\mathrm{f}_{\text {IN }}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 77.0 |  |  |
| Worst spur | Spurious-free dynamic range (excluding HD2, HD3, HD4, HD5, and interleaving spurs IL and HD2 IL) | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 80.0 |  | dBc |
|  |  | $\mathrm{fin}_{\text {I }}=900 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 76.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 64 | 76.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 75.0 |  |  |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2600 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ |  | 75.0 |  |  |
|  |  | $\mathrm{fiN}_{\text {I }}=3500 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}{ }^{(2)}=-3 \mathrm{dBFS}$ with 2-dB gain |  | 71.0 |  |  |
| IMD3 | Two-tone, third-order intermodulation distortion | $\begin{aligned} & \mathrm{f}_{\mathrm{IN} 1}=1770 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN} 2}=1790 \mathrm{MHz}, \\ & \mathrm{~A}_{\mathrm{OUT}}=-8 \mathrm{dBFS} \text { (each tone) } \end{aligned}$ |  | 70 |  | dBFS |
|  |  | $\begin{aligned} & \mathrm{f}_{\mathrm{IN} 1}=1800 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN} 2}=2600 \mathrm{MHz}, \\ & \mathrm{~A}_{\text {OUT }}=-8 \mathrm{dBFS} \text { (each tone) } \end{aligned}$ |  | 73 |  |  |
|  |  | $\begin{aligned} & \mathrm{f}_{\mathrm{N} 1}=3490 \mathrm{MHz}, \mathrm{f}_{\mathrm{N} 2}=3510 \mathrm{MHz}, \\ & \mathrm{~A}_{\text {OUT }}=-8 \mathrm{dBFS} \text { (each tone) with 2-dB gain } \end{aligned}$ |  | 67 |  |  |

(1) The ADC internal resistance $=65 \Omega$, the driving source resistance $=50 \Omega$.
(2) Output amplitude, $\mathrm{A}_{\text {OUT }}$, refers to the signal amplitude in the ADC digital output that is same as the analog input amplitude, $\mathrm{A}_{\text {IN }}$, except when the digital gain feature is used. If digital gain is $G$, then $A_{\text {OUT }}=G+A_{\text {IN }}$.
(3) Minimum values are specified at $\mathrm{A}_{\text {OUT }}=-3 \mathrm{dBFS}$.
(4) The minimum value of HD2 is specified by bench characterization.
(5) Performance is shown with DDC bypassed. When DDC is enabled, performance improves by the decimation filtering process.

### 6.7 AC Performance Characteristics: $\mathrm{f}_{\mathrm{S}}=$ 2457.6 MSPS (Performance Optimized for F + A + D Band)

typical values specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and chip sampling rate $=2949.12 \mathrm{MSPS}, 50 \%$ clock duty cycle, DDC-bypassed performance, $\mathrm{AVDD} 19=1.9 \mathrm{~V}, \mathrm{AVDD}=1.15 \mathrm{~V}, \mathrm{DVDD}=1.15 \mathrm{~V}$, - 2-dBFS differential input, and 0-dB digital gain (unless otherwise noted) ${ }^{(1)}$

| PARAMETER |  |  | TEST CONDITIONS |
| :--- | :--- | :--- | :--- |

(1) F-band $=1880 \mathrm{MHz}$ to $1920 \mathrm{MHz}, \mathrm{A}-$ band $=2010 \mathrm{MHz}$ to 2025 MHz , and D-band $=2570 \mathrm{MHz}$ to 2620 MHz .

### 6.8 AC Performance Characteristics: $\mathrm{f}_{\mathrm{S}}=\mathbf{2 4 5 7 . 6}$ MSPS (Performance Optimized for F + A Band)

typical values specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and chip sampling rate $=2949.12 \mathrm{MSPS}, 50 \%$ clock duty cycle, DDC-bypassed performance, $A V D D 19=1.9 \mathrm{~V}, \mathrm{AVDD}=1.15 \mathrm{~V}, \mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted) ${ }^{(1)}$

|  | PARAMETER | TEST CONDITIONS | MIN NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SNR | Signal-to-noise ratio | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 58.7 |  | dBFS |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 57.9 |  |  |
| SFDR | Spurious-free dynamic range | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 71.0 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 69.0 |  |  |
| HD2 | Second-order harmonic distortion | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 71.0 |  | dBc |
|  |  | $\mathrm{f}_{\text {IN }}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 69.0 |  |  |
| HD3 | Third-order harmonic distortion | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 75.0 |  | dBc |
|  |  | $\mathrm{f}_{\text {IN }}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 76.0 |  |  |
| IL spur | Interleaving spurs:$\begin{aligned} & \mathrm{f}_{\mathrm{S}} / 2-\mathrm{f}_{\mathrm{IN}}, \\ & \mathrm{f}_{\mathrm{S}} / 4 \pm \mathrm{f}_{\mathrm{IN}} \end{aligned}$ | $\mathrm{fIN}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 82.0 |  | dBc |
|  |  | $\mathrm{fiN}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ | 84.0 |  |  |
| HD2 IL | Interleaving spur for HD2: $\mathrm{f}_{\mathrm{S}} / 2$ - HD2 | $\mathrm{f}_{\mathrm{IN}}=1850 \mathrm{MHz}, \mathrm{A}_{\text {OUT }}=-2 \mathrm{dBFS}$ | 80.0 |  | dBc |
|  |  | $\mathrm{f}_{\mathrm{IN}}=2100 \mathrm{MHz}, \mathrm{A}_{\text {OUt }}=-2 \mathrm{dBFS}$ | 80.0 |  |  |

(1) F-band $=1880 \mathrm{MHz}$ to 1920 MHz , A-band $=2010 \mathrm{MHz}$ to 2025 MHz , and D-band $=2570 \mathrm{MHz}$ to 2620 MHz .

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### 6.9 Digital Requirements

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and chip sampling rate $=2949.12 \mathrm{MSPS}$, DDC bypassed performance, $50 \%$ clock duty cycle, $\mathrm{AVDD} 19=1.9 \mathrm{~V}, \mathrm{AVDD}=1.15 \mathrm{~V}, \mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIGITAL INPUTS (RESET, SCLK, SEN, SDIN, PDN, GPIO1, GPIO2, GPIO3, GPIO4) |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High-level input voltage |  | 0.8 |  |  | V |
| $\mathrm{V}_{\mathrm{IL}}$ | Low-level input voltage |  |  |  | 0.4 | V |
|  | High-level input current |  |  | 50 |  | $\mu \mathrm{A}$ |
|  | Low-level input current |  |  | - 50 |  | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\mathrm{i}}$ | Input capacitance |  |  | 4 |  | pF |

DIGITAL OUTPUTS (SDOUT, GPIO1, GPIO2, GPIO3, GPIO4)

| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage |  | AVDD19 <br> -0.1 | AVDD19 |
| :--- | :--- | :--- | ---: | :---: | :---: |

DIGITAL INPUTS (SYSREFP and SYSREFM; SYNCBP and SYNCBM; Requires External Biasing)

| $\mathrm{V}_{\text {ID }}$ | Differential input voltage |  | 350 | 450 | 800 |
| :--- | :--- | :--- | ---: | ---: | :---: |
| $\mathrm{~V}_{\mathrm{CM}}$ | Input common-mode voltage |  | 1.05 | 1.2 | 1.325 |

DIGITAL OUTPUTS (JESD204B Interface: DA[3:0], DB[3:0], Meets JESD204B LV-0IF-11G-SR Standard)

| $\left\|\mathrm{V}_{\text {OD }}\right\|$ | Output differential voltage |  | 700 | mV PP |
| :---: | :---: | :---: | :---: | :---: |
| \| $\mathrm{V}_{\text {Ocm }} \mid$ | Output common-mode voltage |  | 450 | mV |
|  | Transmitter short-circuit current | Transmitter pins shorted to any voltage between -0.25 V and 1.45 V | -100 100 | mA |
| $\mathrm{z}_{\text {os }}$ | Single-ended output impedance |  | 50 | $\Omega$ |
| Co | Output capacitance | Output capacitance inside the device, from either output to ground | 2 | pF |

### 6.10 Timing Requirements

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and chip sampling rate $=2949.12 \mathrm{MSPS}, 50 \%$ clock duty cycle, DDC-bypassed performance, $\mathrm{AVDD} 19=1.9 \mathrm{~V}, \mathrm{AVDD}=1.15 \mathrm{~V}, \mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| SAMPLE TIMING |  |  |  |  |
| Aperture delay | 250 |  | 750 | ps |
| Aperture delay matching between two channels on the same device |  | $\pm 15$ |  | ps |
| Aperture delay matching between two devices at the same temperature and supply voltage |  | $\pm 150$ |  | ps |
| Aperture jitter, clock amplitude $=2 \mathrm{~V}_{\mathrm{PP}}$ |  | 90 |  | $\mathrm{f}_{S}$ |
| Latency (1) (3) Data latency, ADC sample to digital output, DDC block bypassed ${ }^{(4)}$, LMFS $=8224$ |  | 424 |  | Input clock cycles |
| Fast overrange latency, ADC sample to FOVR indication on GPIO pins |  | 70 |  |  |
| $t_{P D}$ Propagation delay time: logic gates and output buffer delay <br> (does not change with $\left.\mathrm{f}_{\mathrm{S}}\right)$ |  | 6 |  | ns |
| SYSREF TIMING ${ }^{(2)}$ |  |  |  |  |
| $\mathrm{t}_{\text {SU_SYSREF }}$ SYSREF setup time: referenced to clock rising edge, 2949.12 MSPS | 140 | 70 |  | ps |
| $\mathrm{t}_{\mathrm{H} \text { _SYSREF }}$ SYSREF hold time: referenced to clock rising edge, 2949.12 MSPS | 50 | 20 |  | ps |
| Valid transition window sampling period: $\mathrm{t}_{\text {SU_SYSREF }}-\mathrm{t}_{\text {H_SYSREF }}$, 2949.12 MSPS | 143 |  |  | ps |

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$ ；minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ；and chip sampling rate $=2949.12 \mathrm{MSPS}, 50 \%$ clock duty cycle，DDC－bypassed performance， $\operatorname{AVDD} 19=1.9 \mathrm{~V}, \mathrm{AVDD}=1.15 \mathrm{~V}$ ， $\mathrm{DVDD}=1.15 \mathrm{~V}$ ，$-2-\mathrm{dBFS}$ differential input，and 0－dB digital gain（unless otherwise noted）

（1）Overall latency $=$ latency $+t_{\text {PD }}$ ．
（2）Common－mode voltage for the SYSREF input is kept at 1.2 V ．
（3）Latency increases when the DDC modes are used；see 表 8－5．
（4）For latency in different DDC options，see 表 8－5．


A．$V_{O C M}$ is not the same as $V_{I C M}$ ．Similarly，$V_{O D}$ is not the same as $V_{I D}$ ．
图 6－1．Logic Levels for Digital Inputs and Outputs


图 6-2. SYSREF Timing Diagram

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## 6．11 Typical Characteristics

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$ ；minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ；and ADC sampling rate $=2949.12 \mathrm{MSPS}$ ，DDC bypassed performance， $50 \%$ clock duty cycle， $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$ ，$-2-\mathrm{dBFS}$ differential input，and $0-\mathrm{dB}$ digital gain（unless otherwise noted）


## 6．11 Typical Characteristics（continued）

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$ ；minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ；and ADC sampling rate $=2949.12 \mathrm{MSPS}$ ，DDC bypassed performance， $50 \%$ clock duty cycle， $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$ ，$-2-\mathrm{dBFS}$ differential input，and $0-\mathrm{dB}$ digital gain（unless otherwise noted）


## 6．11 Typical Characteristics（continued）

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$ ；minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ；and ADC sampling rate $=2949.12 \mathrm{MSPS}$ ，DDC bypassed performance， $50 \%$ clock duty cycle， $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$ ，$-2-\mathrm{dBFS}$ differential input，and $0-\mathrm{dB}$ digital gain（unless otherwise noted）


图 6－11．FFT for 2600－MHz Input Signal


SNR $=54.2 \mathrm{dBFS} ; \mathrm{SFDR}=60 \mathrm{dBc} ; \mathrm{HD} 2=-60 \mathrm{dBc} ; \mathrm{HD} 3=$ -64 dBc ；non HD2，HD3 $=71 \mathrm{dBc}$ ；IL spur $=80 \mathrm{dBc} ; \mathrm{f}_{\mathrm{IN}}=3.5$ $\mathrm{GHz}, \mathrm{A}_{\mathrm{IN}}=-3 \mathrm{dBFS}$ with 2－dB gain

图 6－13．FFT for $\mathbf{3 5 0 0}-\mathrm{MHz}$ Input Signal


SNR $=55.4 \mathrm{dBFS} ; \mathrm{SFDR}=60 \mathrm{dBc} ; \mathrm{HD} 2=-60 \mathrm{dBc} ; \mathrm{HD} 3=$
-67 dBc ；non HD2，HD3 $=72 \mathrm{dBc}$ ；IL spur $=75 \mathrm{dBc} ; \mathrm{f}_{\mathrm{IN}}=2.6$ GHz

图 6－12．FFT for $\mathbf{2 6 0 0}-\mathrm{MHz}$ Input Signal（ $\mathrm{f}_{\mathrm{S}}=\mathbf{2 4 5 7 . 6}$ MSPS）

$\mathrm{SNR}=53.6 \mathrm{dBFS} ; \mathrm{SFDR}=47 \mathrm{dBc} ; \mathrm{HD} 2=-50 \mathrm{dBc} ; \mathrm{HD} 3=$ -47 dBc ；non HD2，HD3 $=70 \mathrm{dBc}$ ；IL spur $=67 \mathrm{dBc} ; \mathrm{f}_{\mathrm{IN}}=3.5$ $\mathrm{GHz}, \mathrm{A}_{\mathrm{IN}}=-3 \mathrm{dBFS}$ with $2-\mathrm{dB}$ gain

图 6－14．FFT for 3500－MHz Input Signal（ $\mathrm{f}_{\mathrm{S}}=\mathbf{2 4 5 7 . 6}$ MSPS）

### 6.11 Typical Characteristics (continued)

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and ADC sampling rate $=2949.12 \mathrm{MSPS}$, DDC bypassed performance, $50 \%$ clock duty cycle, $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)


### 6.11 Typical Characteristics (continued)

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and ADC sampling rate $=2949.12 \mathrm{MSPS}$, DDC bypassed performance, $50 \%$ clock duty cycle, $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)


### 6.11 Typical Characteristics (continued)

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and ADC sampling rate $=2949.12 \mathrm{MSPS}$, DDC bypassed performance, $50 \%$ clock duty cycle, $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)


## 6．11 Typical Characteristics（continued）

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$ ；minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ；and ADC sampling rate $=2949.12 \mathrm{MSPS}$ ，DDC bypassed performance， $50 \%$ clock duty cycle， $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$ ，$-2-\mathrm{dBFS}$ differential input，and $0-\mathrm{dB}$ digital gain（unless otherwise noted）

$\mathrm{f}_{\mathrm{IN} 1}=3.49 \mathrm{MHz}, \mathrm{f}_{\mathrm{IN} 2}=3.51 \mathrm{GHz}, \mathrm{IMD}=66 \mathrm{dBFS}, \mathrm{A}_{\mathrm{IN}}=-3$ dBFS with 2－dB gain

图 6－27．FFT for Two－Tone Input Signal（－ 8 dBFS）


$$
\begin{gathered}
\mathrm{f}_{\mathrm{IN} 1}=2.59 \mathrm{GHz}, \mathrm{f}_{\mathrm{IN} 2}=2.6 \mathrm{GHz}, \mathrm{~A}_{\mathrm{IN}}=-8 \mathrm{dBFS}, \mathrm{IMD}=65 \\
\mathrm{dBFS}
\end{gathered}
$$

图 6－29．FFT for Two－Tone Input Signal（－8dBFS， $\mathbf{f}_{\mathrm{S}}=\mathbf{2 4 5 7 . 6}$
MSPS）

$\mathrm{f}_{\mathrm{IN} 1}=1.77 \mathrm{GHz}, \mathrm{f}_{\mathrm{IN} 2}=1.79 \mathrm{GHz}$
图 6－31．Intermodulation Distortion vs．Input Amplitude（1770 MHz and $1790 \mathbf{M H z}$ ）


图 6－28．FFT for Two－Tone Input Signal（ $\mathbf{- 3 6}$ dBFS）


$$
\begin{gathered}
\mathrm{f}_{\mathrm{N} 1}=2.59 \mathrm{GHz}, \mathrm{f}_{\mathrm{IN} 2}=2.6 \mathrm{GHz}, \mathrm{~A}_{\mathrm{IN}}=-36 \mathrm{dBFS}, \mathrm{IMD}=92 \\
\mathrm{dBFS}
\end{gathered}
$$

图 6－30．FFT for Two－Tone Input Signal（ $-\mathbf{3 6} \mathrm{dBFS}, \mathrm{f}_{\mathrm{S}}=2457.6$ MSPS）

$\mathrm{f}_{\mathrm{IN} 1}=1.77 \mathrm{GHz}, \mathrm{f}_{\mathrm{IN} 2}=1.79 \mathrm{GHz}$
图 6－32．Intermodulation Distortion vs．Input Amplitude（1770 MHz and $\mathbf{1 7 9 0} \mathbf{~ M H z , ~} \mathrm{f}_{\mathrm{S}}=\mathbf{2 4 5 7 . 6} \mathbf{~ M S P S}$ ）

## 6．11 Typical Characteristics（continued）

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$ ；minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ；and ADC sampling rate $=2949.12 \mathrm{MSPS}$ ，DDC bypassed performance， $50 \%$ clock duty cycle， $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$ ，$-2-\mathrm{dBFS}$ differential input，and $0-\mathrm{dB}$ digital gain（unless otherwise noted）


图 6－33．Intermodulation Distortion vs．Input Amplitude（1800 MHz and 2600 MHz ）

$\mathrm{f}_{\mathrm{IN} 1}=3.49 \mathrm{GHz}, \mathrm{f}_{\mathrm{IN} 2}=3.51 \mathrm{GHz}$ with 2－dB digital gain
图 6－35．Intermodulation Distortion vs．Input Amplitude（3490 $\mathbf{M H z}$ and 3510 MHz ）

$A_{\text {OUT }}=-2 d B F S$ with $0-\mathrm{dB}$ gain for $\mathrm{f}_{\mathrm{IN}}$ less than 3 GHz ， $\mathrm{A}_{\text {OUT }}$ $=-3 \mathrm{dBFS}$ with $2-\mathrm{dB}$ gain for $\mathrm{f}_{\mathrm{IN}}$ more than 3 GHz

图 6－37．Spurious－Free Dynamic Range vs．Input Frequency

$\mathrm{f}_{\mathrm{IN} 1}=2.09 \mathrm{GHz}, \mathrm{f}_{\mathrm{IN} 2}=2.1 \mathrm{GHz}$
图 6－34．Intermodulation Distortion vs．Input Amplitude（1800 MHz and $2600 \mathrm{MHz}, \mathrm{f}_{\mathrm{S}}=2457.6 \mathrm{MSPS}$ ）

$\mathrm{f}_{\mathrm{IN} 1}=2.59 \mathrm{GHz}, \mathrm{f}_{\mathrm{IN} 2}=2.6 \mathrm{GHz}$
图 6－36．Intermodulation Distortion vs．Input Amplitude（3490 MHz and $\mathbf{3 5 1 0} \mathbf{~ M H z , ~} \mathrm{f}_{\mathrm{S}}=\mathbf{2 4 5 7 . 6} \mathbf{~ M S P S}$ ）

$A_{\text {OUT }}=-2 d B F S$ with $0-\mathrm{dB}$ gain for $\mathrm{f}_{\text {IN }}$ less than 3 GHz ， $\mathrm{A}_{\text {OUT }}$ $=-3 \mathrm{dBFS}$ with $2-\mathrm{dB}$ gain for $\mathrm{f}_{\mathrm{IN}}$ more than 3 GHz
图 6－38．Spurious－Free Dynamic Range vs．Input Frequency（fs ＝2457．6 MSPS）

### 6.11 Typical Characteristics (continued)

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and ADC sampling rate $=2949.12 \mathrm{MSPS}$, DDC bypassed performance, $50 \%$ clock duty cycle, $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)


## 6．11 Typical Characteristics（continued）

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$ ；minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ；and ADC sampling rate $=2949.12 \mathrm{MSPS}$ ，DDC bypassed performance， $50 \%$ clock duty cycle， $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$ ，$-2-\mathrm{dBFS}$ differential input，and $0-\mathrm{dB}$ digital gain（unless otherwise noted）


图 6－43．Signal－to－Noise Ratio vs．AVDD Supply and Temperature

$\mathrm{f}_{\mathrm{IN}}=3.5 \mathrm{GHz}, \mathrm{A}_{\mathrm{IN}}=-3 \mathrm{dBFS}$ with 2－dB digital gain
图 6－45．Signal－to－Noise Ratio vs．AVDD Supply and Temperature

$\mathrm{f}_{\mathrm{IN}}=1.78 \mathrm{GHz}, \mathrm{A}_{\mathrm{IN}}=-2 \mathrm{dBFS}$
图 6－47．Signal－to－Noise Ratio vs．DVDD Supply and Temperature


图 6－44．Spurious－Free Dynamic Range vs．AVDD Supply and Temperature

$\mathrm{f}_{\mathrm{IN}}=3.5 \mathrm{GHz}, \mathrm{A}_{\mathrm{IN}}=-3 \mathrm{dBFS}$ with 2－dB digital gain
图 6－46．Spurious－Free Dynamic Range vs．AVDD Supply and Temperature

$\mathrm{f}_{\mathrm{IN}}=1.78 \mathrm{GHz}, \mathrm{A}_{\mathrm{IN}}=-2 \mathrm{dBFS}$
图6－48．Spurious－Free Dynamic Range vs．DVDD Supply and Temperature

## 6．11 Typical Characteristics（continued）

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$ ；minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ；and ADC sampling rate $=2949.12 \mathrm{MSPS}$ ，DDC bypassed performance， $50 \%$ clock duty cycle， $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$ ，$-2-\mathrm{dBFS}$ differential input，and $0-\mathrm{dB}$ digital gain（unless otherwise noted）


### 6.11 Typical Characteristics (continued)

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and ADC sampling rate $=2949.12 \mathrm{MSPS}$, DDC bypassed performance, $50 \%$ clock duty cycle, $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)


### 6.11 Typical Characteristics (continued)

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and ADC sampling rate $=2949.12 \mathrm{MSPS}$, DDC bypassed performance, $50 \%$ clock duty cycle, $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)


## 6．11 Typical Characteristics（continued）

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$ ；minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ；and ADC sampling rate $=2949.12 \mathrm{MSPS}$ ，DDC bypassed performance， $50 \%$ clock duty cycle， $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$ ，$-2-\mathrm{dBFS}$ differential input，and $0-\mathrm{dB}$ digital gain（unless otherwise noted）


图 6－67．Common－Mode Rejection Ratio vs．Tone Frequency

$\mathrm{f}_{\mathrm{IN}}=1.78 \mathrm{GHz}, \mathrm{A}_{\mathrm{IN}}=-2 \mathrm{dBFS}, \mathrm{f}_{\mathrm{S}}=2949.12 \mathrm{MSPS}, \mathrm{SNR}=$ 60.6 dBFS ，SFDR（includes IL）$=75 \mathrm{dBc}$

图 6－68．FFT in 4x Decimation（Complex Output）
$\mathrm{f}_{\mathrm{IN}}=1.78 \mathrm{GHz}, \mathrm{A}_{\mathrm{IN}}=-2 \mathrm{dBFS}, \mathrm{f}_{\mathrm{S}}=2949.12 \mathrm{MSPS}, \mathrm{SNR}=$ $62.6 \mathrm{dBFS}, \mathrm{SFDR}$（includes IL）$=86 \mathrm{dBc}$

图 6－70．FFT in 8x Decimation（Complex Output）

$\mathrm{f}_{\mathrm{IN}}=1.78 \mathrm{GHz}, \mathrm{A}_{\mathrm{IN}}=-2 \mathrm{dBFS}, \mathrm{f}_{\mathrm{S}}=2949.12 \mathrm{MSPS}, \mathrm{SNR}=$ 63.3 dBFS, SFDR（includes IL）$=81 \mathrm{dBc}$

图 6－72．FFT in 10x Decimation（Complex Output）

### 6.11 Typical Characteristics (continued)

typical values are specified at an ambient temperature of $25^{\circ} \mathrm{C}$; minimum and maximum values are specified over an ambient temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$; and ADC sampling rate $=2949.12 \mathrm{MSPS}$, DDC bypassed performance, $50 \%$ clock duty cycle, $\operatorname{AVDD19}=1.9 \mathrm{~V}, \mathrm{AVDD}=\mathrm{DVDD}=1.15 \mathrm{~V}$, $-2-\mathrm{dBFS}$ differential input, and $0-\mathrm{dB}$ digital gain (unless otherwise noted)


## 7 Parameter Measurement Information

### 7.1 Input Clock Diagram

图 7-1 shows the input clock diagram.


图 7-1. Input Clock Diagram

## 8 Detailed Description

### 8.1 Overview

The ADC32RF8x is a dual, 14-bit, 2949.12-MSPS, telecom receiver and feedback device family containing analog-to-digital converters (ADCs) followed by multi-band digital down-converters (DDCs), and a back-end JESD204B digital interface.
The ADCs are preceded by input buffers and on-chip termination to provide a uniform input impedance over a large input frequency range. Furthermore, an internal differential clamping circuit provides first-level protection against overvoltage conditions. Each ADC channel is internally interleaved four times and equipped with background, analog and digital, and interleaving correction.
The on-chip DDC enables single- or dual-band internal processing to pre-select and filter smaller bands of interest and also reduces the digital output data traffic. Each DDC is equipped with up to three independent, 16-bit numerically-controlled oscillators (NCOs) for phase coherent frequency hopping; the NCOs can be controlled through the SPI or GPIO pins. The ADC32RF8x also provides three different power detectors on-chip with alarm outputs in order to support external automatic gain control (AGC) loops.
The processed data are passed into the JESD204B interface where the data are framed, encoded, serialized, and output on one to four lanes per channel, depending on the ADC sampling rate and decimation. The CLKIN, SYSREF, and SYNCB inputs provide the device clock and the SYSREF and SYNCB signals to the JESD204B interface that are used to derive the internal local frame and local multiframe clocks and establish the serial link. All features of the ADC32RF8x are configurable through the SPI.

### 8.2 Functional Block Diagram



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### 8.3 Feature Description

### 8.3.1 Analog Inputs

The ADC32RF8x analog signal inputs are designed to be driven differentially. The analog input pins have internal analog buffers that drive the sampling circuit. The ADC32RF8x provides on-chip, differential termination to minimize reflections. The buffer also helps isolate the external driving circuit from the internal switching currents of the sampling circuit, thus resulting in a more constant SFDR performance across input frequencies.

The common-mode voltage of the signal inputs is internally biased to CM using the $32.5-\Omega$ termination resistors that allow for ac-coupling of the input drive network. 图 8-1 and 图 8-2 show SDD11 at the analog inputs from dc to 5 GHz with a $100-\Omega$ reference impedance.


The input impedance of analog inputs can also be modeled as parallel combination of equivalent resistance and capacitance．图 8－3 and 图 8－4 show how equivalent impedance（ $C_{I N}$ and $R_{I N}$ ）vary over frequency．


图8－3．Differential Input Capacitance vs．Input Frequency


图8－4．Differential Input Resistance vs．Input Frequency

Each input pin（INP，INM）must swing symmetrically between（CM＋0．3375 V）and（CM－ 0.3375 V ），resulting in a $1.35-V_{P P}$（default）differential input swing．As shown in 图 8－5，the input sampling circuit has a 3－dB bandwidth that extends up to approximately 3.2 GHz ．


图 8－5．Input Bandwidth With a 100－$\Omega$ Source Resistance

## 8．3．1．1 Input Clamp Circuit

The ADC32RF8x analog inputs include an internal，differential clamp for overvoltage protection．As shown in 图 $8-6$ and 图 8－7，the clamp triggers for any input signals at approximately 600 mV above the input common－mode voltage，effectively limiting the maximum input signal to approximately $2.4 \mathrm{~V}_{\mathrm{PP}}$ ．

When the clamp circuit conducts，the maximum differential current flowing through the circuit（via input pins） must be limited to 20 mA ．


图 8－6．Clamp Circuit in the ADC32RF8x


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### 8.3.2 Clock Input

The ADC32RF8x sampling clock input includes internal 100- $\Omega$ differential termination along with on-chip biasing. The clock input is recommended to be ac-coupled externally. The input bandwidth of the clock input is approximately 3 GHz ; the clock input impedance is shown in the smith chart of 图 8-8 with a $100-\Omega$ reference impedance.


图 8-8. SDD11 of the Clock Input

The analog－to－digital converter（ADC）aperture jitter is a function of the clock amplitude applied to the pins．The equivalent aperture jitter is shown in 图 $8-9$ for input frequencies at a $1-\mathrm{GHz}$ and a $2-\mathrm{GHz}$ input．Depending on the clock frequency，a matching circuit can be designed in order to maximize the clock amplitude．


图 8－9．Equivalent Aperture Jitter vs．Input Clock Amplitude

## 8．3．3 SYSREF Input

The SYSREF signal is a periodic signal that is sampled by the ADC32RF8x device clock and is used to align the boundary of the local multiframe clock inside the data converter．SYSREF is also used to reset critical blocks ［such as the clock divider for the interleaved ADCs，numerically－controlled oscillators（NCOs），decimation filters and so forth］．
The SYSREF input requires external biasing．Furthermore，SYSREF must be established before the SPI registers are programmed．A programmable delay on the SYSREF input，as shown in 图 8－10，is available to help with skew adjustment when the sampling clock and SYSREF are not provided from the same source．


图8－10．SYSREF Internal Circuit Diagram

## 8．3．3．1 Using SYSREF

The ADC32RF8x uses SYSREF information to reset the clock divider，the NCO phase，and the LMFC counter of the JESD interface．The device provides flexibility to provide SYSREF information either from dedicated pins or through SPI register bits．As shown in 图 8－11，SYSREF is asserted by a low－to－high transition on the SYSREF pins or a 0－to－1 change in the ASSERT SYSREF REG bit when using SPI registers．


图 8－11．Using SYSREF to Reset the Clock Divider，the NCO，and the LMFC Counter
The ADC32RF8x samples the SYSREF signal on the input clock rising edge．Required setup and hold time are listed in the 节 6.10 table．The input clock divider gets reset each time that SYSREF is asserted，whereas the NCO phase and the LMFC counter of the JESD interface are reset on each SYSREF assertion after disregarding the first two assertions，as shown in 表 8－1．

表 8－1．Asserting SYSREF

| SYSREF ASSERTION INDEX | ACTION |  |  |
| :---: | :---: | :---: | :---: |
|  | INPUT CLOCK DIVIDER | NCO PHASE | LMFC COUNTER |
| 1 | Gets reset | Does not get reset | Does not get reset |
| 2 | Gets reset | Does not get reset | Does not get reset |
| 3 | Gets reset | Gets reset | Gets reset |
| 4 and onwards | Gets reset | Gets reset | Gets reset |

The SYSREF use－cases can be classified broadly into two categories：
1．SYSREF is applied as aperiodic multi－shot pulses．
图 8－12 shows a case when only a counted number of pulses are applied as SYSREF to the ADC．


Alternatively, the SYSREF buffer can be powered down with the PDN SYSREF bit.

## 图 8-12. SYSREF Used as Aperiodic, Finite Number of Pulses

After the first SYSREF pulse is applied, allow the DLL in the clock path to settle by waiting for the $t_{\text {DLL }}$ time (> $40 \mu \mathrm{~s}$ ) before applying the second pulse. During this time, mask the SYSREF going to the input clock divider by setting the MASK CLKDIV SYSREF bit so that the divider output phase remains stable. The NCO phase and LMFC counter are reset on the third SYSREF pulse. After the third SYSREF pulse, the SYSREF going to the NCO and JESD block can be disabled by setting the MASK NCO SYSREF bit to avoid any unwanted resets.

2．SYSREF is applied as a periodic pulse．
图 8－13 shows how SYSREF can be applied as a continuous periodic waveform．


A．$t_{\text {SYSREF }}$ is a period of the SYSREF waveform．
B．Alternatively，the SYSREF buffer can be powered down using the PDN SYSREF bit．
图 8－13．SYSREF Used as a Periodic Waveform
After applying the SYSREF signal，DLL must be allowed to lock，and the NCO phase and LMFC counter must be allowed to reset by waiting for at least the $\mathrm{t}_{\text {DLL }}(40 \mu \mathrm{~s})+2 \times \mathrm{t}_{\text {SYSREF }}$ time．Then，the SYSREF going to the NCO and JESD can be masked by setting the MASK NCO SYSREF register bit．

## 8．3．3．2 Frequency of the SYSREF Signal

When SYSREF is a periodic signal，its frequency is required to be a sub－harmonic of the internal local multi－ frame clock（LMFC）frequency，as described in 方程式 1．The LMFC frequency is determined by the selected decimation，frames per multi－frame setting（K），samples per frame（S），and device input clock frequency．
SYSREF = LMFC / N
where
－ N is an integer value（ $1,2,3$ ，and so forth）
In order for the interleaving correction engine to synchronize properly，the SYSREF frequency must also be a multiple of $f_{S} / 64$ ．表 8－2 provides a summary of the valid LMFC clock settings．

表 8－2．．SYSREF and LMFC Clock Frequency

| OPERATING MODE | LMFS SETTING | LMFC CLOCK FREQUENCY | SYSREF FRQUENCY |
| :---: | :---: | :---: | :---: |
| Decimation | Various | $\mathrm{f}_{\mathrm{S}}{ }^{(1)} /\left(\mathrm{D} \times \mathrm{S}^{(4)} \times \mathrm{K}^{(3)}\right)$ | $\mathrm{f}_{\mathrm{S}} /\left(\mathrm{N} \times \mathrm{LCM}^{(2)}\left(64, \mathrm{D}^{(5)} \times \mathrm{S} \times \mathrm{K}\right)\right)$ |

（1）$f_{S}=$ sampling（device）clock frequency．
（2） $\mathrm{LCM}=$ least－common multiple．
（3） $\mathrm{K}=$ number of frames per multi－frame．
（4）$S=$ samples per frame．
（5） $\mathrm{D}=$ decimation ratio．
The SYSREF signal is recommended to be a low－frequency signal less than 5 MHz in order to reduce coupling to the signal path both on the printed circuit board（PCB）as well as internal to the device．

## Example： $\mathrm{f}_{\mathrm{S}} \mathbf{= 2 9 4 9 . 1 2}$ MSPS，Divide－by－4（LMFS＝8411）， $\mathrm{K}=16$

SYSREF $=2949.12 \mathrm{MSPS} / \operatorname{LCM}(4,64,16)=46.08 \mathrm{MHz} / \mathrm{N}$
Operate SYSREF at 2.88 MHz （effectively divide－by－1024， $\mathrm{N}=16$ ）
For proper device operation，disable the SYSREF signal after the JESD synchronization is established．

## 8．3．4 DDC Block

The ADC32RF8x provides a sophisticated on－chip，digital down converter（DDC）block that can be controlled through SPI register settings and the general－purpose input／output（GPIO）pins．The DDC block supports two basic operating modes：receiver（RX）mode with single－or dual－band DDC and wide－bandwidth observation receiver mode．
Note that the ADC32RF80 and ADC32RF83 are identical devices except the fact that the ADC32RF83 offers only single－band DDC option whereas the ADC32RF80 offers both single－band and dual－band DDC options，as shown in 表 8－3．

表 8－3．DDC Option Availability

| DDC OPTION | AVAILABILITY IN DEVICE |
| :---: | :---: |
| Wide－band DDC | ADC32RF80，ADC32RF83 |
| Single－band DDC | ADC32RF80，ADC32RF83 |
| Dual－band DDC | ADC32RF80 only |

Each ADC channel is followed by two DDC chains consisting of the digital filter along with a complex digital mixer with a 16－bit numerically－controlled oscillator（NCO），as shown in 图8－14．The NCOs allow accurate frequency tuning within the Nyquist zone prior to the digital filtering．One DDC chain is intended for supporting a dual－band DDC configuration in receiver mode and the second DDC chain supports the wide－bandwidth output option for the observation configuration．At any given time，either the single－band DDC，the dual－band DDC，or the wideband DDC can be enabled．Furthermore，three different NCO frequencies can be selected on that path and are quickly switched using the SPI or the GPIO pins to enable wide－bandwidth observation in a multi－band application．


Red traces show SYSREF going to the NCO blocks．
图 8－14．DDC Chains Overview（One ADC Channel Shown）
Additionally，the decimation filter block provides the option to convert the complex output back to real format at twice the decimated，complex output rate．The filter response with a real output is identical to a complex output． The band is centered in the middle of the Nyquist zone（mixed with fout／4）based on a final output data rate of fout．

## 8．3．4．1 Operating Mode：Receiver

In receiver mode，the DDC block can be configured to single－or dual－band operation，as shown in 图 8－15．Both DDC chains use the same decimation filter setting and the available options are discussed in the 节 8．3．4．3 section．The decimation filter setting also directly affects the interface rate and number of lanes of the JESD204B interface．


Red traces show SYSREF going to the NCO blocks.
图 8-15. Decimation Filter Option for Single- or Dual-Band Operation

## 8．3．4．2 Operating Mode：Wide－Bandwidth Observation Receiver

This mode is intended for using a DDC with a wide bandwidth output，but for multiple bands．This mode uses a single DDC chain where up to three NCOs can be used to perform wide－bandwidth observation in a multi－band environment，as shown in 图 8－16．The three NCOs can be switched dynamically using either the GPIO pins or an SPI command．All three NCOs operate continuously to ensure phase continuity；however，when the NCO is switched，the output data are invalid until the decimation filters are completely flushed with data from the new band．


Red traces show SYSREF going to the NCO blocks．
图8－16．Decimation Filter Implementation for Single－Band and Wide－Bandwidth Mode

## 8．3．4．3 Decimation Filters

The stop－band rejection of the decimation filters is approximately 90 dB with a pass－band bandwidth of approximately $80 \%$ ．表 8－4 gives an overview of the pass－band bandwidth depending on decimation filter setting and ADC sampling rate．

表 8－4．Decimation Filter Summary and Maximum Available Output Bandwidth

| DECIMATIONSETTING | NO．OF DDCS AVAILABLE PER CHANNEL | NOMINAL PASSBAND GAIN | BANDWIDTH |  | ADC SAMPLE RATE＝N MSPS |  | ADC SAMPLE RATE $\mathbf{~} \mathbf{3}$ GSPS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} 3 \mathrm{~dB} \\ (\%) \end{gathered}$ | $\begin{gathered} 1 \mathrm{~dB} \\ (\%) \end{gathered}$ | OUTPUT RATE （MSPS）PER BAND | OUTPUT BANDWIDTH （MHz）PER BAND | COMPLEX OUTPUT RATE （MSPS）PER BAND | OUTPUT BANDWIDTH （MHz）PER BAND |
| Divide－by－4 complex | 1 | － 0.4 dB | 90.9 | 86.8 | N／ 4 complex | $0.4 \times \mathrm{N} / 2$ | 750 | 600 |
| Divide－by－6 complex | 1 | -0.65 dB | 90.6 | 86.1 | N／ 6 complex | $0.4 \times \mathrm{N} / 3$ | 500 | 400 |
| Divide－by－8 complex | 2 | － 0.27 dB | 91.0 | 86.8 | N／ 8 complex | $0.4 \times \mathrm{N} / 4$ | 375 | 300 |
| Divide－by－9 complex | 2 | $-0.45 \mathrm{~dB}$ | 90.7 | 86.3 | N／9 complex | $0.4 \times \mathrm{N} / 4.5$ | 333.3 | 266.6 |
| $\begin{aligned} & \text { Divide-by-10 } \\ & \text { complex } \end{aligned}$ | 2 | － 0.58 dB | 90.7 | 86.3 | N／ 10 complex | $0.4 \times \mathrm{N} / 5$ | 300 | 240 |
| Divide-by-12 complex | 2 | － 0.55 dB | 90.7 | 86.4 | N／ 12 complex | $0.4 \times \mathrm{N} / 6$ | 250 | 200 |
| Divide-by-16 complex | 2 | － 0.42 dB | 90.8 | 86.4 | N／ 16 complex | $0.4 \times \mathrm{N} / 8$ | 187.5 | 150 |

表 8－4．Decimation Filter Summary and Maximum Available Output Bandwidth（continued）

| DECIMATION SETTING | NO．OF DDCS AVAILABLE PER CHANNEL | $\begin{aligned} & \text { NOMINAL } \\ & \text { PASSBAND } \\ & \text { GAIN } \end{aligned}$ | BANDWIDTH |  | ADC SAMPLE RATE＝N MSPS |  | ADC SAMPLE RATE $=3$ GSPS |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} 3 \mathrm{~dB} \\ (\%) \end{gathered}$ | $\begin{gathered} 1 \mathrm{~dB} \\ (\%) \end{gathered}$ | OUTPUT RATE （MSPS）PER BAND | OUTPUT BANDWIDTH （MHz）PER BAND | COMPLEX OUTPUT RATE （MSPS）PER BAND | OUTPUT BANDWIDTH （MHz）PER BAND |
| Divide－by－18 complex | 2 | － 0.83 dB | 91.2 | 87.0 | N／ 18 complex | $0.4 \times \mathrm{N} / 9$ | 166.6 | 133 |
| Divide－by－20 complex | 2 | － 0.91 dB | 91.2 | 87.0 | N／ 20 complex | $0.4 \times \mathrm{N} / 10$ | 150 | 120 |
| Divide－by－24 complex | 2 | － 0.95 db | 91.1 | 86.9 | N／ 24 complex | $0.4 \times \mathrm{N} / 12$ | 125 | 100 |
| Divide－by－32 complex | 2 | － 0.78 dB | 91.1 | 86.8 | N／ 32 complex | $0.4 \times \mathrm{N} / 16$ | 93.75 | 75 |

A dual－band example with a divide－by－8 complex is shown in 图 8－17．


## 图 8－17．Dual－Band Example

The decimation filter responses normalized to the ADC sampling clock are illustrated in 图8－17 to 图 8－40 and can be interpreted as follows：

Each figure contains the filter pass－band，transition bands，and alias bands，as shown in 图 8－18．The x－axis in图 8－18 shows the offset frequency（after the NCO frequency shift）normalized to the ADC sampling clock frequency．

For example，in the divide－by－4 complex，the output data rate is an $\mathrm{f}_{\mathrm{S}} / 4$ complex with a Nyquist zone of $\mathrm{f}_{\mathrm{S}} / 8$ or $0.125 \times \mathrm{f}_{\mathrm{S}}$ ．The transition band is centered around $0.125 \times \mathrm{f}_{\mathrm{S}}$ and the alias transition band is centered at $0.375 \times$ $f_{\mathrm{S}}$ ．The alias bands that alias on top of the wanted signal band are centered at $0.25 \times \mathrm{f}_{\mathrm{S}}$ and $0.5 \times \mathrm{f}_{\mathrm{S}}$（and are colored in red）．
The decimation filters of the ADC32RF8x provide greater than $90-\mathrm{dB}$ attenuation for the alias bands．


图 8-18. Interpretation of the Decimation Filter Plots

## 8．3．4．3．1 Divide－by－4

Peak－to－peak pass－band ripple：approximately 0.22 dB


图8－19．Divide－by－4 Filter Response


图 8－20．Divide－by－4 Filter Response（Zoomed）

## 8．3．4．3．2 Divide－by－6

Peak－to－peak pass－band ripple：approximately 0.38 dB


## 8．3．4．3．3 Divide－by－8

Peak－to－peak pass－band ripple：approximately 0.25 dB


图 8－23．Divide－by－8 Filter Response


图 8－24．Divide－by－8 Filter Response（Zoomed）

## 8．3．4．3．4 Divide－by－9

Peak－to－peak pass－band ripple：approximately 0.39 dB


图8－25．Divide－by－9 Filter Response


图 8－26．Divide－by－9 Filter Response（Zoomed）

## 8．3．4．3．5 Divide－by－10

Peak－to－peak pass－band ripple：approximately 0.39 dB


图8－27．Divide－by－10 Filter Response


图 8－28．Divide－by－10 Filter Response（Zoomed）

## 8．3．4．3．6 Divide－by－12

Peak－to－peak pass－band ripple：approximately 0.36 dB


图 8－29．Divide－by－12 Filter Response


图 8－30．Divide－by－12 Filter Response（Zoomed）

## 8．3．4．3．7 Divide－by－16

Peak－to－peak pass－band ripple：approximately 0.29 dB


图 8－31．Divide－by－16 Filter Response


图 8－32．Divide－by－16 Filter Response（Zoomed）

## 8．3．4．3．8 Divide－by－18

Peak－to－peak pass－band ripple：approximately 0.33 dB


图8－33．Divide－by－18 Filter Response


图 8－34．Divide－by－18 Filter Response（Zoomed）

## 8．3．4．3．9 Divide－by－20

Peak－to－peak pass－band ripple：approximately 0.32 dB


图 8－35．Divide－by－20 Filter Response


图 8－36．Divide－by－20 Filter Response（Zoomed）

## 8．3．4．3．10 Divide－by－24

Peak－to－peak pass－band ripple：approximately 0.30 dB


图8－37．Divide－by－24 Filter Response


图 8－38．Divide－by－24 Filter Response（Zoomed）

## 8．3．4．3．11 Divide－by－32

Peak－to－peak pass－band ripple：approximately 0.24 dB


图 8－39．Divide－by－32 Filter Response


图 8－40．Divide－by－32 Filter Response（Zoomed）

## 8．3．4．3．12 Latency with Decimation Options

Device latency in 12－bit bypass mode（with LMFS $=8224$ ）is 424 clock cycles．When the DDC option is used， latency increases as a result of decimation filters，as described in 表 8－5．

表 8－5．Latency with different Decimation options

| DECIMATION OPTION | TOTAL LATENCY，DEVICE CLOCK CYCLES |
| :---: | :---: |
| Divide－by－4 | 516 |
| Divide－by－6 | 746 |
| Divide－by－8 | 621 |
| Divide－by－9 | 763.5 |
| Divide－by－10 | 811 |
| Divide－by－12 | 897 |
| Divide－by－16 | 1045 |
| Divide－by－18 | 1164 |
| Divide－by－20 | 1256 |
| Divide－by－24 | 1443 |
| Divide－by－32 | 1773 |

## 8．3．4．4 Digital Multiplexer（MUX）

The ADC32RF8x supports a mode where the output data of the ADC channel A can be routed internally to the digital blocks of both channel $A$ and channel $B$ ．The ADC channel $B$ can be powered down as shown in 图 8－41． In this manner，the ADC32RF8x can be configured as a single－channel ADC with up to four independent DDC chains or two wideband DDC chains．All decimation filters and JESD204B format configurations are identical to the two ADC channel operation．


图8－41．Digital Multiplexer Option

## 8．3．4．5 Numerically－Controlled Oscillators（NCOs）and Mixers

The ADC32RF8x is equipped with three independent，complex NCOs per ADC channel．The oscillator generates a complex exponential sequence，as shown in 方程式 2 ．

$$
\begin{equation*}
x[n]=e^{-j \omega n} \tag{2}
\end{equation*}
$$

where
－frequency（ $\omega$ ）is specified as a signed number by the 16 －bit register setting
The complex exponential sequence is multiplied by the real input from the ADC to mix the desired carrier down to 0 Hz ．

Each ADC channel has two DDCs．The first DDC has three NCOs and the second DDC has one NCO．The first DDC can dynamically select one of the three NCOs based on the GPIO pin or SPI selection．In wide－bandwidth mode（lower decimation factors，for example， 4 and 6 ），there can only be one DDC for each ADC channel．The NCO frequencies can be programmed independently through the DDCx，NCO［4：1］，and the MSB and LSB register settings．

The NCO frequency setting is set by the 16－bit register value given by 方程式 3 ：

$$
\begin{equation*}
f_{N C O}=\frac{D D C x N C O y \times f_{S}}{2^{16}} \tag{3}
\end{equation*}
$$

where
－ $\mathrm{x}=0,1$
－$y=1$ to 4
For example：
If $f_{S}=2949.12$ MSPS，then the NCO register setting $=38230$（decimal）．
Thus，$f_{\mathrm{NCO}}$ is defined by 方程式 4：

$$
\begin{equation*}
f_{\mathrm{NCO}}=38230 \times \frac{2949.12 \mathrm{MSPS}}{2^{16}}=1720.35 \mathrm{MHz} \tag{4}
\end{equation*}
$$

Any register setting changes that occur after the JESD204B interface is operational results in a non－deterministic NCO phase．If a deterministic phase is required，the JESD204B interface must be reinitialized after changing the register setting．

## 8．3．5 NCO Switching

The first DDC（DDCO）on each ADC channel provides three different NCOs that can be used for phase－coherent frequency hopping．This feature is available in both single－band and dual－band mode，but only affects DDCO．

The NCOs can be switched through an SPI control or by using the GPIO pins with the register configurations shown in 表 8－6 for channel A（ 50 xxh ）and channel B（ 58 xxh ）．The assignment of which GPIO pin to use for INSELO and INSEL1 is done based on 表 $8-7$ ，using registers 5438 h and 5 C 38 h ．The NCO selection is done based on the logic selection on the GPIO pins；see 表 8－8 and 图 8－42．

表 8－6．NCO Register Configurations

| REGISTER | ADDRESS | DESCRIPTION |
| :---: | :---: | :--- |
| NCO CONTROL THROUGH GPIO PINS |  |  |
| NCO SEL pin | $500 \mathrm{Fh}, 580 \mathrm{Fh}$ | Selects the NCO control through the SPI（default）or a GPIO pin． |
| INSELO，INSEL1 | $5438 \mathrm{~h}, 5 \mathrm{C} 38 \mathrm{~h}$ | Selects which two GPIO pins are used to control the NCO． |
| NCO CONTROL THROUGH SPI CONTROL |  |  |
| NCO SEL pin |  | $500 \mathrm{Fh}, 580 \mathrm{Fh}$ |
| NCO SEL | 5010h，5810h | Selects the NCO control through the SPI（default）or a GPIO pin． |

表 8－7．GPIO Pin Assignment

| INSELx［1：0］（Where $\mathbf{x}=\mathbf{0}$ or $\mathbf{1 )}$ | GPIO PIN SELECTED |
| :---: | :---: |
| 00 | GPIO4 |
| 01 | GPIO1 |
| 10 | GPIO3 |

表 8－7．GPIO Pin Assignment（continued）

| INSELx［1：0］（Where $\mathbf{x}=\mathbf{0}$ or $\mathbf{1})$ | GPIO PIN SELECTED |
| :---: | :---: |
| 11 | GPIO2 |

表 8－8．NCO Selection

| NCO SEL［1］ | NCO SEL［0］ | NCO SELECTED |
| :---: | :---: | :---: |
| 0 | 0 | NCO1 |
| 0 | 1 | NCO2 |
| 1 | 0 | NCO3 |
| 1 | 1 | n／a |



图 8－42．NCO Switching from GPIO and SPI

## 8．3．6 SerDes Transmitter Interface

Each 12．3－Gbps serializer，deserializer（SerDes）LVDS transmitter output requires ac－coupling between the transmitter and receiver．Terminate the differential pair with $100-\Omega$ resistance（that is，two $50-\Omega$ resistors）as close to the receiving device as possible to avoid unwanted reflections and signal degradation，as shown in 图 8－43．


图 8－43．External Serial JESD204B Interface Connection

## 8．3．7 Eye Diagrams

图 8－44 and 图8－45 show the serial output eye diagrams of the ADC32RF8x at 5.0 Gbps and 12 Gbps against the JESD204B mask．


## 8．3．8 Alarm Outputs：Power Detectors for AGC Support

The GPIO pins can be configured as alarm outputs for channels $A$ and $B$ ．The ADC32RF8x supports three different power detectors（an absolute peak power detector，crossing detector，and RMS power detector）as well as fast overrange from the ADC．The power detectors operate off the full－rate ADC output prior to the decimation filters．

## 8．3．8．1 Absolute Peak Power Detector

In this detector mode，the peak is computed over eight samples of the ADC output．Next，the peak for a block of $N$ samples（ $\mathrm{N} \times \mathrm{S}^{\prime}$ ）is computed over a programmable block length and then compared against a threshold to either set or reset the peak detector output（图8－46 and 图8－47）．There are two sets of thresholds and each set has two thresholds for hysteresis．The programmable DWELL－time counter is used for clearing the block detector alarm output．


图 8－46．Peak Power Detector Implementation


图8－47．Peak Power Detector Timing Diagram
表 8－9 shows the register configurations required to set up the absolute peak power detector．The detector operates in the $f_{S} / 8$ clock domain；one peak sample is calculated over eight actual samples．
The automatic gain control（AGC）modes can be configured separately for channel $A$（54xxh）and channel $B$ （5Cxxh），although some registers are common in $54 x x h$（such as the GPIO pin selection）．

表 8－9．Registers Required for the Peak Power Detector

\begin{tabular}{|c|c|c|}
\hline REGISTER \& ADDRESS \& DESCRIPTION <br>
\hline PKDET EN \& 5400，5C00h \& Enables peak detector <br>
\hline BLKPKDET \& $$
\begin{aligned}
& \text { 5401h, 5402h, } \\
& \text { 5403h, 5C01h, } \\
& \text { 5C02h, 5C03h }
\end{aligned}
$$ \& Sets the block length $N$ of number of samples（ $S^{`}$ ）．Number of actual ADC samples is $8 x$ this value： N is 17 bits： 1 to $2^{16}$ ． <br>
\hline BLKTHHH， BLKTHHL， BLKTHLH， BLKTHLL \& \[
$$
\begin{aligned}
& \text { 5407h, 5408h, } \\
& \text { 5409h, 540Ah, } \\
& \text { 5C07h, 5C08h, } \\
& \text { 5C09h, 5C0Ah }
\end{aligned}
$$

\] \& | Sets the different thresholds for the hysteresis function values from 0 to 256 （where 256 is equivalent to the peak amplitude）． |
| :--- |
| For example：if BLKTHHH is to -2 dBFS from peak， $10^{(-2 / 20)} \times 256=203$ ，then set 5407 h and $5 \mathrm{C} 07 \mathrm{~h}=\mathrm{CBh}$ ． | <br>

\hline DWELL \& 540Bh，540Ch， 5C0Bh，5C0Ch \& When the computed block peak crosses the upper thresholds BLKTHHH or BLKTHLH，the peak detector output flags are set．In order to be reset，the computed block peak must remain continuously lower than the lower threshold（BLKTHHL or BLKTHLL）for the period specified by the DWELL value．This threshold is 16 bits and is specified in terms of $f_{S} / 8$ clock cycles． <br>

\hline $$
\begin{aligned}
& \text { OUTSEL } \\
& \text { GPIO[4:1] }
\end{aligned}
$$ \& \[

$$
\begin{aligned}
& \text { 5432h, 5433h, } \\
& \text { 5434h, 5435h }
\end{aligned}
$$
\] \& Connects the BLKPKDETH，BLKPKDETL alarms to the GPIO pins；common register． <br>

\hline IODIR \& 5437h \& Selects the direction for the four GPIO pins；common register． <br>
\hline RESET AGC \& 542Bh，5C2Bh \& After configuration，reset the AGC module to start operation． <br>
\hline
\end{tabular}

## 8．3．8．2 Crossing Detector

In this detector mode the peak is computed over eight samples of the ADC output．Next，the peak for a block of N samples $\left(\mathrm{N} \times \mathrm{S}^{\prime}\right)$ is computed over a programmable block length and then the peak is compared against two sets of programmable thresholds（with hysteresis）．The crossing detector counts how many $\mathrm{f}_{\mathrm{S}} / 8$ clock cycles that the block detector outputs are set high over a programmable time period and compares the counter value against the programmable thresholds．The alarm outputs are updated at the end of the time period，routed to the GPIO pins，and held in that state through the next cycle，as shown in 图8－48 and 图8－49．Alternatively，a 2－bit format can be used but（because the ADC32RF8x has four GPIO pins available）this feature uses all four pins for a single channel．


图 8－48．Crossing Detector Implementation


图8－49．Crossing Detector Timing Diagram

表 8-10 shows the register configurations required to set up the crossing detector. The detector operates in the $f_{S} / 8$ clock domain. The AGC modes can be configured separately for channel A ( $54 x x h$ ) and channel B ( 5 Cxxh ), although some registers are common in 54 xxh (such as the GPIO pin selection).

表 8-10. Registers Required for the Crossing Detector Operation

| REGISTER | ADDRESS | DESCRIPTION |
| :---: | :---: | :---: |
| PKDET EN | 5400h, 5C00h | Enables peak detector |
| BLKPKDET | 5401h, 5402h, 5403h, 5C01h, 5C02h, 5C03h | Sets the block length $N$ of number of samples ( $S^{\circ}$ ). <br> Number of actual ADC samples is 8 x this value: N is 17 bits: 1 to $2^{16}$. |
| BLKTHHH, BLKTHHL, BLKTHLH, BLKTHLL | 5407h, 5408h, 5409h, 540Ah, 5C07h, 5C08h, 5C09h, 5C0Ah | Sets the different thresholds for the hysteresis function values from 0 to 256 (where 256 is equivalent to the peak amplitude). <br> For example: if BLKTHHH is to -2 dBFS from peak, $10(-2 / 20) \times 256=203$, then set 5407 h and $5 \mathrm{C} 07 \mathrm{~h}=\mathrm{CBh}$. |
| FILTOLPSEL | 540Dh, 5CODh | Select block detector output or 2-bit output mode as the input to the interrupt identification register (IIR) filter. |
| TIMECONST | 540Eh, 540Fh, 5C0Eh, 5C0Fh | Sets the crossing detector time period for $\mathrm{N}=0$ to 15 as $2 \mathrm{~N} \times \mathrm{f}_{\mathrm{S}} / 8$ clock cycles The maximum time period is $32768 \times \mathrm{f}_{\mathrm{S}} / 8$ clock cycles (approximately $87 \mu \mathrm{~s}$ at 3 GSPS). |
| FILOTHH, FILOTHL, FIL1THH, FIL1THL | 540Fh-5412h, 5C0Fh-5C12h, 5416h-5419h, 5C16h-5C19h | Comparison thresholds for the crossing detector counter. These thresholds are 16bit thresholds in 2.14-signed notation. A value of 1 (4000h) corresponds to $100 \%$ crossings, a value of 0.125 ( 0800 h ) corresponds to $12.5 \%$ crossings. |
| DWELLIIR | 541Dh, 541Eh, 5C1Dh, 5C1Eh | DWELL counter for the IIR filter hysteresis. |
| IIRO 2BIT EN, IIR1 2BIT EN | 5413h, 54114h, 5C13h, 5C114h | Enables 2-bit output format for the crossing detector. |
| OUTSEL GPIO[4:1] | $\begin{aligned} & \text { 5432h, 5433h, } \\ & \text { 5434h, 5435h } \end{aligned}$ | Connects the IIRPKDETO, IIRPKDET1 alarms to the GPIO pins; common register. |
| IODIR | 5437h | Selects the direction for the four GPIO pins; common register. |
| RESET AGC | 542Bh, 5C2Bh | After configuration, reset the AGC module to start operation. |

## 8．3．8．3 RMS Power Detector

In this detector mode the peak power is computed for a block of $N$ samples over a programmable block length and then compared against two sets of programmable thresholds（with hysteresis）．

The RMS power detector circuit provides configuration options，as shown in 图 8－50．The RMS power value（1 or 2 bit）can be output onto the GPIO pins．In 2－bit output mode，two different thresholds are used whereas the 1－bit output provides one threshold together with hysteresis．


## 图 8－50．RMS Power Detector Implementation

表 8－11 shows the register configurations required to set up the RMS power detector．The detector operates in the $f_{S} / 8$ clock domain．The AGC modes can be configured separately for channel A（ $54 \times x h$ ）and channel B （5Cxxh），although some registers are common in 54xxh（such as the GPIO pin selection）．

表 8－11．Registers Required for Using the RMS Power Detector Feature

| REGISTER | ADDRESS | DESCRIPTION |
| :---: | :---: | :--- |
| RMSDET EN | $5420 \mathrm{~h}, 5 \mathrm{C} 20 \mathrm{~h}$ | Enables RMS detector |
| PWRDETACCU | $5421 \mathrm{~h}, 5 \mathrm{C} 21 \mathrm{~h}$ | Programs the block length to be used for RMS power computation．The block length <br> is defined in terms of $\mathrm{f}_{\mathrm{S}} / 8$ clocks． <br> The block length can be programmed as $2^{\mathrm{M}}$ with $\mathrm{M}=0$ to 16. |
| PWRDETH， <br> PWRDETL | $5422 \mathrm{~h}, 5423 \mathrm{~h}, 5424 \mathrm{~h}$, <br> $5425 \mathrm{~h}, 5 \mathrm{C} 22 \mathrm{~h}, 5 \mathrm{C} 23 \mathrm{~h}$, <br> $5 \mathrm{C} 24 \mathrm{~h}, 5 \mathrm{C} 25 \mathrm{~h}$ | The computed average power is compared against these high and low thresholds． <br> One LSB of the thresholds represents $1 / 2^{16}$ ．For example：is PWRDETH is set to－ <br> 14 dBFS from peak，$[10(-14 / 20)]^{2} \times 2^{16}=2609$, then set $5422 \mathrm{~h}, 5423 \mathrm{~h}, 5 \mathrm{C} 22 \mathrm{~h}$, <br> $5 \mathrm{C} 23 \mathrm{~h}=0 \mathrm{~A} 31 \mathrm{~h}$. |
| RMS2BIT EN | $5427 \mathrm{~h}, 5 \mathrm{C} 27 \mathrm{~h}$ | Enables 2－bit output format for the RMS detector output． |
| OUTSEL GPIO［4：1］ | $5432 \mathrm{~h}, 5433 \mathrm{~h}$, <br> $5434 \mathrm{~h}, 5435 \mathrm{~h}$ | Connects the PWRDET alarms to the GPIO pins；common register． |
| IODIR | 5437 h | Selects the direction for the four GPIO pins；common register． |
| RESET AGC | $542 \mathrm{Bh}, 5 \mathrm{C} 2 \mathrm{Bh}$ | After configuration，reset the AGC module to start operation． |

## 8．3．8．4 GPIO AGC MUX

The GPIO pins can be used to control the NCO in wideband DDC mode or as alarm outputs for channel A and B．The GPIO pins can be configured through the SPI control to output the alarm from the peak power（1 bit）， crossing detector（ 1 or 2 bit），faster overrange，or the RMS power output，as shown in 图 8－51．

The programmable output MUX allows connecting any signal（including the NCO control）to any of the four GPIO pins．These pins can be configured as outputs（AGC alarm）or inputs（NCO control）through SPI programming．


OUTSEL GPIO［4：1］
图8－51．GPIO Output MUX Implementation

## 8．3．9 Power－Down Mode

The ADC32RF8x provides a lot of configurability for the power－down mode．Power－down can be enabled using the PDN pin or the SPI register writes．

## 8．3．10 ADC Test Pattern

The ADC32RF8x provides several different options to output test patterns instead of the actual output data of the ADC in order to simplify the serial interface and system debug of the JESD204B digital interface link．The output data path is shown in 图 8－52．


图 8－52．Test Pattern Generator Implementation

## 8．3．10．1 Digital Block

The ADC test pattern replaces the actual output data of the ADC．The test patterns listed in 表 $8-12$ are available when the DDC is enabled and located in register 37 h of the decimation filter page．When programmed，the test patterns are output for each converter $(M)$ stream．The number of converter streams per channel increases by 2 when complex（I，Q）output or dual－band DDC is selected．The test patterns can be synchronized for both ADC channels using the SYSREF signal．
Additionally，a 12－bit test pattern is also available．

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## 备注

The number of converters increases in dual－band DDC mode and with a complex output．
表 8－12．Test Pattern Options（Register 37h and 38h in Decimation Filter Page）

| BIT | NAME | DEFAULT | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| Address 37h， <br> 38h（bits 7－0） | TEST PATTERN DDC1 I－DATA， TEST PATTERN DDC1 Q－DATA， TEST PATTERN DDC2 I－DATA， TEST PATTERN DDC2 Q－DATA， | 0000 | Test pattern outputs onl and $Q$ stream of channel $A$ and $B$ when DDC option is chosen． <br> $0000=$ Normal operation using ADC output data <br> 0001 ＝Outputs all 0s <br> $0010=$ Outputs all 1 s <br> 0011 ＝Outputs toggle pattern：output data are an alternating sequence of 10101010101010 and 01010101010101 <br> $0100=$ Output digital ramp：output data increment by one LSB every clock cycle from code 0 to 65535 <br> $0110=$ Single pattern：output data are a custom pattern 1 （ 75 h and 76h） <br> 0111 Double pattern：output data alternate between custom pattern 1 and custom pattern 2 <br> 1000 ＝Deskew pattern：output data are AAAAh <br> 1001 ＝SYNC pattern：output data are FFFFh |

## 8．3．10．2 Transport Layer

The transport layer maps the ADC output data into 8－bit octets and constructs the JESD204B frames using the LMFS parameters．Tail bits or O＇s are added when needed．Alternatively，the JESD204B long transport layer test pattern can be substituted instead of the ADC data with the JESD frame，as shown in 表 8－13．

表 8－13．Transport Layer Test Mode EN（Register 01h）

| BIT | NAME | DEFAULT | DESCRIPTION |
| :---: | :---: | :---: | :--- |
| 4 | TESTMODE EN | 0 | Generates long transport layer test pattern mode <br> according to section 5．1．6．3 of the JESD204B <br> specification． <br> $0=$ Test mode disabled <br> $1=$ Test mode disabled |

## 8．3．10．3 Link Layer

The link layer contains the scrambler and the $8 \mathrm{~b}, 10 \mathrm{~b}$ encoding of any data passed on from the transport layer． Additionally，the link layer also handles the initial lane alignment sequence that can be manually restarted．
The link layer test patterns are intended for testing the quality of the link（jitter testing and so forth）．The test patterns do not pass through the 8b，10b encoder and contain the options listed in 表 8－14．

表 8－14．Link Layer Test Mode（Register 03h）

| BIT | NAME | DEFAULT | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| 7－5 | LINK LAYER TESTMODE | 000 | Generates a pattern according to section 5．3．3．8．2 of the JESD204B document． <br> $000=$ Normal ADC data <br> 001 ＝D21．5（high－frequency jitter pattern） <br> $010=$ K28．5（mixed－frequency jitter pattern） <br> $011=$ Repeat the initial lane alignment（generates a K28．5 character and repeats lane alignment sequences continuously） <br> $100=12$－octet random pattern（RPAT）jitter pattern |

Furthermore，a $2^{15}$ pseudo－random binary sequence（PRBS）can be enabled by setting up a custom test pattern （AAAAh）in the ADC section and running AAAAh through the 8b，10b encoder with scrambling enabled．

## 8．4 Device Functional Modes

## 8．4．1 Device Configuration

The ADC32RF8x can be configured using a serial programming interface，as described in the 节 8.4 .3 section．In addition，the device has one dedicated parallel pin（PDN）for controlling the power－down modes．

## 8．4．2 JESD204B Interface

The ADC32RF8x supports device subclass 1 with a maximum output data rate of 12.5 Gbps for each serial transmitter．

An external SYSREF signal is used to align all internal clock phases and the local multiframe clock to a specific sampling clock edge．This alignment allows synchronization of multiple devices in a system and minimizes timing and alignment uncertainty．The SYNCB input is used to control the JESD204B SerDes blocks，as shown in 图 8－53．

Depending on the ADC sampling rate，the JESD204B output interface can be operated with one，two，or four lanes per ADC channel．The JESD204B setup and configuration of the frame assembly parameters is controlled through the SPI interface．


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## 图 8－53．JESD Signal Overview

The JESD204B transmitter block consists of the transport layer，the data scrambler，and the link layer，as shown in 图 8－54．The transport layer maps the ADC output data into the selected JESD204B frame data format and manages if the ADC output data or test patterns are transmitted．The link layer performs the $8 \mathrm{~b}, 10 \mathrm{~b}$ data encoding as well as the synchronization and initial lane alignment using the SYNC input signal．Optionally，data from the transport layer can be scrambled．

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图8－54．JESD Digital Block Implementation

## 8．4．2．1 JESD204B Initial Lane Alignment（ILA）

The receiving device starts the initial lane alignment process by deasserting the SYNCB signal．The SYNCB signal can be issued using the SYNCB input pins or by setting the proper SPI bits．When a logic low is detected on the SYNCB input，the ADC32RF8x starts transmitting comma（K28．5）characters to establish the code group synchronization，as shown in 图 8－55．
When synchronization completes，the receiving device reasserts the SYNCB signal and the ADC32RF8x starts the initial lane alignment sequence with the next local multiframe clock boundary．The ADC32RF8x transmits four multiframes，each containing K frames（ K is SPI programmable）．Each of the multiframes contains the frame start and end symbols．The second multiframe also contains the JESD204 link configuration data．


图 8－55．JESD Internal Timing Information

## 8．4．2．2 JESD204B Frame Assembly

The JESD204B standard defines the following parameters：
－$F$ is the number of octets per frame clock period
－$L$ is the number of lanes per link
－ M is the number of converters for the device
－$S$ is the number of samples per frame

## 8．4．2．3 JESD204B Frame Assembly with Decimation（Single－Band DDC）：Complex Output

表 8－15 lists the available JESD204B interface formats and valid ranges for the ADC32RF8x with decimation （single－band DDC）when using a complex output format．The ranges are limited by the SerDes line rate and the maximum ADC sample frequency．The sample alignment on the different lanes is shown in 表 8－16．

表 8－15．JESD Mode Options：Single－Band Complex Output

| DECIMATIO N SETTING （Complex） | NUMBER OF ACTIVE DDCS | L | M | F | S | PLL MODE | JESD MODEO | $\begin{aligned} & \hline \text { JESD } \\ & \text { MODE1 } \end{aligned}$ | JESD <br> MODE2 | RATIO ［fSerDes／f CLK（Gbps／ GSPS）］ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Divide－by－4 | 1per channel | 8 | 4 | 1 | 1 | 20X | 1 | 1 | 0 | 2.5 |
|  |  | 8 | 4 | 2 | 2 | 20X | 1 | 0 | 0 |  |
|  |  | 4 | 4 | 2 | 1 | 40X | 0 | 0 | 1 | 5 |
|  |  | 4 | 4 | 4 | 2 | 40X | 2 | 0 | 0 |  |
| Divide－by－6 | 1per channel | 8 | 4 | 1 | 1 | 20X | 1 | 1 | 0 | 1.67 |
|  |  | 8 | 4 | 2 | 2 | 20X | 1 | 0 | 0 |  |
|  |  | 4 | 4 | 2 | 1 | 40X | 0 | 0 | 1 | 3.33 |
|  |  | 4 | 4 | 4 | 2 | 40X | 2 | 0 | 0 |  |
| Divide－by－8 | 1per channel | 4 | 4 | 2 | 1 | 20X | 1 | 0 | 0 | 2.5 |
|  |  | 2 | 4 | 4 | 1 | 40X | 2 | 0 | 0 | 5 |
| Divide－by－9 | 1per channel | 4 | 4 | 2 | 1 | 20X | 1 | 0 | 0 | 2.22 |
|  |  | 2 | 4 | 4 | 1 | 40X | 2 | 0 | 0 | 4.44 |
| Divide－by－10 | 1per channel | 4 | 4 | 2 | 1 | 20X | 1 | 0 | 0 | 2 |
|  |  | 2 | 4 | 4 | 1 | 40X | 2 | 0 | 0 | 4 |
| Divide－by－12 | 1per channel | 4 | 4 | 2 | 1 | 20X | 1 | 0 | 0 | 1.67 |
|  |  | 2 | 4 | 4 | 1 | 40X | 2 | 0 | 0 | 3.33 |
| Divide－by－16 | 1per channel | 4 | 4 | 2 | 1 | 20X | 1 | 0 | 0 | 1.25 |
|  |  | 2 | 4 | 4 | 1 | 40X | 2 | 0 | 0 | 2.5 |
| Divide－by－18 | 1 per channel | 4 | 4 | 2 | 1 | 20X | 1 | 0 | 0 | 1.11 |
|  |  | 2 | 4 | 4 | 1 | 40X | 2 | 0 | 0 | 2.22 |
| Divide－by－20 | 1per channel | 4 | 4 | 2 | 1 | 20X | 1 | 0 | 0 | 1 |
|  |  | 2 | 4 | 4 | 1 | 40X | 2 | 0 | 0 | 2 |
| Divide－by－24 | 1per channel | 2 | 4 | 4 | 1 | 20X | 1 | 0 | 0 | 1.67 |
| Divide－by－32 | 1per channel | 2 | 4 | 4 | 1 | 40X | 2 | 0 | 0 | 1.25 |

表 8－16．JESD Sample Lane Alignments：Single－Band Complex Output

| OUTPUT LANE | $\begin{gathered} \text { LMFS }= \\ 8411 \end{gathered}$ | LMFS＝ 8422 |  | LMFS $=4421$ 20x |  | LMFS $=4421$ 40x |  | LMFS $=4442$ |  |  |  | LMFS $=2441$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DAO | $\begin{gathered} \mathrm{Al}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{aligned} & \mathrm{Al}_{0} \\ & {[15: 8]} \end{aligned}$ | $\begin{gathered} \mathrm{Al}_{0} \\ {[7: 0]} \end{gathered}$ |  |  |  |  |  |  |  |  |  |  |
| DA1 | $\begin{gathered} \mathrm{Al}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{1} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{1} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{AQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{AQ}_{0} \\ & {[7: 0]} \end{aligned}$ | $\begin{gathered} \mathrm{Al}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{1} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{1} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{Al}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{AQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{AQ}_{0} \\ & {[7: 0]} \end{aligned}$ |
| DA2 | $\begin{gathered} \mathrm{AQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{AQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \hline \mathrm{AQ}_{0} \\ & {[7: 0]} \end{aligned}$ |  |  | $\begin{gathered} \mathrm{AQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{AQ}_{0} \\ & {[7: 0]} \end{aligned}$ | $\begin{gathered} \mathrm{AQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{AQ}_{0} \\ & {[7: 0]} \end{aligned}$ | $\begin{gathered} \hline \mathrm{AQ}_{1} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \hline \mathrm{AQ}_{1} \\ & {[7: 0]} \end{aligned}$ |  |  |  |  |
| DA3 | $\begin{aligned} & \mathrm{AQ}_{0} \\ & {[7: 0]} \end{aligned}$ | $\begin{gathered} \mathrm{AQ}_{1} \\ {[15: 8]} \\ \hline \end{gathered}$ | $\begin{aligned} & \mathrm{AQ}_{1} \\ & {[7: 0]} \end{aligned}$ |  |  |  |  |  |  |  |  |  |  |  |  |
| DB0 | $\begin{gathered} \mathrm{BI}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \hline \mathrm{BI}_{0} \\ {[7: 0]} \end{gathered}$ |  |  |  |  |  |  |  |  |  |  |
| DB1 | $\begin{gathered} \mathrm{BI}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{1} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{1} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{BQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{BQ}_{0} \\ & {[7: 0]} \end{aligned}$ | $\begin{gathered} \mathrm{BI}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{1} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{1} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{gathered} \mathrm{BI}_{0} \\ {[7: 0]} \end{gathered}$ | $\begin{gathered} \mathrm{BQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{BQ}_{0} \\ & {[7: 0]} \end{aligned}$ |
| DB2 | $\begin{gathered} \mathrm{BQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{BQ}_{0} \\ & {[15: 8} \end{aligned}$ | $\begin{aligned} & \mathrm{BQ}_{0} \\ & {[7: 0]} \end{aligned}$ |  |  | $\begin{gathered} \mathrm{BQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{BQ}_{0} \\ & {[7: 0]} \end{aligned}$ | $\begin{gathered} \mathrm{BQ}_{0} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{BQ}_{0} \\ & {[7: 0]} \end{aligned}$ | $\begin{gathered} \mathrm{BQ}_{1} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{BQ}_{1} \\ & {[7: 0]} \end{aligned}$ |  |  |  |  |
| DB3 | $\begin{aligned} & \mathrm{BQ}_{0} \\ & {[7: 0]} \end{aligned}$ | $\begin{gathered} \mathrm{BQ}_{1} \\ {[15: 8]} \end{gathered}$ | $\begin{aligned} & \mathrm{BQ}_{1} \\ & {[7: 0]} \end{aligned}$ |  |  |  |  |  |  |  |  |  |  |  |  |

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## 8．4．2．4 JESD204B Frame Assembly with Decimation（Single－Band DDC）：Real Output

表 8－17 lists the available JESD204B formats and valid ranges for the ADC32RF8x with decimation（single－band DDC）when using real output format．The ranges are limited by the SerDes line rate and the maximum ADC sample frequency．The sample alignment on the different lanes is shown in 表 8－18．

表 8－17．JESD Mode Options：Single－Band Real Output（Wide Bandwidth）

| DECIMATION SETTING（Complex） | NUMBER OF ACTIVE DDCS | L | M | F | S | PLL MODE | JESD MODE0 | JESD MODE1 | JESD MODE2 | RATIO <br> ［ $\mathrm{f}_{\text {SerDes }} / \mathrm{f}_{\mathrm{CLK}}$ （Gbps／GSPS）］ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Divide－by－4 （Divide－by－2 real） | 1 per channel | 8 | 2 | 2 | 4 | 20x | 1 | 0 | 0 | 2.5 |
|  |  | 4 | 2 | 4 | 4 | 40x | 2 | 0 | 0 | 5 |
|  |  | 4 | 2 | 1 | 1 | 40x | 0 | 0 | 1 |  |
| Divide－by－6 （Divide－by－3 real） | 1 per channel | 8 | 2 | 2 | 4 | 20x | 1 | 0 | 0 | 1.67 |
|  |  | 4 | 2 | 4 | 4 | 40x | 2 | 0 | 0 | 3.33 |
|  |  | 4 | 2 | 1 | 1 | 40x | 0 | 0 | 1 |  |

表 8－18．JESD Sample Lane Alignment：Single－Band Real Output（Wide Bandwidth）

| OUTPUT LANE | LMFS＝824 |  | LMFS＝4244 |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DA0 | $\mathrm{A}_{0}[15: 8]$ | $\mathrm{A}_{0}[7: 0]$ |  |  |  |  | LMFS＝4211 |
| DA1 | $\mathrm{A}_{1}[15: 8]$ | $\mathrm{A}_{1}[7: 0]$ | $\mathrm{A}_{0}[15: 8]$ | $\mathrm{A}_{0}[7: 0]$ | $\mathrm{A}_{1}[15: 8]$ | $\mathrm{A}_{1}[7: 0]$ | $\mathrm{A}_{0}[15: 8]$ |
| DA2 | $\mathrm{A}_{2}[15: 8]$ | $\mathrm{A}_{2}[7: 0]$ | $\mathrm{A}_{2}[15: 8]$ | $\mathrm{A}_{2}[7: 0]$ | $\mathrm{A}_{3}[15: 8]$ | $\mathrm{A}_{3}[7: 0]$ | $\mathrm{A}_{0}[7: 0]$ |
| DA3 | $\mathrm{A}_{3}[15: 8]$ | $\mathrm{A}_{3}[7: 0]$ |  |  |  |  |  |
| DB0 | $\mathrm{B}_{0}[15: 8]$ | $\mathrm{B}_{0}[7: 0]$ |  |  |  |  |  |
| DB1 | $\mathrm{B}_{1}[15: 8]$ | $\mathrm{B}_{1}[7: 0]$ | $\mathrm{B}_{0}[15: 8]$ | $\mathrm{B}_{0}[7: 0]$ | $\mathrm{B}_{1}[15: 8]$ | $\mathrm{B}_{1}[7: 0]$ | $\mathrm{B}_{0}[15: 8]$ |
| DB2 | $\mathrm{B}_{2}[15: 8]$ | $\mathrm{B}_{2}[7: 0]$ | $\mathrm{B}_{0}[15: 8]$ | $\mathrm{B}_{2}[7: 0]$ | $\mathrm{B}_{3}[15: 8]$ | $\mathrm{B}_{3}[7: 0]$ | $\mathrm{B}_{0}[7: 0]$ |
| DB3 | $\mathrm{B}_{3}[15: 8]$ | $\mathrm{B}_{3}[7: 0]$ |  |  |  |  |  |

## 8．4．2．5 JESD204B Frame Assembly with Decimation（Single－Band DDC）：Real Output

表 8－19 lists the available JESD204B formats and valid ranges for the ADC32RF8x with decimation（dual－band DDC）when using a complex output format．The sample alignment on the different lanes is shown in 表 8－20．

表 8－19．JESD Mode Options：Single－Band Real Output

| DECIMATION SETTING（Complex） | NUMBER OF ACTIVE DDCS | L | M | F | S | $\begin{aligned} & \text { PLL } \\ & \text { MODE } \end{aligned}$ | JESD MODE0 | $\begin{aligned} & \text { JESD } \\ & \text { MODE1 } \end{aligned}$ | $\begin{aligned} & \text { JESD } \\ & \text { MODE2 } \end{aligned}$ | RATIO <br> ［ $\mathrm{f}_{\text {SerDes }} / \mathrm{f}_{\mathrm{CLK}}$ （Gbps／GSPS）］ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Divide－by－8 （Divide－by－4 real） | 1 per channel | 4 | 2 | 1 | 1 | 20x | 1 | 1 | 0 | 2.5 |
|  |  | 4 | 2 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 2 | 2 | 2 | 1 | 40x | 0 | 0 | 1 | 5 |
|  |  | 2 | 2 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－9 <br> （Divide－by－4．5 real） | 1 per channel | 4 | 2 | 1 | 1 | 20x | 1 | 1 | 0 | 2.22 |
|  |  | 4 | 2 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 2 | 2 | 2 | 1 | 40x | 0 | 0 | 1 | 4.44 |
|  |  | 2 | 2 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－10 （Divide－by－5 real） | 1 per channel | 4 | 2 | 1 | 1 | 20x | 1 | 1 | 0 | 2 |
|  |  | 4 | 2 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 2 | 2 | 2 | 1 | 40x | 0 | 0 | 1 | 4 |
|  |  | 2 | 2 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－12 （Divide－by－6 real） | 1 per channel | 4 | 2 | 1 | 1 | 20x | 1 | 1 | 0 | 1.67 |
|  |  | 4 | 2 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 2 | 2 | 2 | 1 | 40x | 0 | 0 | 1 | 3.33 |
|  |  | 2 | 2 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－16 （Divide－by－8 real） | 1 per channel | 4 | 2 | 1 | 1 | 20x | 1 | 1 | 0 | 1.25 |
|  |  | 4 | 2 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 2 | 2 | 2 | 1 | 40x | 0 | 0 | 1 | 2.5 |
|  |  | 2 | 2 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－18 （Divide－by－9 real） | 1 per channel | 4 | 2 | 1 | 1 | 20x | 1 | 1 | 0 | 1.11 |
|  |  | 4 | 2 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 2 | 2 | 2 | 1 | 40x | 0 | 0 | 1 | 2.22 |
|  |  | 2 | 2 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－20（Divide－by－10 real） | 1 per channel | 4 | 2 | 1 | 1 | 20x | 1 | 1 | 0 | 1 |
|  |  | 4 | 2 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 2 | 2 | 2 | 1 | 40x | 0 | 0 | 1 | 2 |
|  |  | 2 | 2 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－24 （Divide－by－12 real） | 1 per channel | 2 | 2 | 2 | 1 | 40x | 0 | 0 | 1 | 1.67 |
|  |  | 2 | 2 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| $\begin{gathered} \text { Divide-by-32 } \\ \text { (Divide-by-16 real) } \end{gathered}$ | 1 per channel | 2 | 2 | 2 | 1 | 40x | 0 | 0 | 1 | 1.25 |
|  |  | 2 | 2 | 4 | 2 | 40x | 2 | 0 | 0 |  |

表 8－20．JESD Sample Lane Assignment：Single－Band Real Output

| OUTPUT <br> LANE | LMFS＝ <br> $\mathbf{4 2 1 1}$ | LMFS＝4222 |  | LMFS＝2221 |  | LMFS＝2242 |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DA0 | $\mathrm{A}_{0}[15: 8]$ | $\mathrm{A}_{0}[15: 8]$ | $\mathrm{A}_{0}[7: 0]$ |  |  |  |  |  |  |
| DA1 | $\mathrm{A}_{0}[7: 0]$ | $\mathrm{A}_{1}[15: 8]$ | $\mathrm{A}_{1}[7: 0]$ | $\mathrm{A}_{0}[15: 8]$ | $\mathrm{A}_{0}[7: 0]$ | $\mathrm{A}_{0}[15: 8]$ | $\mathrm{A}_{0}[7: 0]$ | $\mathrm{A}_{1}[15: 8]$ | $\mathrm{A}_{1}[7: 0]$ |
| DB0 | $\mathrm{B}_{0}[15: 8]$ | $\mathrm{B}_{0}[15: 8]$ | $\mathrm{B}_{0}[7: 0]$ |  |  |  |  |  |  |
| DB1 | $\mathrm{B}_{0}[7: 0]$ | $\mathrm{B}_{1}[15: 8]$ | $\mathrm{B}_{1}[7: 0]$ | $\mathrm{B}_{0}[15: 8]$ | $\mathrm{B}_{0}[7: 0]$ | $\mathrm{B}_{0}[15: 8]$ | $\mathrm{B}_{0}[7: 0]$ | $\mathrm{B}_{1}[15: 8]$ | $\mathrm{B}_{1}[7: 0]$ |

## 8．4．2．6 JESD204B Frame Assembly with Decimation（Dual－Band DDC）：Complex Output

表 8－21 lists the available JESD204B formats and valid ranges for the ADC32RF8x with decimation（dual－band DDC）when using a complex output format．The ranges are limited by the SerDes line rate and the maximum ADC sample frequency．The sample alignment on the different lanes is shown in 表 8－22．

表 8－21．JESD Mode Options：Dual－Band Complex Output

| DECIMATION SETTING（Complex） | NUMBER OF ACTIVE DDCS | L | M | F | S | $\begin{aligned} & \text { PLL } \\ & \text { MODE } \end{aligned}$ | JESD MODEO | $\begin{aligned} & \text { JESD } \\ & \text { MODE1 } \end{aligned}$ | $\begin{aligned} & \text { JESD } \\ & \text { MODE2 } \end{aligned}$ | RATIO <br> ［ $\mathrm{f}_{\text {SerDes }} / \mathrm{f}_{\mathrm{CLK}}$ （Gbps／GSPS）］ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Divide－by－8 | 2 per channel | 8 | 8 | 2 | 1 | 20x | 1 | 0 | 0 | 2.5 |
|  |  | 4 | 8 | 4 | 1 | 40x | 2 | 0 | 0 | 5 |
| Divide－by－9 | 2 per channel | 8 | 8 | 2 | 1 | 20x | 1 | 0 | 0 | 2.22 |
|  |  | 4 | 8 | 4 | 1 | 40x | 2 | 0 | 0 | 4.44 |
| Divide－by－10 | 2 per channel | 8 | 8 | 2 | 1 | 20x | 1 | 0 | 0 | 2 |
|  |  | 4 | 8 | 4 | 1 | 40x | 2 | 0 | 0 | 4 |
| Divide－by－12 | 2 per channel | 8 | 8 | 2 | 1 | 20x | 1 | 0 | 0 | 1.67 |
|  |  | 4 | 8 | 4 | 1 | 40x | 2 | 0 | 0 | 3.33 |
| Divide－by－16 | 2 per channel | 8 | 8 | 2 | 1 | 20x | 1 | 0 | 0 | 1.25 |
|  |  | 4 | 8 | 4 | 1 | 40x | 2 | 0 | 0 | 2.5 |
| Divide－by－18 | 2 per channel | 8 | 8 | 2 | 1 | 20x | 1 | 0 | 0 | 1.11 |
|  |  | 4 | 8 | 4 | 1 | 40x | 2 | 0 | 0 | 2.22 |
| Divide－by－20 | 2 per channel | 8 | 8 | 2 | 1 | 20x | 1 | 0 | 0 | 1 |
|  |  | 4 | 8 | 4 | 1 | 40x | 2 | 0 | 0 | 2 |
| Divide－by－24 | 2 per channel | 4 | 8 | 4 | 1 | 40x | 2 | 0 | 0 | 1.67 |
| Divide－by－32 | 2 per channel | 4 | 8 | 4 | 1 | 40x | 2 | 0 | 0 | 1.25 |

表 8－22．JESD Sample Lane Assignment：Dual－Band Complex Output ${ }^{(1)}$

| OUTPUT LANE | LMFS＝ 8821 |  | LMFS $=4841$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DAO | A10［15：8］ | A10［7：0］ |  |  |  |  |
| DA1 | A1Q ${ }_{0}[15: 8]$ | A1Q $\mathrm{A}_{0}[7: 0]$ | A110［15：8］ | A110［7：0］ | A1 $\mathrm{Q}_{0}[15: 8]$ | A1Q ${ }_{0}[7: 0]$ |
| DA2 | A210［15：8］ | A210［7：0］ | A210［15：8］ | A21 ${ }_{0}[7: 0]$ | $\mathrm{A} 2 \mathrm{Q}_{0}[15: 8]$ | A2Q ${ }_{0}[7: 0]$ |
| DA3 | A2Q ${ }_{0}[15: 8]$ | A2Q ${ }_{0}[7: 0]$ |  |  |  |  |
| DB0 | B110［15：8］ | B110［7：0］ |  |  |  |  |
| DB1 | $\mathrm{B1}_{0}[15: 8]$ | B1Q $\mathrm{Q}_{0}[7: 0]$ | B110［15：8］ | B110［7：0］ | $\mathrm{B1}_{0}[15: 8]$ | $B 1 Q_{0}[7: 0]$ |
| DB2 | B210［15：8］ | B210［7：0］ | B210［15：8］ | B21 ${ }_{0}$［7：0］ | $\mathrm{B} 2 \mathrm{Q}_{0}[15: 8]$ | $B 2 Q_{0}[7: 0]$ |
| DB3 | B2Q ${ }_{0}[15: 8]$ | B2Q ${ }_{0}[7: 0]$ |  |  |  |  |

（1）Blue and green shading indicates the two bands for channel $A$ ；yellow and orange shading indicates the two bands for channel $B$ ．

## 8．4．2．7 JESD204B Frame Assembly with Decimation（Dual－Band DDC）：Real Output

表 8－23 lists the available JESD204B formats and valid ranges for the ADC32RF8x with decimation（dual－band DDC）when using real output format．The ranges are limited by the SerDes line rate and the maximum ADC sample frequency．The sample alignment on the different lanes is shown in 表 8－24．

表 8－23．JESD Mode Options：Dual－Band Real Output

| decimation SETTING（Complex） | NUMBER OF ACTIVE DDCS | L | M | F | S | $\begin{aligned} & \text { PLL } \\ & \text { MODE } \end{aligned}$ | JESD MODEO | JESD <br> MODE1 | $\begin{aligned} & \text { JESD } \\ & \text { MODE2 } \end{aligned}$ | RATIO ［ $\mathrm{f}_{\text {SerDes }} / \mathrm{f}_{\mathrm{CLK}}$ （Gbps／GSPS）］ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Divide－by－8 （Divide－by－4 real） | 2 per channel | 8 | 4 | 1 | 1 | 20x | 1 | 1 | 0 | 2.5 |
|  |  | 8 | 4 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 4 | 4 | 2 | 1 | 40x | 0 | 0 | 1 | 5 |
|  |  | 4 | 4 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－9（Divide－by－4．5 real） | 2 per channel | 8 | 4 | 1 | 1 | 20x | 1 | 1 | 0 | 2.22 |
|  |  | 8 | 4 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 4 | 4 | 2 | 1 | 40x | 0 | 0 | 1 | 4.44 |
|  |  | 4 | 4 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－10（Divide－by－5 real） | 2 per channel | 8 | 4 | 1 | 1 | 20x | 1 | 1 | 0 | 2 |
|  |  | 8 | 4 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 4 | 4 | 2 | 1 | 40x | 0 | 0 | 1 | 4 |
|  |  | 4 | 4 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－12 （Divide－by－6 real） | 2 per channel | 8 | 4 | 1 | 1 | 20x | 1 | 1 | 0 | 1.67 |
|  |  | 8 | 4 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 4 | 4 | 2 | 1 | 40x | 0 | 0 | 1 | 3.33 |
|  |  | 4 | 4 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| $\begin{gathered} \text { Divide-by-16 } \\ \text { (Divide-by-8 real) } \end{gathered}$ | 2 per channel | 8 | 4 | 1 | 1 | 20x | 1 | 1 | 0 | 1.25 |
|  |  | 8 | 4 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 4 | 4 | 2 | 1 | 40x | 0 | 0 | 1 | 2.5 |
|  |  | 4 | 4 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－18 （Divide－by－9 real） | 2 per channel | 8 | 4 | 1 | 1 | 20x | 1 | 1 | 0 | 1.11 |
|  |  | 8 | 4 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 4 | 4 | 2 | 1 | 40x | 0 | 0 | 1 | 2.22 |
|  |  | 4 | 4 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| $\begin{gathered} \text { Divide-by-20 } \\ \text { (Divide-by-10 real) } \end{gathered}$ | 2 per channel | 8 | 4 | 1 | 1 | 20x | 1 | 1 | 0 | 1 |
|  |  | 8 | 4 | 2 | 2 | 20x | 1 | 0 | 0 |  |
|  |  | 4 | 4 | 2 | 1 | 40x | 0 | 0 | 1 | 2 |
|  |  | 4 | 4 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－24 （Divide－by－12 real） | 2 per channel | 4 | 4 | 2 | 1 | 40x | 0 | 0 | 1 | 1.67 |
|  |  | 4 | 4 | 4 | 2 | 40x | 2 | 0 | 0 |  |
| Divide－by－32 （Divide－by－16 real） | 2 per channel | 4 | 4 | 2 | 1 | 40x | 0 | 0 | 1 | 1.25 |
|  |  | 4 | 4 | 4 | 2 | 40x | 2 | 0 | 0 |  |

表 8－24．JESD Sample Lane Assignment：Dual－Band Complex Output

| OUTPUT LANE | LMFS＝ 8411 | LMFS＝ 8422 |  | LMFS $=4421$ |  | LMFS $=4442$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DA0 | $\mathrm{A} 1{ }_{0}[15: 8]$ | A10［15：8］ | $\mathrm{A} 10[7: 0]$ |  |  |  |  |  |  |
| DA1 | $\mathrm{A} 1_{0}[7: 0]$ | A11［15：8］ | A11 $[7: 0]$ | A10［15：8］ | $\mathrm{A} 1_{0}[7: 0]$ | A10［15：8］ | A1 ${ }_{0}$［7：0］ | A1 ${ }_{1}$［15：8］ | $\mathrm{A} 1_{1}[7: 0]$ |
| DA2 | $\mathrm{A} 2{ }_{0}[15: 8]$ | A2 ${ }_{0}[15: 8]$ | $\mathrm{A} 2[770]$ | A2 ${ }_{0}[15: 8]$ | $\mathrm{A} 2[0]: 0]$ | A20［15：8］ | A20［7：0］ | A2 ${ }_{1}[15: 8]$ | $\mathrm{A} 1_{1}[7: 0]$ |
| DA3 | A2 ${ }_{0}[7: 0]$ | A2 ${ }_{1}[15: 8]$ | A2 ${ }_{1}[7: 0]$ |  |  |  |  |  |  |
| DB0 | B1 ${ }_{0}$［15：8］ | B10［15：8］ | $\mathrm{B} 1_{0}[7: 0]$ |  |  |  |  |  |  |
| DB1 | B10［7：0］ | B11［15：8］ | B1 17 ： 0 ］ | B10［15：8］ | B10［7：0］ | B10［15：8］ | B1 ${ }_{0}$［7：0］ | B1 ${ }_{1}$［15：8］ | B1 1 ［7：0］ |
| DB2 | B2 ${ }_{0}$［15：8］ | B20［15：8］ | $B 2[7: 0]$ | B20［15：8］ | B20［7：0］ | B2 ${ }_{0}[15: 8]$ | B2 ${ }_{0}[7: 0]$ | B2 $1_{1}[15: 8]$ | B2 $1^{[7: 0]}$ |

表 8－24．JESD Sample Lane Assignment：Dual－Band Complex Output（continued）

| OUTPUT <br> LANE | LMFS＝8411 | LMFS＝8422 |  | LMFS＝4421 |  | LMFS＝4442 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DB3 | $B 22_{0}[7: 0]$ | $B 2{ }_{1}[15: 8]$ | $B 2{ }_{1}[7: 0]$ |  |  |  |  |

## 8．4．3 Serial Interface

The ADC has a set of internal registers that can be accessed by the serial interface formed by the SEN（serial interface enable），SCLK（serial interface clock），and SDIN（serial interface data）pins．Serially shifting bits into the device is enabled when SEN is low．SDIN serial data are latched at every SCLK rising edge when SEN is active（low），as shown in 图 8－56．The interface can function with SCLK frequencies from 20 MHz down to low speeds（of a few hertz）and also with a non－50\％SCLK duty cycle，as shown in 表 8－25．

The SPI access uses 24 bits consisting of eight register data bits， 12 register address bits，and four special bits to distinguish between read／write，page and register，and individual channel access，as described in 表 8－26．


图8－56．SPI Timing Diagram
表8－25．SPI Timing Information

|  |  | MIN | TYP |
| :--- | :--- | :---: | :---: |
| $f_{\text {SCLK }}$ | SCLK frequency（equal to 1／$\left.t_{\text {SCLK }}\right)$ | 1 | MAX |
| $t_{\text {SLOADS }}$ | SEN to SCLK setup time | 50 | 20 |
| $t_{\text {SLOADH }}$ | SCLK to SEN hold time | 50 | MHz |
| $t_{\text {DSU }}$ | SDIN setup time | 10 | ns |
| $t_{\text {DH }}$ | SDIN hold time | 10 | ns |
| $t_{\text {SDOUT }}$ | Delay between SCLK falling edge to SDOUT |  | ns |

表 8－26．SPI Input Description

| SPI BIT | DESCRIPTION | OPTIONS |
| :--- | :--- | :--- |
| R／W bit | Read／write bit | $0=$ SPI write <br> $1=$ SPI read back |
| M bit | SPI bank access | $0=$ Analog SPI bank（master） <br> $1=$ All digital SPI banks（main digital，interleaving， <br> decimation filter，JESD digital，and so forth $)$ |
| P bit | JESD page selection bit | $0=$ Page access <br> $1=$ Register access |
| CH bit | SPI access for a specific channel of the JESD SPI <br> bank | $0=$ Channel A <br> $1=$ Channel B |
| ADDR［11：0］ | SPI address bits | - |
| DATA［7：0］ | SPI data bits | - |

图 8－57 shows the SDOUT timing when data are read back from a register．Data are placed on the SDOUT bus at the SCLK falling edge so that the data can be latched at the SCLK rising edge by the external receiver．


图8－57．SDOUT Timing

## 8．4．3．1 Serial Register Write：Analog Bank

The internal register of the ADC32RF8x analog bank（图8－58）can be programmed by：
1．Driving the SEN pin low．
2．Initiating a serial interface cycle selecting the page address of the register whose content must be written．To select the master page：write address 0012h with 04h．To select the ADC page：write address 0011h with FFh．
3．Writing the register content．When a page is selected，multiple registers located in the same page can be programmed．


图 8－58．SPI Write Timing Diagram for the Analog Bank

## 8．4．3．2 Serial Register Readout：Analog Bank

Contents of the registers located in the two pages of the analog bank（图 8－59）can be readback by：
1．Driving the SEN pin low．
2．Selecting the page address of the register whose content must be read．Master page：write address 0012 h with 04h．ADC page：write address 0011h with FFh．
3．Setting the R／W bit to 1 and writing the address to be read back．
4．Reading back the register content on the SDOUT pin．When a page is selected，the contents of multiple registers located in same page can be readback．


图8－59．SPI Read Timing Diagram for the Analog Bank

### 8.4.3.3 Serial Register Write: Digital Bank

The digital bank contains seven pages (Offset Corrector Page for channel A and B; Digital Gain Page for channel A and B; Main digital Page for channel A and B; and JESD Digital Page). The timing for the individual page selection is shown in 图 8-60. The registers located in the pages of the digital bank can be programmed by:

1. Driving the SEN pin low.
2. Setting the $M$ bit to 1 and specifying the page with the desired register. There are seven pages in Digital Bank. These pages can be selected by appropriately programming register bits DIGITAL BANK PAGE SEL, located in addresses 002h, 003h, and 004h, using three consecutive SPI cycles. Addressing in a SPI cycle begins with $4 x x x$ when selecting a page from digital bank because the $M$ bit must be set to 1 .

- To select the offset corrector page channel A: write address 4004h with 61h, 4003h with 00h, and 4002h with 00h.
- To select the offset corrector page channel B: write address 4004h with $61 \mathrm{~h}, 4003 \mathrm{~h}$ with 01 h , and 4002 h with 00h.
- To select the digital gain page channel A: write address 4004 h with $61 \mathrm{~h}, 4003 \mathrm{~h}$ with 00 h , and 4002 h with 05h.
- To select the digital gain page channel B: write address 4004 h with $61 \mathrm{~h}, 4003 \mathrm{~h}$ with 01 h , and 4002 h with 05h.
- To select the main digital page channel A: write address 4004 h with $68 \mathrm{~h}, 4003 \mathrm{~h}$ with 00 h , and 4002 h with 00h.
- To select the main digital page channel B: write address 4004 h with $68 \mathrm{~h}, 4003 \mathrm{~h}$ with 01 h , and 4002 h with 00h.
- To select the JESD digital page: write address 4004 h with $69 \mathrm{~h}, 4003 \mathrm{~h}$ with 00 h , and 4002 h with 00 h .


RESET


图 8-60. SPI Write Timing Diagram for Digital Bank Page Selection
3. Writing into the desired register by setting both the $M$ bit and $P$ bit to 1 . Write register content. When a page is selected, multiple writes into the same page can be done. Addressing in an SPI cycle begins with $6 \times x x$ when selecting a page from the digital bank because the M bit must be set to 1 , as shown in 图 8-61.
Note that the JESD digital page is common for both channels. The CH bit can be used to distinguish between two channels when programming registers in the JESD digital page. When $\mathrm{CH}=0$, registers are programmed for channel B ; when $\mathrm{CH}=1$, registers are programmed for channel A . Thus, an SPI cycle to program registers for channel $B$ begins with $6 x x x$ and channel $A$ begins with $7 x x x$.


图 8-61. SPI Write Timing Diagram for Digital Bank Register Write

## 8．4．3．4 Serial Register Readout：Digital Bank

Readback of the register in one of the digital banks（as shown in 图 8－62）can be accomplished by：
1．Driving the SEN pin low．
2．Selecting the page in the digital page：follow step 2 in the 节 8．4．3．3 section．
3．Set the $R / W, M$ ，and $P$ bits to 1 ，select channel $A$ or channel $B$ ，and write the address to be read back．
－JESD digital page：use the $C H$ bit to select channel $B(C H=0)$ or channel $A(C H=1)$ ．
4．Read back the register content on the SDOUT pin．When a page is selected，multiple read backs from the same page can be done．


图 8－62．SPI Read Timing Diagram for the Digital Bank

## 8．4．3．5 Serial Register Write：Decimation Filter and Power Detector Pages

The decimation filter and power detector pages are special pages that accept direct addressing．The sampling clock and SYSREF signal are required to properly configure the decimation settings．Registers located in these pages can be programmed in one SPI cycle（图 8－63）．
1．Drive the SEN pin low．
2．Directly write to the decimation filter or power detector pages．To program registers in these pages，set $\mathrm{M}=1$ and $\mathrm{CH}=1$ ．Additionally，address bit $\mathrm{A}[10]$ selects the decimation filter page $(\mathrm{A}[10]=0)$ or the power detector page（ $A[10]=1$ ）．Address bit $A[11]$ selects channel $A(A[11]=0)$ or channel $B(A[11]=1)$ ．
－Decimation filter page：write address $50 \times x h$ for channel $A$ or $58 x x h$ for channel $B$ ．
－Power detector page：write address $54 \times x$ for channel $A$ or $5 C x x h$ for channel B．
Example：Writing address 5001 h with 02 h selects the decimation filter page for channel A and programs decimation factor of divide－by－8（complex output）．


图8－63．SPI Write Timing Diagram for the Decimation and Power Detector Pages

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## 8．5 Register Maps

The ADC32RF8x contains two main SPI banks．The analog SPI bank provides access to the ADC core and the digital SPI bank controls the digital blocks （including the serial JESD interface）．图 8－64 and 图 8－65 provide a conceptual view of the SPI registers inside the ADC32RF8x．The analog SPI bank contains the master and ADC pages．The digital SPI bank is divided into multiple pages（the main digital，digital gain，decimation filter，JESD digital，and power detector pages）．


A．In general，SPI writes are completed in two steps．The first step is to access the necessary page．The second step is to program the desired register in that page．When a page is accessed，the registers in that page can be programmed multiple times．
B．Registers in the decimation filter page and the power detector page can be directly programmed in one SPI cycle．
C．The CH bit is a don＇t care bit and is recommended to be kept at 0 ．
图 8－64．SPI Registers，Two－Step Addressing


SPI Cycle
 sen $\square$ $\qquad$

A. Registers in the decimation filter page and the power detector page can be directly programmed in one SPI cycle.
$B$. To program registers in the decimation filter page, set $M=1, C H=1, A[10]=0$, and $A[11]=0$ or 1 for channel $A$ or $B$. Addressing begins at $50 x x$ for channel $A$ and $58 x x$ for channel $B$.
C. To program registers in power detector page, set $M=1, C H=1, A[10]=1$, and $A[11]=0$ or 1 for channel $A$ or $B$. Addressing begins at $54 x x$ for channel $A$ and $5 C x x$ for channel $B$.

图 8-65. SPI Registers: Direct Addressing

## 表8-27. Register Map

表 8-27 lists the register map for the ADC32RF8x.

| REGISTER | REGISTER DATA |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A[11:0] (Hex) | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| GENERAL REGISTERS |  |  |  |  |  |  |  |  |
| 000 | RESET | 0 | 0 | 0 | 0 | 0 | 0 | RESET |
| 002 | DIGITAL BANK PAGE SEL[7:0] |  |  |  |  |  |  |  |
| 003 | DIGITAL BANK PAGE SEL[15:8] |  |  |  |  |  |  |  |
| 004 | DIGITAL BANK PAGE SEL[23:16] |  |  |  |  |  |  |  |
| 010 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 3 or 4 WIRE |
| 011 | ADC PAGE SEL |  |  |  |  |  |  |  |
| 012 | 0 | 0 | 0 | 0 | 0 | MASTER PAGE SEL | 0 | 0 |
| MASTER PAGE ( $\mathrm{M}=\mathbf{0}$ ) |  |  |  |  |  |  |  |  |
| 020 | 0 | 0 | 0 | PDN SYSREF | 0 | 0 | PDN CHB | GLOBAL PDN |
| 032 | 0 | 0 | INCR CM IMPEDANCE | 0 | 0 | 0 | 0 | 0 |
| 039 | 0 | ALWAYS WRITE 1 | 0 | ALWAYS WRITE 1 | 0 | 0 | PDN CHB EN | SYNC TERM DIS |
| 03C | 0 | SYSREF DEL EN | 0 | 0 | 0 | 0 | SYSREF | DEL[4:3] |
| 03D | 0 | 0 | 0 | 0 | 0 | JESD OUTPUT SWING |  |  |
| 05A | SYSREF DEL[2:0] |  |  | 0 | 0 | 0 | 0 | 0 |
| 057 | 0 | 0 | 0 | SEL SYSREF REG | ASSERT SYSREF REG | 0 | 0 | 0 |
| 058 | 0 | 0 | SYNCB POL | 0 | 0 | 0 | 0 | 0 |
| ADC PAGE (FFh, M = 0) |  |  |  |  |  |  |  |  |
| 03F | 0 | 0 | 0 | 0 | 0 | SLOW SP EN1 | 0 | 0 |
| 042 | 0 | 0 | 0 | SLOW SP EN2 | 0 | 0 | 1 | 1 |
| Offset Corr Page Channel A (610000h, M = 1) |  |  |  |  |  |  |  |  |
| 68 | FREEZE OFFSET CORR | ALWAYS WRITE 1 | 0 | 0 | 0 | $\begin{gathered} \text { DIS OFFSET } \\ \text { CORR } \end{gathered}$ | ALWAYS WRITE 1 | 0 |
| Offset Corr Page Channel B (610100h, M = 1) |  |  |  |  |  |  |  |  |
| 68 | FREEZE OFFSET CORR | ALWAYS WRITE 1 | 0 | 0 | 0 | DIS OFFSET CORR | ALWAYS WRITE 1 | 0 |
| Digital Gain Page Channel A (610005, M = 1) |  |  |  |  |  |  |  |  |
| 0A6 | 0 | 0 | 0 | 0 | DIGITAL GAIN |  |  |  |


| 表 8-27. Register Map (continued) |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| REGISTERADDRESSA[11:0] (Hex) | REGISTER DATA |  |  |  |  |  |  |  |
|  | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Digital Gain Page Channel B (610105, M = 1) |  |  |  |  |  |  |  |  |
| 0A6 | 0 | 0 | 0 | 0 | DIGITAL GAIN |  |  |  |
| Main Digital Page Channel A (680000h, M = 1) |  |  |  |  |  |  |  |  |
| 000 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | DIG CORE RESET GBL |
| 0A2 | 0 | 0 | 0 | 0 | NQ ZONE EN | NYQUIST ZONE |  |  |
| Main Digital Page Channel B (680001h, M = 1) |  |  |  |  |  |  |  |  |
| 000 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 0A2 | 0 | 0 | 0 | 0 | NQ ZONE EN | NYQUIST ZONE |  |  |
| JESD DIGITAL PAGE (690000h, M = 1) |  |  |  |  |  |  |  |  |
| 001 | CTRL K | 0 | 0 | TESTMODE EN | 0 | LANE ALIGN | FRAME ALIGN | TX LINK DIS |
| 002 | SYNC REG | SYNC REG EN | 0 | 0 | 12BIT MODE |  | JESD MODE0 |  |
| 003 | LINK LAYER TESTMODE |  |  | LINK LAY RPAT | LMFC MASK RESET | JESD MODE1 | JESD MODE2 | RAMP 12BIT |
| 004 | 0 | 0 | 0 | 0 | 0 | 0 | REL | A SEQ |
| 006 | SCRAMBLE EN | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| 007 | 0 | 0 | 0 |  |  | PER MULTIFR | (K) |  |
| 016 | 0 |  | 40X MODE |  | 0 | 0 | 0 | 0 |
| 017 | 0 | 0 | 0 | 0 | LANEO POL | LANE1 POL | LANE2 POL | LANE3 POL |
| 032 |  |  | SEL | ANE 0 |  |  | 0 | 0 |
| 033 |  |  | SEL | ANE 1 |  |  | 0 | 0 |
| 034 |  |  | SEL | LANE 2 |  |  | 0 | 0 |
| 035 |  |  | SEL | LANE 3 |  |  | 0 | 0 |
| 036 | 0 | CMOS SYNCB | 0 | 0 | 0 | 0 | 0 | 0 |
| 037 | 0 | 0 | 0 | 0 | 0 | 0 | PLL | ODE |
| 03C | 0 | 0 | 0 | 0 | 0 | 0 | 0 | EN CMOS SYNCB |
| 03E | 0 | MASK CLKDIV SYSREF | MASK NCO SYSREF | 0 | 0 | 0 | 0 | 0 |

## 表 8-27. Register Map (continued)

| REGISTER <br> ADDRESS <br> A[11:0] (Hex) |
| :--- |
|  |


| 000 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | DDC EN |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 001 | 0 | 0 | 0 | 0 | DECIM FACTOR |  |  |  |
| 002 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | DUAL BAND EN |
| 005 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | REAL OUT EN |
| 006 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | DDC MUX |
| 007 | DDC0 NCO1 LSB |  |  |  |  |  |  |  |
| 008 | DDC0 NCO1 MSB |  |  |  |  |  |  |  |
| 009 | DDC0 NCO2 LSB |  |  |  |  |  |  |  |
| 00A | DDCO NCO2 MSB |  |  |  |  |  |  |  |
| 00B | DDC0 NCO3 LSB |  |  |  |  |  |  |  |
| 00C | DDCO NCO3 MSB |  |  |  |  |  |  |  |
| 00D | DDC1 NCO4 LSB |  |  |  |  |  |  |  |
| 00E | DDC1 NCO4 MSB |  |  |  |  |  |  |  |
| 00F | 0 | 0 | 0 | 0 | 0 | 0 | 0 | NCO SEL PIN |
| 010 | 0 | 0 | 0 | 0 | 0 | 0 | NCO SEL |  |
| 011 | 0 | 0 | 0 | 0 | 0 | 0 | LMFC RESET MODE |  |
| 014 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | DDC0 6DB GAIN |
| 016 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | DDC1 6DB GAIN |
| 01E | 0 | DDC DET LAT |  |  | 0 | 0 | 0 | 0 |
| 01F | 0 | 0 | 0 | 0 | 0 | 0 | 0 | WBF 6DB GAIN |
| 033 | CUSTOM PATTERN1[7:0] |  |  |  |  |  |  |  |
| 034 | CUSTOM PATTERN1[15:8] |  |  |  |  |  |  |  |
| 035 | CUSTOM PATTERN2[7:0] |  |  |  |  |  |  |  |
| 036 | CUSTOM PATTERN2[15:8] |  |  |  |  |  |  |  |
| 037 | TEST PATTERN DDC1 Q-DATA |  |  |  | TEST PATTERN DDC1 I-DATA |  |  |  |
| 038 | TEST PATTERN DDC2 Q-DATA |  |  |  | TEST PATTERN DDC2 I-DATA |  |  |  |
| 039 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | USE COMMON TEST PATTERN |
| 03A | 0 | 0 | 0 | 0 | 0 | 0 | TEST PAT RES | TP RES EN |


| REGISTER ADDRESS A[11:0] (Hex) | REGISTER DATA |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| POWER DETECTOR PAGE (Direct Addressing, 16-Bit Address, 5400h for Channel A and 5C00h for Channel B) |  |  |  |  |  |  |  |  |
| 000 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | PKDET EN |
| 001 | BLKPKDET [7:0] |  |  |  |  |  |  |  |
| 002 | BLKPKDET [15:8] |  |  |  |  |  |  |  |
| 003 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | BLKPKDET [16] |
| 007 | BLKTHHH |  |  |  |  |  |  |  |
| 008 | BLKTHHL |  |  |  |  |  |  |  |
| 009 | BLKTHLH |  |  |  |  |  |  |  |
| 00A | BLKTHLL |  |  |  |  |  |  |  |
| 00B | DWELL[7:0] |  |  |  |  |  |  |  |
| 00C | DWELL[15:8] |  |  |  |  |  |  |  |
| 00D | 0 | 0 | 0 | 0 | 0 | 0 | 0 | FILTOLPSEL |
| 00E | 0 | 0 | 0 | 0 |  |  |  |  |
| 00F | FILOTHH[7:0] |  |  |  |  |  |  |  |
| 010 | FILOTHH[15:8] |  |  |  |  |  |  |  |
| 011 | FILOTHL[7:0] |  |  |  |  |  |  |  |
| 012 | FILOTHL[15:8] |  |  |  |  |  |  |  |
| 013 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | IIRO 2BIT EN |
| 016 | FIL1THH[7:0] |  |  |  |  |  |  |  |
| 017 | FIL1THH[15:8] |  |  |  |  |  |  |  |
| 018 | FIL1THL[7:0] |  |  |  |  |  |  |  |
| 019 | FIL1THL[15:8] |  |  |  |  |  |  |  |
| 01A | 0 | 0 | 0 | 0 | 0 | 0 | 0 | IIR1 2BIT EN |
| 01D | DWELLIIR[7:0] |  |  |  |  |  |  |  |
| 01E | DWELLIIR[15:8] |  |  |  |  |  |  |  |
| 020 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | IIRO 2BIT EN |
| 021 | 0 | 0 | 0 |  |  |  |  |  |
| 022 | PWRDETH[7:0] |  |  |  |  |  |  |  |
| 023 | PWRDETH[15:8] |  |  |  |  |  |  |  |
| 024 | PWRDETL[7:0] |  |  |  |  |  |  |  |
| 025 | PWRDETL[15:8] |  |  |  |  |  |  |  |


| REGISTER ADDRESS A[11:0] (Hex) | REGISTER DATA |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| POWER DETECTOR PAGE (continued) |  |  |  |  |  |  |  |  |
| 027 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | RMS 2BIT EN |
| 02B | 0 | 0 | 0 | RESET AGC | 0 | 0 | 0 | 0 |
| 032 | OUTSEL GPIO4 |  |  |  |  |  |  |  |
| 033 | OUTSEL GPIO1 |  |  |  |  |  |  |  |
| 034 | OUTSEL GPIO3 |  |  |  |  |  |  |  |
| 035 | OUTSEL GPIO2 |  |  |  |  |  |  |  |
| 037 | 0 | 0 | 0 | 0 | IODIR GPIO2 | IODIR GPIO3 | IODIR GPIO1 | IODIR GPIO4 |
| 038 | 0 | 0 | INSEL1 |  | 0 | 0 | INSELO |  |

ADC32RF80，ADC32RF83

## 8．5．1 Example Register Writes

This section provides three different example register writes．表 8－28 describes a global power－down register write，表 8－29 describes the register writes when the scrambler is enabled，and 表 $8-30$ describes the register writes for 8 x decimation for channels A and B （complex output， 1 DDC mode）with the NCO set to 1.8 GHz （ $\mathrm{f}_{\mathrm{S}}=$ 3 GSPS）and the JESD format configured to LMFS $=4421$.

表 8－28．Global Power－Down

| ADDRESS | DATA | COMMENT |
| :---: | :---: | :--- |
| 12 h | 04 h | Set the master page |
| 20 h | 01 h | Set the global power－down |

表 8－29．Scrambler Enable

| ADDRESS | DATA |  |
| :---: | :---: | :--- |
| 4004 h | 69 h | COMMENT |
| 4003 h | 00 h | Select the digital JESD page |
| 6006 h | 80 h | Scrambler enable，channel A |
| 7006 h | 80 h | Scrambler enable，channel B |

表 8－30．8x Decimation for Channel A and B

| ADDRESS | DATA | COMMENT |
| :---: | :---: | :---: |
| 4004h | 68h | Select the main digital page for channel A |
| 4003h | 00h |  |
| 6000h | 01h | Issue a digital reset for channel A |
| 6000h | 00h | Clear the digital for reset channel A |
| 4003h | 01h | Select the main digital page for channel B |
| 6000h | 01h | Issue a digital reset for channel B |
| 6000h | 00h | Clear the digital reset for channel B |
| 4004h | 69h | Select the digital JESD page |
| 4003h | 00h |  |
| 6002h | 01h | Set JESD MODE0＝1，channel A |
| 7002h | 01h | Set JESD MODE0 $=1$ ，channel B |
| 5000h | 01h | Enable the DDC，channel A |
| 5001h | 02h | Set decimation to 8x complex |
| 5007h | 9Ah | Set the LSB of DDC0，NCO1 to 9Ah（f $\mathrm{NCO}=1.8 \mathrm{GHz}, \mathrm{f}_{\mathrm{S}}=3 \mathrm{GSPS}$ ） |
| 5008h | 99h | Set the MSB of DDC0，NCO1 to 99h（f ${ }_{\text {NCO }}=1.8 \mathrm{GHz}, \mathrm{f}_{\mathrm{S}}=3 \mathrm{GSPS}$ ） |
| 5014h | 01h | Enable the 6－dB digital gain of DDC0 |
| 5801h | 02h | Set decimation to 8x complex |
| 5807h | 9Ah | Set the LSB of DDC0，NCO1 to 9Ah（ $\mathrm{f}_{\text {NCO }}=1.8 \mathrm{GHz}, \mathrm{f}_{\mathrm{S}}=3 \mathrm{GSPS}$ ） |
| 5808h | 99h | Set the MSB of DDCO，NCO1 to 99h（f $\mathrm{f}_{\mathrm{NCO}}=1.8 \mathrm{GHz}, \mathrm{f}_{\mathrm{S}}=3 \mathrm{GSPS}$ ） |
| 5814h | 01h | Enable the 6－dB digital gain of DDC0 |

## 8．5．2 Register Descriptions

## 8．5．2．1 General Registers

## 8．5．2．1．1 Register 000 h （address $=000 \mathrm{~h}$ ），General Registers

图8－36．Register 000h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RESET | 0 | 0 | 0 | 0 | 0 | 0 | RESET |
| R／W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－0h |

表 8－31．Register 000h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | RESET | R／W | Oh | $0=$ Normal operation <br> $1=$ Internal software reset，clears back to 0 |
| $6-1$ | 0 | W | $0 h$ | Must write 0 |
| 0 | RESET | R／W | Oh | $0=$ Normal operation $^{(1)}$ <br> $1=$ Internal software reset，clears back to 0 |

（1）Both bits $(7,0)$ must be set simultaneously to perform a reset．

## 8．5．2．1．2 Register 002h（address $=002 \mathrm{~h}$ ），General Registers

图8－37．Register 002h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

表 8－32．Register 002h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DIGITAL BANK PAGE SEL［7：0］ | R／W | Oh | Program the JESD BANK PAGE SEL［23：0］bits to access the <br> desired page in the JESD bank． <br> $680000 \mathrm{~h}=$ Main digital page CHA selected |
|  |  |  |  | $680100 \mathrm{~h}=$ Main digital page CHB selected <br> $610000 \mathrm{~h}=$ Digital function page CHA selected <br> $610100 \mathrm{~h}=$ Digital function page CHB selected |
|  |  |  |  | $690000 \mathrm{~h}=$ JESD digital page selected |

## 8．5．2．1．3 Register 003h（address $\boldsymbol{=}$ 003h），General Registers

图 8－38．Register 003h

| 7 | 6 | 5 | 4 | 3 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | DIGITAL BANK PAGE SEL［15：8］ | 0 |  |  |  |

表 8－33．Register 003h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DIGITAL BANK PAGE SEL［15：8］ | R／W | Oh | Program the JESD BANK PAGE SEL［23：0］bits to access the <br> desired page in the JESD bank． |
|  |  |  | $680000 \mathrm{~h}=$ Main digital page CHA selected <br>  |  |
|  |  |  | $680100 \mathrm{~h}=$ Main digital page CHB selected |  |
|  |  |  | $610000 \mathrm{~h}=$ Digital function page CHA selected |  |
|  |  |  | $690000 \mathrm{~h}=$ JESD digital page selected |  |

## 8．5．2．1．4 Register 004h（address＝004h），General Registers

图 8－39．Register 004h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIGITAL BANK PAGE SEL［23：16］ |  |  |  |  |  |  |  |
| R／W－Oh |  |  |  |  |  |  |  |

表 8－34．Register 004h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DIGITAL BANK PAGE SEL［23：16］ | R／W | Oh | Program the JESD BANK PAGE SEL［23：0］bits to access the <br> desired page in the JESD bank． |
|  |  |  | $680000 \mathrm{~h}=$ Main digital page CHA selected |  |
|  |  |  | $680100 \mathrm{~h}=$ Main digital page CHB selected <br>  |  |
|  |  | $610000 \mathrm{~h}=$ Digital function page CHA selected |  |  |
|  |  |  | $690000 \mathrm{~h}=$ JESD digital page selected |  |

8．5．2．1．5 Register 010h（address $=010 \mathrm{~h}$ ），General Registers
图 8－40．Register 010h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | Wh | WIRE |  |

表 8－35．Register 010h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | 0 h | Must write 0 |
| 0 | 3 or 4 WIRE | R／W | 0 h | $0=4$－wire SPI（default） <br> $1=3$－wire SPI where SDIN become input or output |

## 8．5．2．1．6 Register 011 （address＝011 h），General Registers

图 8－41．Register 011h

| 7 | 6 | 4 | 3 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | ADC PAGE SEL |  |  |  |

表 8－36．Register 011h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | ADC PAGE SEL | R／W | Oh | $00000000=$ Normal operation，ADC page is not selected <br> $11111111=$ ADC page is selected；MASTER PAGE SEL must be <br> set to 0 |

8．5．2．1．7 Register 012h（address $=012 \mathrm{~h}$ ），General Registers
图 8－42．Register 012h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | MASTER PAGE SEL | 0 | 0 |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh | W－Oh | W－Oh |

表 8－37．Register 012h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-3$ | 0 | W | Oh | Must write 0 |
| 2 | MASTER PAGE SEL | R／W | Oh | $0=$ Normal operation <br> $1=$ Selects the master page address；ADC PAGE must be set to <br> 0 |
| $1-0$ | 0 | W | Oh | Must write 0 |

## 8．5．3 Master Page（ $\mathrm{M}=0$ ）

## 8．5．3．1 Register 020h（address $=020 h$ ），Master Page

图 8－43．Register 020h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | PDN SYSREF | 0 | 0 | PDN CHB | GLOBAL PDN |
| W－Oh | W－Oh | W－Oh | R／W－Oh | W－Oh | R／W－Oh | R／W－Oh | R／W－Oh |

表 8－38．Register 020h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-5$ | 0 | W | Oh | Must write 0 |
| 4 | PDN SYSREF | R／W | Oh | This bit powers down the SYSREF input buffer． <br> $0=$ Normal operation <br> $1=$ SYSREF input capture buffer is powered down and further <br> SYSREF input pulses are ignored |
| $3-2$ | 0 | W | Oh | Must write 0 |

## 8．5．3．2 Register 032h（address＝032h），Master Page

图8－44．Register 032h

| 7 | 6 | 5 | 3 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | INCR CM IMPEDANCE | 0 | 0 | 0 | 0 | 0 |
| W－Oh | W－Oh | R／W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh |

表 8－39．Register 032h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7－6 | 0 | W | Oh | Must write 0 |
| 5 | INCR CM IMPEDANCE | R／W | Oh | Only use this bit when analog inputs are dc－coupled to the driver． <br> $0=$ VCM buffer directly drives the common point of biasing resistors． <br> $1=$ VCM buffer drives the common point of biasing resistors with $>5 \mathrm{k} \Omega$ |
| 4－0 | 0 | W | Oh | Must write 0 |

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## 8．5．3．3 Register 039h（address＝039h），Master Page

图8－45．Register 039h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | ALWAYS WRITE 1 | 0 | ALWAYS WRITE 1 | 0 | 0 | PDN CHB EN | SYNC TERM DIS |
| W－Oh | W－Oh | W－Oh | W－Oh | W－0h | R／W－Oh | R／W－Oh | R／W－Oh |

表 8－40．Register 039h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | 0 | W | Oh | Must write 0 |
| 6 | ALWAYS WRITE 1 | W | Oh | Always set this bit to 1 |
| 5 | 0 | W | Oh | Must write 0 |
| 4 | ALWAYS WRITE 1 | W | Oh | Always set this bit to 1 |
| $3-2$ | 0 | W | Oh | Must write 0 |
| 1 | PDN CHB EN | R／W | Oh | This bit enables the power－down control of channel B through <br> the SPI in register 20h． <br> $0=$ PDN control disabled <br> $1=$ PDN control enabled |
| 0 | SYNC TERM DIS | R／W | Oh | This bit disables the on－chip，100－$\Omega$ termination resistors on the <br> SYNCB input． <br> $0=$ On－chip，100－$\Omega$ termination enabled <br> $1=$ On－chip，100－$\Omega$ termination disabled |

## 8．5．3．4 Register 03Ch（address＝03Ch），Master Page

图8－46．Register 03Ch

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | SYSREF DEL EN | 0 | 0 | 0 | 0 | SYSREF DEL［4：3］ |
| W－Oh | R／W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－0h |

表 8－41．Register 03Ch Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | 0 | W | Oh | Must write 0 |
| 6 | SYSREF DEL EN | R／W | Oh | This bit allows an internal delay to be added to the SYSREF <br> input． <br> $0=$ SYSREF delay disabled <br> $1=$ SYSREF delay enabled through register settings［3Ch（bits <br> $1-0), 5$ Ah（bits 7－5）］ |
| $5-2$ | 0 | W | Oh | Must write 0 |
| $1-0$ | SYSREF DEL［4：3］ | R／W | Oh | When the SYSREF delay feature is enabled（3Ch，bit 6）the <br> delay can be adjusted in 25－ps steps；the first step is 175 ps． <br> The PVT variation of each 25－ps step is $\pm 10$ ps．The 175－ps step <br> is $\pm 50$ ps；see 表 8－43． |

## 8．5．3．5 Register 05Ah（address＝05Ah），Master Page

图8－47．Register 05Ah

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | SYSREF DEL［2：0］ |  | 0 | 0 | 0 | 0 |  |
| $W-0 h$ | R／W－Oh | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W$ |  |

表 8－42．Register 05Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | SYSREF DEL2 | W | Oh | When the SYSREF delay feature is enabled（3Ch，bit 6）the <br> delay can be adjusted in 25－ps steps；the first step is 175 ps． <br> The PVT variation of each 25－ps step is $\pm 10$ ps．The 175－ps step <br> is $\pm 50$ ps；see 表 8－43． |
| 6 | SYSREF DEL1 | R／W |  | W |

表 8－43．SYSREF DEL［2：0］Bit Settings

| STEP | SETTING | STEP（NOM） | TOTAL DELAY（NOM） |
| :---: | :---: | :---: | :---: |
| 1 | 01000 | 175 ps | 175 ps |
| 2 | 00111 | 25 ps | 200 ps |
| 3 | 00110 | 25 ps | 225 ps |
| 4 | 00101 | 25 ps | 250 ps |
| 5 | 00100 | 25 ps | 275 ps |
| 6 | 00011 | 25 ps | 300 ps |

8．5．3．6 Register 03Dh（address＝3Dh），Master Page
图8－48．Register 03Dh

| 7 | 6 | 5 | 4 | 3 | 2 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 1 |
| $W-0 h$ | $W-0 h$ | $W-0 h$ | JESD OUTPUT SWING |  |  |

表 8－44．Register 03Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7－3 | 0 | W | Oh | Must write 0 |
| 2－0 | JESD OUTPUT SWING | R／W | Oh | These bits select the output amplitude， $\mathrm{V}_{\mathrm{OD}}\left(\mathrm{m} \mathrm{V}_{\mathrm{PP}}\right)$ ，of the JESD transmitter for all lanes． $\begin{aligned} & 0=860 \mathrm{mV} V_{P P} \\ & 1=810 \mathrm{mV} \\ & 2=770 \mathrm{mV} \\ & 3=745 \mathrm{mV} \\ & 4=960 \mathrm{mV} \\ & 5=930 \mathrm{mV} \\ & 6=905 \mathrm{mV} \\ & 7=880 \mathrm{mV} \\ & 7 \end{aligned}$ |

## 8．5．3．7 Register 057h（address＝057h），Master Page

## 图 8－49．Register 057h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | SEL SYSREF REG | ASSERT SYSREF REG | 0 | 0 | 0 |
| $W$ W－Oh | W－Oh | W－Oh | R／W－Oh | R／W－Oh | W－0h | W－Oh |  |

表 8－45．Register 057h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7－5 | 0 | W | Oh | Must write 0 |
| 4 | SEL SYSREF REG | R／W | Oh | SYSREF can be asserted using this bit．Ensure that the SEL SYSREF REG register bit is set high before using this bit；see the 节8．3．3．1 section． <br> $0=$ SYSREF is logic low <br> 1 ＝SYSREF is logic high |
| 3 | ASSERT SYSREF REG | R／W | Oh | Set this bit to use the SPI register to assert SYSREF． <br> $0=$ SYSREF is asserted by device pins <br> 1 ＝SYSREF can be asserted by the ASSERT SYSREF REG <br> register bit <br> Other bits $=0$ |
| 2－0 | 0 | W | Oh | Must write 0 |

8．5．3．8 Register 058h（address＝058h），Master Page
图 8－50．Register 058h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | SYNCB POL | 0 | 0 | 0 | 0 | 0 |
| W－Oh | W－Oh | R／W－Oh | W－Oh | W－0h | W－Oh | W－Oh | W－Oh |

表 8－46．Register 058h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0 |
| 5 | SYNCB POL | R／W | Oh | This bit inverts the SYNCB polarity． <br> $0=$ Polarity is not inverted；this setting matches the timing <br> diagrams in this document and is the proper setting to use <br> $1=$ Polarity is inverted |
| $4-0$ | 0 | W | Oh | Must write 0 |

## 8．5．4 ADC Page（FFh，M＝0）

## 8．5．4．1 Register 03Fh（address＝03Fh），ADC Page

图 8－51．Register 03Fh

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | SLOW SP EN1 | 0 | 0 |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh | W－Oh | W－Oh |

表 8－47．Register 03Fh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-3$ | 0 | W | Oh | Must write 0 |
| 2 | SLOW SP EN1 | R／W | Oh | This bit must be enabled for clock rates below 2．5 GSPS． <br> $0=$ ADC sampling rates are faster than 2．5 GSPS <br> $1=$ ADC sampling rates are slower than 2．5 GSPS |
| $1-0$ | 0 | W | Oh | Must write 0 |

## 8．5．4．2 Register 042h（address＝042h），ADC Page

图8－52．Register 042h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | SLOW SP EN2 | 0 | 0 | 0 | 0 |
| W－Oh | W－Oh | W－Oh | R／W－Oh | W－Oh | W－Oh | W－Oh | W－Oh |

表 8－48．Register 042h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-5$ | 0 | W | Oh | Must write 0 |
| 4 | SLOW SP EN2 | R／W | Oh | This bit must be enabled for clock rates below 2．5 GSPS． <br> $0=$ ADC sampling rates are faster than 2．5 GSPS <br> $1=$ ADC sampling rates are slower than 2．5 GSPS |
| $3-0$ | 0 | W | Oh | Must write 0 |

## 8．5．5 Digital Function Page（ $610000 \mathrm{~h}, \mathrm{M}=1$ for Channel A and $610100 \mathrm{~h}, \mathrm{M}=1$ for Channel B ）

## 8．5．5．1 Register A6h（address＝OA6h），Digital Function Page

图8－53．Register 0A6h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 |  | DIG GAIN |  |
| W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |  |  |

表 8－49．Register 0A6h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | Oh | Must write 0 |
| $3-0$ | DIG GAIN | R／W | Oh | These bits set the digital gain of the ADC output data prior to <br> decimation up to 11 dB；see 表 8－50． |

表 8－50．DIG GAIN Bit Settings

| SETTING | DIGITAL GAIN |
| :---: | :---: |
| 0000 | 0 dB |
| 0001 | 1 dB |
| 0010 | 2 dB |
| $\cdots$ | $\cdots$ |
| 1010 | 10 dB |
| 1011 | 11 dB |

## 8．5．6 Offset Corr Page Channel A（610000h，M＝1）

## 8．5．6．1 Register 034h（address $=034 h$ ），Offset Corr Page Channel A

图 8－54．Register 034h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| $W-O h$ | $W-O h$ | $W-O h$ | $W-0 h$ | $W-0 h$ | W－Oh |  |

表 8－51．Register 034h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | SEL EXT EST | R／W | Oh | This bit selects the external estimate for the offset correction <br> block；see the 节 9.1 .5 section． |

## 8．5．6．2 Register 068h（address＝068h），Offset Corr Page Channel A

图8－55．Register 068h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FREEZE OFFSET CORR | ALWAYS WRITE 1 | 0 | 0 | 0 | DIS OFFSET CORR | ALWAYS WRITE 1 | 0 |
| R／W－Oh | R／W－0h | W－0h | W－0h | W－0h | R／W－0h | R／W－0h | R／W－Oh |

表 8－52．Register 068h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | FREEZE OFFSET CORR | R／W | Oh | Use this bit and bits 5 and 1 to freeze the offset estimation <br> process of the offset corrector；see the 节 9.1 .5 section． <br> 011＝Apply this setting after powering up the device <br> $111=$ Offset corrector is frozen，does not estimate offset <br> anymore，and applies the last computed value． <br> Others＝Do not use |
| 6 | ALWAYS WRITE 1 | R／W | Oh | Always write this bit as 1 for the offset correction block to work <br> properly． |
| 5 | 0 | W | Oh | Must write 0 |
| $4-3$ | 0 | W | Oh | Must write 0 <br> 2 |
| DIS OFFSET CORR | R／W | Oh | $0=$ Offset correction block works and removes $\mathrm{f}_{\mathrm{S}} / 8, \mathrm{f}_{\mathrm{S}} / 4,3 \mathrm{f}_{\mathrm{S}} /$ <br> 8, and $\mathrm{f}_{\mathrm{S}} / 2$ spurs <br> $1=$ Offset correction block is disabled |  |
| 1 | ALWAYS WRITE 1 | R／W | Oh | Always write this bit as 1 for the offset correction block to work <br> properly． |
| 0 | 0 | W | Oh | Must write 0 |

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## 8．5．7 Offset Corr Page Channel B（610000h，M＝1）

## 8．5．7．1 Register 068h（address $=068 \mathrm{~h}$ ），Offset Corr Page Channel B

图 8－56．Register 068h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| FREEZE OFFSET CORR | ALWAYS WRITE 1 | 0 | 0 | 0 | DIS OFFSET CORR | ALWAYS WRITE 1 | 0 |
| R／W－Oh | R／W－Oh | W－0h | W－0h | W－0h | R／W－0h | R／W－0h | R／W－0h |

表 8－53．Register 068h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | FREEZE OFFSET CORR | R／W | Oh | Use this bit and bits 5 and 1 to freeze the offset estimation <br> process of the offset corrector；see the 节 9.1 .5 section． <br> $011=$ Apply this setting after powering up the device <br> $111=$ Offset corrector is frozen，does not estimate offset <br> anymore，and applies the last computed value． <br> Others＝Do not use |
| 6 | ALWAYS WRITE 1 | R／W | Oh | Always write this bit as 1 for the offset correction block to work <br> properly． |
| 5 | 0 | W | Oh | Must write 0 |

## 8．5．8 Digital Gain Page（610005h，M＝ 1 for Channel A and 610105h，M＝1 for Channel B）

8．5．8．1 Register 0A6h（address＝OA6h），Digital Gain Page
图8－57．Register 0A6h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 |  | DIGITAL GAIN |  |
| W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |  |  |

表 8－54．Register 0A6h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | Oh | Must write 0 |

## 8．5．9 Main Digital Page Channel A（680000h，M＝1）

## 8．5．9．1 Register 000h（address $=000 h$ ），Main Digital Page Channel A

图8－58．Register 000h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | DIG CORE RESET GBL |
| $W-O h$ | $W-O h$ | $W-O h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $R / W-O h$ |

表8－55．Register 000h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | DIG CORE RESET GBL | R／W | Oh | Pulse this bit $(0 \rightarrow 1 \rightarrow 0)$ to reset the digital core（applies to both <br> channel A and B）． <br> All Nyquist zone settings take effect when this bit is pulsed． |

## 8．5．9．2 Register OA2h（address＝OA2h），Main Digital Page Channel A

图 8－59．Register 0A2h

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | NQ ZONE EN | NYQUIST ZONE |  |
| W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh | R／W－Oh |  |

表 8－56．Register 0A2h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | Oh | Must write 0 |

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## 8．5．10 Main Digital Page Channel B（680001h，M＝1）

## 8．5．10．1 Register 000h（address $=000 \mathrm{~h}$ ），Main Digital Page Channel B

## 图 8－60．Register 000h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | DIG CORE RESET GBL |
| $W-0 h$ | $W-O h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $R / W-0 h$ |

表 8－57．Register 000h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | DIG CORE RESET GBL | R／W | Oh | Pulse this bit $(0 \rightarrow 1 \rightarrow 0)$ to reset the digital core（applies to both <br> channel A and B）． <br> All Nyquist zone settings take effect when this bit is pulsed． |

## 8．5．10．2 Register 0A2h（address＝OA2h），Main Digital Page Channel B

图 8－61．Register 0A2h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | NQ ZONE EN | NYQUIST ZONE |  |  |
| W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh | R／W－Oh |  |  |

表 8－58．Register 0A2h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-4$ | 0 |  | W | Oh |
| 3 | NQ ZONE EN | Rust write 0 |  |  |
| $2-0$ | NYQUIST ZONE | Oh | This bit allows for specification of the operating Nyquist zone． <br> $0=$ Nyquist zone specification disabled <br> $1=$ Nyquist zone specification enabled |  |

### 8.5.11 JESD Digital Page ( $6900 \mathrm{~h}, \mathrm{M}=1$ )

### 8.5.11.1 Register 001h (address $=001$ h), JESD Digital Page

图 8-62. Register 001h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CTRL K | 0 | 0 | TESTMODE EN | 0 | LANE ALIGN | FRAME ALIGN | TX LINK DIS |
| R/W-Oh | W-Oh | W-Oh | R/W-Oh | W-Oh | R/W-Oh | R/W-Oh | R/W-Oh |

表8-59. Register 001h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | CTRL K | R/W | Oh | This bit is the enable bit for the number of frames per <br> multiframe. <br> $0=$ Default is five frames per multiframe <br> $1=$ Frames per multiframe can be set in register 06h |
| $6-5$ | 0 |  | R/W | Oh |
| 4 | TESTMODE EN | Must write 0 |  |  |

## 8．5．11．2 Register 002h（address＝002h ），JESD Digital Page

图 8－63．Register 002h

| 7 | 6 | 5 | 4 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| SYNC REG | SYNC REG EN | 0 | 0 | 12BIT MODE | JESD MODE0 |
| R／W－Oh | R／W－Oh | W－Oh | W－Oh | R／W－Oh | R／W－Oh |

表 8－60．Register 002h Field Descriptions
$\left.\left.\begin{array}{|c|l|l|l|l|}\hline \text { Bit } & \text { Field } & \text { Type } & \text { Reset } & \text { Description } \\ \hline 7 & \text { SYNC REG } & \text { R／W } & \text { Oh } & \begin{array}{l}\text { This bit provides SYNC control through the SPI．} \\ 0=\text { Normal operation } \\ 1=\text { ADC output data are replaced with K28．5 characters }\end{array} \\ \hline 6 & \text { SYNC REG EN } & \text { R／W } & \text { Oh } & \begin{array}{l}\text { This bit is the enable bit for SYNC control through the SPI．} \\ 0=\text { Normal operation } \\ 1=\text { SYNC control through the SPI is enabled（ignores the } \\ \text { SYNCB input pins）}\end{array} \\ \hline 5-4 & 0 & \text { W } & \text { Oh } & \begin{array}{l}\text { Must write 0 }\end{array} \\ \hline 3-2 & \text { 12BIT MODE } & \text { R／W } & \text { Oh } & \begin{array}{l}\text { This bit enables the 12－bit output mode for more efficient data } \\ \text { packing．} \\ 00=\text { Normal operation，14－bit output }\end{array} \\ 01,10=\text { Unused } \\ 11=\text { High－efficient data packing enabled }\end{array} \right\rvert\, \begin{array}{l}\text { These bits select the configuration register to configure the } \\ \text { correct LMFS frame assemblies for different decimation settings；} \\ \text { see the JESD frame assembly tables in the 节 8．4．2．2 section．} \\ 00=0 \\ 01=1 \\ 10=2 \\ 11=3\end{array}\right]$

## 8．5．11．3 Register 003h（address＝003h），JESD Digital Page

## 图 8－64．Register 003h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| LINK LAYER TESTMODE | LINKLAY RPAT | LMFC <br> MASKRESET | JESDMODE1 | JESDMODE2 | RAMP12BIT |  |  |
| R／W－0h |  | R／W－0h | R／W－Oh | R／W－1h | R／W－0h | R／W－0h |  |

表 8－61．Register 003h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7－5 | LINK LAYER TESTMODE | R／W | Oh | These bits generate a pattern according to section 5．3．3．8．2 of the JESD204B document． <br> $000=$ Normal ADC data $001=$ D21．5（high－frequency jitter pattern） $010=$ K28．5（mixed－ frequency jitter pattern） 011＝Repeat initial lane alignment（generates a K28．5 character and repeats lane alignment sequences continuously） $100=12$－octet RPAT jitter pattern |
| 4 | LINKLAY RPAT | R／W | Oh | This bit changes the running disparity in a modified RPAT pattern test mode（only when link layer test mode $=100$ ）． $0=$ Normal operation $1=$ Changes disparity |
| 3 | LMFCMASK RESET | R／W | Oh | $0=$ Normal operation |
| 2 | JESDMODE1 | R／W | 1h | These bits select the configuration register to configure the correct LMFS frame assemblies for different decimation settings； see the JESD frame assembly tables in the 节8．4．2．2 section |
| 1 | JESDMODE2 | R／W | Oh | These bits select the configuration register to configure the correct LMFS frame assemblies for different decimation settings； see the JESD frame assembly tables in the 节 8．4．2．2 section |
| 0 | RAMP12BIT | R／W | Oh | 12－bit RAMP test pattern． $0=$ Normal data output 1 ＝Digital output is the RAMP pattern |

8．5．11．4 Register 004h（address＝004h），JESD Digital Page
图 8－65．Register 004h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | REL ILA SEQ |
| $W-O h$ | $W-O h$ | $W-O h$ | $W-0 h$ | $W-O h$ | $W$ W－Oh | R／W－Oh |

表 8－62．Register 004h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0 |
| $1-0$ | REL ILA SEQ | R／W | Oh | These bits delay the generation of the lane alignment sequence <br> by 0，1，2，or 3 multiframes after the code group synchronization． <br> $00=0$ multiframe delays <br> $01=1$ multifame delay <br> $10=2$ multiframe delays <br> $11=3$ multiframe delays |

## 8．5．11．5 Register 006h（address＝006h），JESD Digital Page

## 图 8－66．Register 006h

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SCRAMBLE EN | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| R／W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh |

表 8－63．Register 006h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | SCRAMBLE EN | R／W | Oh | This bit is the scramble enable bit in the JESD204B interface． <br> $0=$ Scrambling disabled <br> $1=$ Scrambling enabled |
| $6-0$ | 0 | W | Oh | Must write 0 |

8．5．11．6 Register 007h（address $=007 h$ ），JESD Digital Page
图 8－67．Register 007h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | FRAMES PER MULTIFRAME（K） |  |  |  |
| W－Oh | W－Oh | W－Oh | R／W－Oh |  |  |  |

表 8－64．Register 007h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-5$ | 0 | W | 0 h | Must write 0 |
| $4-0$ | FRAMES PER MULTIFRAME（K） | R／W | Oh | These bits set the number of multiframes． <br> Actual K is the value in hex +1 （that is， 0 Fh is $\mathrm{K}=16$ ）． |

## 8．5．11．7 Register 016h（address $=016 \mathrm{~h}$ ），JESD Digital Page

图 8－68．Register 016h

| 7 | 6 | 5 | 4 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | $40 \times M O D E$ | 0 | 0 | 0 | 0 |
| $W-0 h$ | $R / W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ |

表 8－65．Register 016h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | 0 | W | Oh | Must write 0 |
| $6-4$ | $40 X$ MODE | R／W | Oh | This register must be set for 40x mode operation． <br> 000＝Register is set for 20x and 80x mode <br> $111=$ Register must be set for 40x mode |
| $3-0$ | 0 | W | Oh | Must write 0 |

## 8．5．11．8 Register 017h（address＝017h），JESD Digital Page

图 8－69．Register 017h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | Lane0 POL | Lane1 POL | Lane2 POL | Lane3 POL |
| W－Oh | R／W－Oh | R／W－Oh | R／W－Oh | W－Oh | W－Oh | W－Oh | W－Oh |

表 8－66．Register 017h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | 0 | W | Oh | Must write 0 |
| $6-4$ | 0 | R／W | Oh | Must write 0 |
| $3-0$ | Lane［3：0］POL | W | Oh | These bits set the polarity of the individual JESD output lanes． <br> $0=$ Polarity as given in the pinout（noninverted） <br> $1=$ Inverts polarity（positive，P，or negative，M） |

## 8．5．11．9 Register 032h－035h（address＝032h－035h），JESD Digital Page

图 8－70．Register 032h

| 7 | 6 | 5 | 4 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | SEL EMP LANE 0 | 0 | 0 |  |  |
|  | R／W－Oh | W－Oh |  |  |  |

图 8－71．Register 033h

| 7 | 6 | 5 | 4 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | SEL EMP LANE 1 | 0 | 0 | 0 |  |
|  | R／W－Oh |  |  |  |  |

图 8－72．Register 034h

| 7 | 6 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | SEL EMP LANE 2 | 0 | 0 |  |  |
|  | R／W－Oh | W－Oh | W－Oh |  |  |

图 8－73．Register 035h

| 7 | 6 | 5 | 4 | 2 | 1 |
| :---: | :---: | ---: | :---: | :---: | :---: |
|  | SEL EMP LANE 3 | 0 | 0 |  |  |
|  | R／W－Oh | W－Oh | W－0h |  |  |

表 8－67．Register 032h－035h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7－2 | SEL EMP LANE | R／W | Oh | These bits select the amount of de－emphasis for the JESD output transmitter．The de－emphasis value in dB is measured as the ratio between the peak value after the signal transition to the settled value of the voltage in one bit period． $\begin{aligned} & 0=0 \mathrm{~dB} \\ & 1=-1 \mathrm{~dB} \\ & 3=-2 \mathrm{~dB} \\ & 7=-4.1 \mathrm{~dB} \\ & 15=-6.2 \mathrm{~dB} \\ & 31=-8.2 \mathrm{~dB} \\ & 63=-11.5 \mathrm{~dB} \end{aligned}$ |
| 1－0 | 0 | W | Oh | Must write 0 |

## 8．5．11．10 Register 036h（address $=036 \mathrm{~h}$ ），JESD Digital Page

图 8－74．Register 036h

| 7 | 6 | 5 | 4 | 3 | 2 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | CMOS SYNCB | 0 | 0 | 0 | 0 | 0 | 0 |
| $W-O h$ | R／W－0h | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ |  |

表 8－68．Register 036h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | 0 | W | Oh | Must write 0 |
| 6 | CMOS SYNCB | R／W | Oh | This bit enables single－ended control of SYNCB using the <br> GPIO4 pin（pin 63）．The differential SYNCB input is ignored．Set <br> the EN CMOS SYNCB bit and keep the CH bit high to make this <br> bit effective． <br> $0=$ Differential SYNCB input <br> $1=$ Single－ended SYNCB input using pin 63 |
| $5-0$ | 0 | W |  | Oh |

8．5．11．11 Register 037h（address＝037h），JESD Digital Page
图8－75．Register 037h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | PLL MODE |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |

表 8－69．Register 037h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0 |

## 8．5．11．12 Register 03Ch（address＝03Ch），JESD Digital Page

图8－76．Register 03Ch

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | EN CMOS SYNCB |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－0h |

表 8－70．Register 03Ch Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | EN CMOS SYNCB | R／W | Oh | Set this bit and the CMOS SYNCB bit high to provide a single－ <br> ended SYNC input to the device instead of differential．Also， <br> keep the CH bit high．Thus： <br> $1 . \quad$ Select the JESD digital page． <br> $2 . \quad$ Write address 7036h with value 40h． <br> $3 . \quad$ Write address 703Ch with value 01h． |

## 8．5．11．13 Register 03Eh（address＝03Eh），JESD Digital Page

图8－77．Register 03Eh

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | MASK CLKDIV SYSREF | MASK NCO SYSREF | 0 | 0 | 0 | 0 | 0 |
| W－Oh | R／W－Oh | R／W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh |

表 8－71．Register 03Eh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | 0 | W | Oh | Must write 0 |
| 6 | MASK CLKDIV SYSREF | R／W | Oh | Use this bit to mask the SYSREF going to the input clock <br> divider． <br> $0=$ Input clock divider is reset when SYSREF is asserted（that <br> is，when SYSREF transitions from low to high） <br> $1=$ Input clock divider ignores SYSREF assertions |
| 5 | MASK NCO SYSREF | R／W | Oh | Use this bit to mask the SYSREF going to the NCO in the DDC <br> block and LMFC counter of the JESD interface． <br> $0=$ NCO phase and LMFC counter are reset when SYSREF is <br> asserted（that is，when SYSREF transitions from low to high） <br> $1=$ NCO and LMFC counter ignore SYSREF assertions |
| $4-0$ | 0 | W | Oh | Must write 0 |

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## 8．5．12 Decimation Filter Page

Direct Addressing，16－Bit Address，5000h for Channel A，5800h for Channel B

## 8．5．12．1 Register 000h（address＝000h），Decimation Filter Page

图 8－78．Register 000h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | DDC EN |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |

表 8－72．Register 000h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | DDC EN | R／W | Oh | This bit enables the decimation filter and disables the bypass <br> mode． <br> $0=$ Do not use <br> $1=$ Decimation filter enabled |

## 8．5．12．2 Register 001h（address $=001 \mathrm{~h}$ ），Decimation Filter Page

图 8－79．Register 001h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | DECIM FACTOR |  |  |
| W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |  |  |

表 8－73．Register 001h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7－4 | 0 | W | Oh | Must write 0 |
| 3－0 | DECIM FACTOR | R／W | Oh | These bits configure the decimation filter setting． $0000=$ Divide－by－4 complex <br> 0001 ＝Divide－by－6 complex <br> $0010=$ Divide－by－8 complex <br> 0011 ＝Divide－by－9 complex <br> $0100=$ Divide－by－10 complex <br> 0101 ＝Divide－by－12 complex <br> $0110=$ Not used <br> 0111 ＝Divide－by－16 complex <br> $1000=$ Divide－by－18 complex <br> 1001 ＝Divide－by－20 complex <br> $1010=$ Divide－by－24 complex <br> 1011 ＝Not used <br> $1100=$ Divide－by－32 complex |

## 8．5．12．3 Register 002h（address $=2 h$ ），Decimation Filter Page

图 8－80．Register 002h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | DUAL BAND EN |
| $W-O h$ | $W-O h$ | $W-O h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | W－Oh | R／W－Oh |

表 8－74．Register 002h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | DUAL BAND EN | R／W | Oh | This bit enables the dual－band DDC filter for the corresponding <br> channel． <br> $0=$ Single－band DDC；available in both ADC32RF80 and <br> ADC32RF83 <br> $1=$ Dual－band DDC；available in ADC32RF80 only |

## 8．5．12．4 Register 005h（address＝005h），Decimation Filter Page

图 8－81．Register 005h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | REAL OUT EN |
| W－Oh | $W$ W－Oh | $W-O h$ | $W-0 h$ | $W-O h$ | $W-O h$ | $W-O h$ | R／W－Oh |

表 8－75．Register 005h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | REAL OUT EN | R／W | Oh | This bit converts the complex output to real output at $2 x$ the <br> output rate． <br> $0=$ Complex output format <br> $1=$ Real output format |

## 8．5．12．5 Register 006h（address $=006 h$ ），Decimation Filter Page

图 8－82．Register 006h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | DDC MUX |
| $W-O h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ |  |  |  |

表 8－76．Register 006h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | DDC MUX | R／W | Oh | This bit connects the DDC to the alternate channel ADC to <br> enable up to four DDCs with one ADC and completely turn off <br> the other ADC channel． <br> $0=$ Normal operation <br> $1=$ DDC block takes input from the alternate ADC |

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## 8．5．12．6 Register 007h（address＝007h），Decimation Filter Page

图 8－83．Register 007h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

表 8－77．Register 007h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DDC0 NCO1 LSB | R／W | Oh | These bits are the LSB of the NCO frequency word for NCO1 of <br> DDC0（band 1）． <br> The LSB represents $\mathrm{f}_{\mathrm{S}} /\left(2^{16}\right)$, where $\mathrm{f}_{\mathrm{S}}$ is the ADC sampling <br> frequency． |

## 8．5．12．7 Register 008h（address $=008 h$ ），Decimation Filter Page

图 8－84．Register 008h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

表 8－78．Register 008h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DDC0 NCO1 MSB | R／W | Oh | These bits are the MSB of the NCO frequency word for NCO1 of <br> DDC0（band 1）． <br> The LSB represents $f_{S} /\left(2^{16}\right)$, where $f_{S}$ is the ADC sampling <br> frequency． |

## 8．5．12．8 Register 009h（address $=009 h$ ），Decimation Filter Page

图 8－85．Register 009h
$\left.\begin{array}{|lllllll|}\hline 7 & 6 & 5 & 4 & 3 & 2 & 1\end{array}\right]$

表 8－79．Register 009h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DDC0 NCO2 MSB | R／W | Oh | These bits are the LSB of the NCO frequency word for NCO2 of <br> DDC0（band 1）． <br> The LSB represents $f_{S} /\left(2^{16}\right)$, where $f_{S}$ is the ADC sampling <br> frequency． |

## 8．5．12．9 Register 00Ah（address＝00Ah），Decimation Filter Page

图8－86．Register 00Ah

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

表 8－80．Register 00Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DDC0 NCO2 MSB | R／W | Oh | These bits are the MSB of the NCO frequency word for NCO2 of <br> DDC0（band 1）． <br> The LSB represents $\mathrm{f}_{S} /\left(2^{16}\right)$, where $\mathrm{f}_{\mathrm{S}}$ is the ADC sampling <br> frequency． |

## 8．5．12．10 Register 00Bh（address $=00 B h$ ），Decimation Filter Page

图8－87．Register 00Bh

| 7 | 6 | 5 | 4 | 3 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | DDC0 NCO3 LSB |  |  |  |  |

表 8－81．Register 00Bh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DDC0 NCO3 LSB | R／W | Oh | These bits are the LSB of the NCO frequency word for NCO3 of <br> DDC0（band 1）． <br> The LSB represents $\mathrm{f}_{S} /\left(2^{16}\right)$, where $\mathrm{f}_{\mathrm{S}}$ is the ADC sampling <br> frequency． |

## 8．5．12．11 Register 00Ch（address $=00 \mathrm{Ch}$ ），Decimation Filter Page

图8－88．Register 00Ch
$\left.\begin{array}{|lllllll|}\hline 7 & 6 & 5 & 4 & 3 & 2 & 1\end{array}\right]$

表 8－82．Register 00Ch Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DDC0 NCO3 MSB | R／W | Oh | These bits are the MSB of the NCO frequency word for NCO3 of <br> DDC0（band 1）． <br> The LSB represents $f_{S} /\left(2^{16}\right)$, where $f_{S}$ is the ADC sampling <br> frequency． |

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## 8．5．12．12 Register 00Dh（address＝00Dh），Decimation Filter Page

图8－89．Register 00Dh

| 7 | 6 | 5 | 4 | 3 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | DDC1 NCO4 LSB |  |  |  |  |

表 8－83．Register 00Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DDC1 NCO4 LSB | R／W | Oh | These bits are the LSB of the NCO frequency word for NCO4 of <br> DDC1（band 2，only when dual－band mode is enabled）． <br> The LSB represents $\mathrm{f}_{\mathrm{S}} /\left(2^{16}\right)$, where $\mathrm{f}_{\mathrm{S}}$ is the ADC sampling <br> frequency． |

## 8．5．12．13 Register 00Eh（address $=00 E h$ ），Decimation Filter Page

图8－90．Register 00Eh

| 7 | 6 | 5 | 4 | 3 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | DDC1 NCO4 MSB |  |  |  |  |
|  |  |  |  |  | R／W－0h |

表 8－84．Register 00Eh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DDC1 NCO4 MSB | R／W | Oh | These bits are the MSB of the NCO frequency word for NCO4 of <br> DDC1（band 2，only when dual－band mode is enabled）． <br> The LSB represents $\mathrm{f}_{\mathrm{S}} /\left(2^{16}\right)$, where $\mathrm{f}_{\mathrm{S}}$ is the ADC sampling <br> frequency． |

## 8．5．12．14 Register 00Fh（address $=00 F h$ ），Decimation Filter Page

图 8－91．Register 00Fh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | NCO SEL PIN |
| $W-O h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ |  |  |  |

表 8－85．Register 00Fh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | NCO SEL PIN | R／W | Oh | This bit enables NCO selection through the GPIO pins． <br> $0=$ NCO selection through SPI（see address Oh10） <br> $1=$ NCO selection through GPIO pins |

## 8．5．12．15 Register 010h（address $=010 h$ ），Decimation Filter Page

图8－92．Register 010h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | NCO SEL |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |

表 8－86．Register 010h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0 |
| $1-0$ | NCO SEL | R／W | Oh | These bits enable NCO selection through register setting． <br> $00=$ NCO1 selected for DDC 1 <br> $01=$ NCO2 selected for DDC 1 <br> $10=$ NCO3 selected for DDC 1 |

## 8．5．12．16 Register 011h（address＝011h），Decimation Filter Page

图 8－93．Register 011h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | LMFC RESET MODE |
| W－Oh | W－Oh | $W-0 h$ | $W-O h$ | $W-0 h$ | $W-0 h$ | R／W－Oh |

表 8－87．Register 011h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0 |

## 8．5．12．17 Register 014h（address＝014h），Decimation Filter Page

## 图8－94．Register 014h

| 7 | 6 | 5 | 4 | 3 | 2 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | DDC0 6DB GAIN |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |

表 8－88．Register 014h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | DDC0 6DB GAIN | R／W | Oh | This bit scales the output of DDC0 by $2(6 \mathrm{~dB})$ to compensate <br> for real－to－complex conversion and image suppression．This <br> scaling does not apply to the high－bandwidth filter path（divide－ <br> by－4 and－6）；see register 1Fh． <br> $0=$ Normal operation <br> $1=6-\mathrm{dB}$ digital gain is added |

## 8．5．12．18 Register 016h（address＝016h），Decimation Filter Page

## 图 8－95．Register 016h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | DDC1 6DB GAIN |
| W－Oh | W－Oh | W－Oh | W－0h | W－0h | W－0h | W－0h | R／W－0h |

表 8－89．Register 016h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | DDC1 6DB GAIN | R／W | Oh | This bit scales the output of DDC1 by $2(6 \mathrm{~dB})$ to compensate <br> for real－to－complex conversion and image suppression．This <br> scaling does not apply to the high－bandwidth filter path（divide－ <br> by－4 and－6）；see register 1Fh． <br> $0=$ Normal operation <br> $1=6-\mathrm{dB}$ digital gain is added |

8．5．12．19 Register 01Eh（address＝01Eh），Decimation Filter Page
图8－96．Register 01Eh

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | DDC DET LAT | 0 | 0 | 0 | 0 |  |
| $W-0 h$ | R／W－5h | $W-1 \mathrm{~h}$ | $\mathrm{~W}-1 \mathrm{~h}$ | $\mathrm{~W}-1 \mathrm{~h}$ | $\mathrm{~W}-1 \mathrm{~h}$ |  |

表 8－90．Register 01Eh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| 7 | 0 | W | 0h | Must write 0 |
| $6-4$ | DDC DET LAT | R／W | 5 h | These bits ensure deterministic latency depending on the decimation setting <br> used；see 表 $8-91$. |
| $3-0$ | 0 | W | 1 h | Must write 0 |

表 8－91．DDC DET LAT Bit Settings

| SETTING | COMPLEX DECIMATION SETTING |
| :---: | :--- |
| 10 h | Divide－by－24，-32 complex |
| 20 h | Divide－by－16，$-18,-20$ complex |
| 40 h | Divide－by－by $6,-12$ complex |
| 50 h | Divide－by－4，$-8,-9,-10$ complex |

## 8．5．12．20 Register 01Fh（address＝01Fh），Decimation Filter Page

## 图8－97．Register 01Fh

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | WBF 6DB GAIN |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－0h | W－Oh | R／W－0h |

表 8－92．Register 01Fh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | WBF 6DB GAIN | R／W | Oh | This bit scales the output of the wide bandwidth DDC filter by 2 <br> $(6 \mathrm{~dB})$ to compensate for real－to－complex conversion and image <br> suppression．This setting only applies to the high－bandwidth <br> filter path（divide－by－4 and－6）． <br> $0=$ Normal operation <br> $1=6-\mathrm{dB}$ digital gain is added |

8．5．12．21 Register 033h－036h（address＝033h－036h），Decimation Filter Page
图 8－98．Register 033h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

图 8－99．Register 034h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

图 8－100．Register 035h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

图 8－101．Register 036h
$\left.\begin{array}{|ccccccc|}\hline 7 & 6 & 5 & 4 & 3 & 2 & 1\end{array}\right]$

表 8－93．Register 033h－036h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | CUSTOM PATTERN | R／W | Oh | These bits set the custom test pattern in address 33h，34h，35h， <br> or 36h． |

### 8.5.12.22 Register 037h (address $=037 h$ ), Decimation Filter Page

图 8-102. Register 037h

| 7 | 6 | 5 | 4 | 3 | 2 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | TEST PATTERN DDC1 Q-DATA |  |  | 1 |  |
| $W-0 h$ | $W-0 h$ | $W-0 h$ | $W$ | TEST PATTERN DDC1 I-DATA |  |

表 8-94. Register 037h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7-4 | TEST PATTERN DDC1 Q-DATA | W | Oh | These bits select the test patten for the Q stream of the DDC1. $0000=$ Normal operation using ADC output data <br> 0001 = Outputs all 0s <br> $0010=$ Outputs all 1 s <br> 0011 = Outputs toggle pattern: output data are an alternating sequence of 10101010101010 and 01010101010101 <br> 0100 = Output digital ramp: output data increment by one LSB every clock cycle from code 0 to 65535 <br> $0110=$ Single pattern: output data are a custom pattern 1 (75h and 76h) <br> 0111 Double pattern: output data alternate between custom pattern 1 and custom pattern 2 <br> 1000 = Deskew pattern: output data are AAAAh <br> 1001 = SYNC pattern: output data are FFFFh |
| 3-0 | TEST PATTERN DDC1 I-DATA | R/W | Oh | These bits select the test patten for the I stream of the DDC1. <br> $0000=$ Normal operation using ADC output data <br> 0001 = Outputs all 0s <br> $0010=$ Outputs all 1 s <br> 0011 = Outputs toggle pattern: output data are an alternating sequence of 10101010101010 and 01010101010101 <br> $0100=$ Output digital ramp: output data increment by one LSB every clock cycle from code 0 to 65535 <br> 0110 = Single pattern: output data are a custom pattern 1 ( 75 h and 76h) <br> 0111 Double pattern: output data alternate between custom pattern 1 and custom pattern 2 <br> 1000 = Deskew pattern: output data are AAAAh <br> 1001 = SYNC pattern: output data are FFFFh |

### 8.5.12.22.1 Register 038h (address = 038h), Decimation Filter Page

图8-103. Register 038h

| 7 | 6 | 5 | 4 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| TEST PATTERN DDC2 Q-DATA |  | TEST PATTERN DDC2 I-DATA |  |  |  |
| R/W-Oh |  |  |  |  |  |

表 8-95. Register 038h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7-4 | TEST PATTERN DDC2 Q-DATA | W | Oh | These bits select the test patten for the Q stream of the DDC2. <br> $0000=$ Normal operation using ADC output data <br> 0001 = Outputs all 0s <br> $0010=$ Outputs all 1 s <br> $0011=$ Outputs toggle pattern: output data are an alternating sequence of 10101010101010 and 01010101010101 <br> $0100=$ Output digital ramp: output data increment by one LSB every clock cycle from code 0 to 65535 <br> $0110=$ Single pattern: output data are a custom pattern 1 ( 75 h and 76h) <br> 0111 Double pattern: output data alternate between custom pattern 1 and custom pattern 2 <br> 1000 = Deskew pattern: output data are AAAAh <br> 1001 = SYNC pattern: output data are FFFFh |
| 3-0 | TEST PATTERN DDC2 I -DATA | R/W | Oh | These bits select the test patten for the I stream of the DDC2. $0000=$ Normal operation using ADC output data <br> $0001=$ Outputs all 0s <br> $0010=$ Outputs all 1 s <br> 0011 = Outputs toggle pattern: output data are an alternating sequence of 10101010101010 and 01010101010101 <br> $0100=$ Output digital ramp: output data increment by one LSB every clock cycle from code 0 to 65535 <br> $0110=$ Single pattern: output data are a custom pattern 1 ( 75 h and 76h) <br> 0111 Double pattern: output data alternate between custom pattern 1 and custom pattern 2 <br> $1000=$ Deskew pattern: output data are AAAAh <br> 1001 = SYNC pattern: output data are FFFFh |

## 8．5．12．22．2 Register 039h（address $=039 \mathrm{~h}$ ），Decimation Filter Page

图8－104．Register 039h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | USE COMMON TEST PATTERN |
| $W-0 h$ | $W-O h$ | $W-0 h$ | $W-O h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $R / W-O h$ |

表 8－96．Register 039h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | USE COMMON TEST PATTERN | R／W | Oh | $0=$ Each data stream sends test patterns programmed by <br> bits $[3: 0]$ of register 37h． <br> $1=$ Test patterns are individually programmed for the I and Q <br> stream of each DDC using the TEST PATTERN DDCx $y$－DATA <br> register bits（where $x=1$ or 2 and $y=1$ or Q）． |

8．5．12．23 Register 03Ah（address $=03 A h$ ），Decimation Filter Page
图 8－105．Register 03Ah

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | TEST PAT RES | TP RES EN |
| $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $R / W-0 h$ | $R / W-0 h$ |

表 8－97．Register 03Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-2$ | 0 | W | Oh | Must write 0 |
| 1 | TEST PAT RES | R／W | Oh | Pulsing this bit resets the test pattern．The test pattern reset <br> must be enabled first（bit D0）． <br> $0=$ Normal operation <br> $1=$ Reset the test pattern |
| 0 | TP RES EN | R／W | Oh | This bit enables the test pattern reset． <br> $0=$ Reset disabled <br> $1=$ Reset enabled |

## 8．5．13 Power Detector Page

## 8．5．13．1 Register 000h（address $=000 \mathrm{~h}$ ），Power Detector Page

图 8－106．Register 000h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | PKDET EN |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |

表 8－98．Register 000h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | PKDET EN | R／W | Oh | This bit enables the peak power and crossing detector． <br> $0=$ Power detector disabled <br> $1=$ Power detector enabled |

## 8．5．13．2 Register 001h－002h（address $=001 \mathrm{~h}-002 \mathrm{~h}$ ），Power Detector Page

图8－107．Register 001h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

图 8－108．Register 002h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

表 8－99．Register 001h－002h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7－0 | BLKPKDET | R／W | Oh | This register specifies the block length in terms of number of samples（ $\mathrm{S}^{\prime}$ ）used for peak power computation．Each sample $S$ is a peak of 8 actual ADC samples．This parameter is a 17 －bit value directly in linear scale．In decimation mode，the block length must be a multiple of a divide－by－4 or -6 complex：length $=5 \times$ decimation factor． <br> The divide－by－8 to -32 complex：length $=10 \times$ decimation factor． |

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## 8．5．13．3 Register 003h（address＝003h），Power Detector Page

图8－109．Register 003h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | BLKPKDET［16］ |
| $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | $W-0 h$ | W－0h | R／W－Oh |  |

表 8－100．Register 003h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | BLKPKDET［16］ | R／W | Oh | This register specifies the block length in terms of number of <br> samples（S＇）used for peak power computation．Each sample S <br> is a peak of 8 actual ADC samples．This parameter is a 17－bit <br> value directly in linear scale．In decimation mode，the block <br> length must be a multiple of a divide－by－4 or -6 complex：length <br> $=5 \times$ decimation factor． <br> The divide－by－8 to -32 complex：length $=10 \times$ decimation factor． |

8．5．13．4 Register 007h－00Ah（address $=007 h-00 A h$ ），Power Detector Page
图8－110．Register 007h

| 7 | 6 | 5 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| BLKTHHH |  |  |  |  |  |  |
| R／W－Oh |  |  |  |  |  |  |

图8－111．Register 008h

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  | BLKTHHL |

图8－112．Register 009h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

图 8－113．Register 00Ah

| 7 | 6 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| BLKTHLL |  |  |  |  |  |  |
| R／W－Oh |  |  |  |  |  |  |

表 8－101．Register 007h－00Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | BLKTHHH <br> BLKTHHL <br> BLKTHLH <br> BLKTHLL | R／W | Oh | These registers set the four different thresholds for the <br> hysteresis function threshold values from 0 to $256(2 T H)$, where <br> 256 is equivalent to the peak amplitude． <br> Example：BLKTHHH is set to -2 dBFS from peak： $10(-2 / 20) \times 256$ <br> $=203$, then set 5407h， $5 \mathrm{CO} 07 \mathrm{~h}=$ CBh． |

## 8．5．13．5 Register 00Bh－00Ch（address $=00 B h-00 C h$ ），Power Detector Page

图 8－114．Register 00Bh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DWELL［7：0］ |  |  |  |  |  |  |  |
| R／W－Oh |  |  |  |  |  |  |  |

图 8－115．Register 00Ch

| 7 | 6 | 4 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  |  |  |  |  |

表 8－102．Register 00Bh－00Ch Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DWELL | R／W | Oh | DWELL time counter． <br> When the computed block peak crosses the upper thresholds <br> BLKTHHH or BLKTHLH，the peak detector output flags are set． <br> In order to be reset，the computed block peak must remain <br> continuously lower than the lower threshold（BLKTHHL or <br> BLKTHLL）for the period specified by the DWELL value．This <br> threshold is 16 bits，is specified in terms of $\mathrm{f}_{\mathrm{S}} / 8$ clock cycles， <br> and must be set to 0 for the crossing detector．Example：if $f_{S}=3$ <br> GSPS， $\mathrm{f}_{\mathrm{S}} / 8=375 \mathrm{MHz}$, and DWELL $=0100 \mathrm{~h}$ then the DWELL <br> time $=2^{9} / 375 \mathrm{MHz=1.36} \mu \mathrm{~s}$. |

## 8．5．13．6 Register 00Dh（address $=00 \mathrm{Dh}$ ），Power Detector Page

图 8－116．Register 00Dh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | FILTOLPSEL |
| $W-O h$ | $W-O h$ | $W-O h$ | $W-O h$ | $W-O h$ | W－Oh |  |  |

表 8－103．Register 00Dh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | FILTOLPSEL | R／W | Oh | This bit selects either the block detector output or 2－bit output as <br> the input to the IIR filter． <br> $0=$ Use the output of the high comparators（HH and HL）as the <br> input of the IIR filter <br> $1=$ Combine the output of the high（HH and HL）and low（LH <br> and LL）comparators to generate a 3－level input to the IIR filter <br> $(-1,0,1)$ |

## 8．5．13．7 Register 00Eh（address $=00 E h$ ），Power Detector Page

图8－117．Register 00Eh

| 7 | 6 | 5 | 4 | 3 | 2 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 |  | TIMECONST |
| $W-0 h$ | $W-0 h$ | $W-O h$ | $R / W-O h$ |  |  |

## 表 8－104．Register 00Eh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | 0 h | Must write 0 |
| $3-0$ | TIMECONST | R／W | 0 h | These bits set the crossing detector time period for $N=0$ to 15 <br> as $2^{N} \times f_{S} / 8$ clock cycles．The maximum time period is $32768 \times$ <br> $f_{S} / 8$ clock cycles（approximately $87 \mu \mathrm{~s}$ at 3 GSPS$)$. |

## 8．5．13．8 Register 00Fh，010h－012h，and 016h－019h（address＝00Fh，010h－012h，and 016h－019h），Power Detector Page

图8－118．Register 00Fh

| 7 | 6 | 5 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | FILOTHH［7：0］ |  |  |  |  |

图 8－119．Register 010h

| 7 | 6 | 5 | 4 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | FILOTHH［15：8］ |  |  |  |  |

图 8－120．Register 011h

| 7 | 6 | 5 | 4 | 3 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | FILOTHL［7：0］ |  |  |  |  |
|  | R／W－Oh |  |  |  |  |

图8－121．Register 012h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

图 8－122．Register 016h

| 7 | 6 | 5 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | FIL1THH［7：0］ |  |  |  |  |

图8－123．Register 017h

| 7 | 6 | 5 | 4 | 3 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | FIL1THH［15：8］ |  |  |  |  |

图 8－124．Register 018h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

图8－125．Register 019h
$\left.\begin{array}{|lllllll|}\hline 7 & 6 & 5 & 4 & 3 & 2 & 1\end{array}\right]$

表 8－105．Register 00Fh，010h，011h，012h，016h，017h，018h，and 019h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | FILOTHH | R／W | Oh | Comparison thresholds for the crossing detector counter．This <br> threshold is 16 bits in 2．14 signed notation．A value of 1 （4000h） <br> corresponds to $100 \%$ crossings，a value of 0.125 （0800h） <br> corresponds to $12.5 \%$ crossings． |
|  | FIL1THH <br> FIL1THL |  |  | lens |

8．5．13．9 Register 013h－01Ah（address＝013h－01Ah），Power Detector Page
图8－126．Register 013h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | IIRO 2BIT EN |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |

图 8－127．Register 01Ah

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | IIR1 2BIT EN |
| W－Oh | W－Oh | $W$ W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |

表 8－106．Register 013h and 01Ah Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | IIR0 2BIT EN <br> IIR1 2BIT EN | R／W | Oh | This bit enables 2－bit output format of the IIR0 and IIR1 output <br> comparators． <br> $0=$ Selects 1－bit output format <br> $1=$ Selects 2－bit output format |

## 8．5．13．10 Register 01Dh－01Eh（address＝01Dh－01Eh），Power Detector Page

图 8－128．Register 01Dh

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  |

图 8－129．Register 01Eh

| 7 | 6 | 5 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  |  |  |  |  |

表 8－107．Register 01Dh－01Eh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | DWELLIIR | R／W | Oh | DWELL time counter for the IIR output comparators．When the <br> IIR filter output crosses the upper thresholds FILOTHH or <br> FIL1THH，the IIR peak detector output flags are set．In order to <br> be reset，the output of the IIR filter must remain continuously <br> lower than the lower threshold（FILOTHL or FIL1THL）for the <br> period specified by the DWELLIIR value．This threshold is 16 <br> bits and is specified in terms of $f_{\mathrm{S}} / 8 \mathrm{clock} \mathrm{cycles}$. <br> Example：if $\mathrm{f}_{\mathrm{S}}=3 \mathrm{GSSS}, \mathrm{f}_{\mathrm{S}} / 8=375 \mathrm{MHz}$, and DWELLIIR $=$ <br> $0100 h$, then the DWELL time $=29 / 375 \mathrm{MHz}=1.36 \mu \mathrm{~s}$. |

## 8．5．13．11 Register 020h（address $=020 h$ ），Power Detector Page

图 8－130．Register 020h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | RMSDET EN |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |

表 8－108．Register 020h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | RMSDET EN | R／W | Oh | This bit enables the RMS power detector． <br> $0=$ Power detector disabled <br> $1=$ Power detector enabled |

## 8．5．13．12 Register 021h（address＝021h），Power Detector Page

图8－131．Register 021h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 |  | PWRDETACCU |  |  |
| W－Oh | W－Oh | W－Oh | R／W－Oh |  |  |  |

表 8－109．Register 021h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-5$ | 0 | W | Oh | Must write 0 |
| $4-0$ | PWRDETACCU | R／W | Oh | These bits program the block length to be used for RMS power <br> computation． <br> The block length is defined in terms of $f_{S} / 8$ clocks and can be <br> programmed as 2M，where $M=0$ to 16. |

## 8．5．13．13 Register 022h－025h（address $=022 h-025 h$ ），Power Detector Page

图8－132．Register 022h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

图 8－133．Register 023h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

图 8－134．Register 024h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

图 8－135．Register 025h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |

表 8－110．Register 022h－025h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-0$ | PWRDETH［15：0］ <br> PWRDETL［15：0］ | R／W | Oh | The computed average power is compared against these high and low <br> thresholds．One LSB of the thresholds represents $1 / 2^{16}$. <br> Example：if PWRDETH is set to -14 dBFS from peak，$\left(10^{(-14 / 20)}\right)^{2} \times 2^{16}=$ <br> 2609，then set $5422 \mathrm{~h}, 5423 \mathrm{~h}, 5 \mathrm{C} 22 \mathrm{~h}, 5 \mathrm{C} 23 \mathrm{~h}=0 \mathrm{~A} 31 \mathrm{~h}$. |

## 8．5．13．14 Register 027h（address＝027h），Power Detector Page

图 8－136．Register 027h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | RMS 2BIT EN |
| W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | W－Oh | R／W－Oh |

表 8－111．Register 027h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-1$ | 0 | W | Oh | Must write 0 |
| 0 | RMS 2BIT EN | R／W | Oh | This bit enables 2－bit output format on the RMS output <br> comparators． <br> $0=$ Select 1－bit output format <br> $1=$ Selects 2－bit output format |

## 8．5．13．15 Register 02Bh（address $=02 B h$ ），Power Detector Page

图 8－137．Register 02Bh

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | RESET AGC | 0 | 0 | 0 | 0 |
| $W-O h$ | $W-O h$ | R／W－Oh | $W-0 h$ | $W-0 h$ | $W-0 h$ |  |  |

表 8－112．Register 02Bh Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :--- | :--- | :--- | :--- |
| $7-5$ | 0 | W | Oh | Must write 0 |
| 4 | RESET AGC | R／W | Oh | After configuration，the AGC module must be reset and then <br> brought out of reset to start operation． <br> $0=$ Clear AGC reset <br> $1=$ Set AGC reset <br> Example：set 542Bh to 10h and then to 00h． |
| $3-0$ | 0 | W | Oh | Must write 0 |

## 8．5．13．16 Register 032h－035h（address＝032h－035h），Power Detector Page

图 8－138．Register 032h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

图 8－139．Register 033h

| 7 | 6 | 5 | 3 | 2 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  |  |  |  |  |

图 8－140．Register 034h

| 7 | 6 | 5 | 4 | 3 | 2 | 1 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

图 8－141．Register 035h

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  |  |  |  |  |  |
| OUTSEL GPIO2 |  |  |  |  |  |  |

表 8－113．Register 032h－035h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :---: | :---: | :---: | :---: | :---: |
| 7－0 | OUTSEL GPIO1 OUTSEL GPIO2 OUTSEL GPIO3 OUTSEL GPIO4 | R／W | Oh | These bits set the function or signal for each GPIO pin． <br> $0=\operatorname{IIR}$ PK DETO［0］of channel A <br> $1=$ IIR PK DETO［1］of channel A（2－bit mode） <br> $2=\operatorname{IIR}$ PK DET1［ 0$]$ of channel $A$ <br> 3 ＝IIR PK DET1［1］of channel A（2－bit mode） <br> $4=$ BLKPKDETH of channel A <br> $5=$ BLKPKDETL of channel A <br> $6=$ PWR Det［0］of channel A <br> 7 ＝PWR Det［1］of channel A（2－bit mode） <br> $8=$ FOVR of channel A <br> 9－17＝Repeat outputs 0－8 but for channel B instead |

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## 8．5．13．17 Register 037h（address $=037 h$ ），Power Detector Page

图 8－142．Register 037h

| 7 | 6 | 5 | 4 | 3 | 1 | 0 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | 0 | 0 | IODIR GPIO2 | IODIR GPIO3 | IODIR GPIO1 | IODIR GPIO4 |
| W－0h | W－Oh | W－0h | W－0h | R／W－0h | R／W－Oh | R／W－0h | R／W－0h |

表 8－114．Register 037h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-4$ | 0 | W | Oh | Must write 0 |
| $3-0$ | IODIRGPIO［4：1］ | R／W | Oh | These bits select the output direction for the GPIO［4：1］pins． <br> $0=$ Input（for the NCO control） <br> $1=$ Output（for the AGC alarm function） |

8．5．13．18 Register 038h（address $=038 h$ ），Power Detector Page
图 8－143．Register 038h

| 7 | 6 | 5 | 4 | 2 | 1 | 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 0 | INSEL1 | 0 | 0 | INSELO |  |
| W－Oh | W－Oh | R／W－0h | R／W－0h | R／W－Oh | R／W－Oh |  |

表 8－115．Register 038h Field Descriptions

| Bit | Field | Type | Reset | Description |
| :--- | :--- | :--- | :--- | :--- |
| $7-6$ | 0 | W | Oh | Must write 0 |

表 8－116．INSEL Bit Settings

| INSEL1 | INSEL2 | NCO SELECTED |
| :---: | :---: | :---: |
| 0 | 0 | NCO1 |
| 0 | 1 | NCO2 |
| 1 | 0 | NCO3 |
| 1 | 1 | n／a |

## 9 Application and Implementation

## 备注

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客 户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

## 9．1 Application Information

## 9．1．1 Start－Up Sequence

The steps in 表 9－1 are recommended as the power－up sequence when the ADC32RF8x is in the decimation－ by－4 complex output mode．

表 9－1．Initialization Sequence
$\left.\begin{array}{|l|l|l|l|}\hline \text { STEP } & \text { DESCRIPTION } & \begin{array}{l}\text { PAGE，REGISTER ADDRESS } \\ \text { AND DATA }\end{array} & \text { COMMENT } \\ \hline 1 & \begin{array}{l}\text { Supply all supply voltages．There } \\ \text { is no required power－supply } \\ \text { sequence for the 1．15 V，1．2 V，} \\ \text { and 1．9 V supplies，and can be } \\ \text { supplied in any order．}\end{array} & - & - \\ \hline 2 & \text { Provide the SYSREF signal．} & - & - \\ \hline 3 & \begin{array}{l}\text { Pulse a hardware reset（low－to－} \\ \text { high－to－low）on pins 33 and 34．}\end{array} & - & - \\ \hline 4 & \begin{array}{l}\text { Write the register addresses } \\ \text { described in the } \\ \text { PowerUpConfigfile．}\end{array} & \text { Seethe files located in SBAA226 } & \begin{array}{l}\text { ThePower－up config file contains } \\ \text { analog trim registers that are } \\ \text { required for best performance of } \\ \text { the ADC．Write these registers } \\ \text { every time after power up．}\end{array} \\ \hline 5 & \begin{array}{l}\text { Write the register addresses } \\ \text { mentioned in the } \\ \text { ILConfigNyqX＿ChA file，where } \\ \text { is the Nyquist zone．}\end{array} & \text { Seethe files located in SBAA226 } & \begin{array}{l}\text { Based on the signal band of } \\ \text { interest，provide the Nyquist zone } \\ \text { information to the device．}\end{array} \\ \hline 6 & \begin{array}{l}\text { Write the register addresses } \\ \text { mentioned in the } \\ \text { LLConfigNyqX＿ChB file，where }\end{array} & \text { Seethe files located in SBAA226 } \\ \text { is the Nyquist zone．}\end{array} \quad \begin{array}{l}\text { This step optimizes device＇} \\ \text { performance by reducing } \\ \text { interleaving mismatch errors．}\end{array}\right\}$

## 9．1．2 Hardware Reset

Timing information for the hardware reset is shown in 图 9－1 and 表 9－2．


图 9-1. Hardware Reset Timing Diagram
表 9-2. Hardware Reset Timing Information

|  |  | MIN | TYP |
| :--- | :--- | :---: | :---: |
| $t_{1}$ | Power-on delay from power-up to active high RESET pulse | 1 | MAX |
| $t_{2}$ | Reset pulse duration: active high RESET pulse duration | 1 | ms |
| $t_{3}$ | Register write delay from RESET disable to SEN active | 100 | $n s$ |

## 9．1．3 SNR and Clock Jitter

The signal－to－noise ratio（SNR）of the ADC is limited by three different factors：quantization noise，thermal noise， and jitter，as shown in 方程式 5 ．The quantization noise is typically not noticeable in pipeline converters and is 84 dB for a 14－bit ADC．The thermal noise limits the SNR at low input frequencies and the clock jitter sets the SNR for higher input frequencies．

$$
\begin{equation*}
\operatorname{SNRADC}[\mathrm{dBc}]=-20 \log \sqrt{\left(10^{-\frac{\mathrm{SNR}_{\text {Quantization Noise }}}{20}}\right)^{2}+\left(10^{\left.-\frac{S N R_{\text {Thermal Noise }}}{20}\right)^{2}+\left(10^{-\frac{S N R_{\text {jiter }}}{20}}\right)^{2}}\right.} \tag{5}
\end{equation*}
$$

The SNR limitation resulting from sample clock jitter can be calculated by 方程式 6：

$$
\begin{equation*}
\operatorname{SNR}_{\text {Jitter }}[\mathrm{dBc}]=-20 \log \left(2 \pi \times \mathrm{f}_{\mathbb{N}} \times \mathrm{t}_{\text {jitter }}\right) \tag{6}
\end{equation*}
$$

The total clock jitter（ $\mathrm{T}_{\text {jitter }}$ ）has two components：the internal aperture jitter $\left(90 \mathrm{f}_{\mathrm{S}}\right)$ is set by the noise of the clock input buffer and the external clock jitter． $\mathrm{T}_{\text {jitter }}$ can be calculated by 方程式 7：

$$
\begin{equation*}
\mathrm{t}_{\text {jitter }}=\sqrt{\left(\mathrm{t}_{\text {jitter }}, \text { Ext_Clock_Input }\right)^{2}+\left(\mathrm{t}_{\text {Aperture_ADC }}\right)^{2}} \tag{7}
\end{equation*}
$$

External clock jitter can be minimized by using high－quality clock sources and jitter cleaners as well as band－ pass filters at the clock input．A faster clock slew rate also improves the ADC aperture jitter．

The ADC32RF8x has a thermal noise of approximately 63 dBFS and an internal aperture jitter of $90 \mathrm{f}_{\mathrm{s}}$ ．The SNR，depending on the amount of external jitter for different input frequencies，is shown in 图 9－2．


图 9－2．ADC SNR vs．Input Frequency and External Clock Jitter

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## 9．1．3．1 External Clock Phase Noise Consideration

External clock jitter can be calculated by integrating the phase noise of the clock source out to approximately two times of the ADC sampling rate（ $2 \times \mathrm{f}_{\mathrm{S}}$ ），as shown in 图9－3．In order to maximize the ADC SNR，an external band－pass filter is recommended to be used on the clock input．This filter reduces the jitter contribution from the broadband clock phase noise floor by effectively reducing the integration bandwidth to the pass band of the band－pass filter．This method is suitable when estimating the overall ADC SNR resulting from clock jitter at a certain input frequency．


图 9－3．Integration Bandwidth for Extracting Jitter from Clock Phase Noise
However，when estimating the affect of a nearby blocker（such as a strong in－band interferer to the sensitivity， the phase noise information can be used directly to estimate the noise budget contribution at a certain offset frequency，as shown in 图 9－4．


图 9－4．Small Wanted Signal in Presence of Interferer
At the sampling instant，the phase noise profile of the clock source convolves with the input signal（for example， the small wanted signal and the strong interferer merge together）．If the power of the clock phase noise in the signal band of interest is too large，the wanted signal cannot not be recovered．

The resulting equivalent phase noise at the ADC input is also dependent on the sampling rate of the ADC and frequency of the input signal．The ADC sampling rate scales the clock phase noise，as shown in 方程式 8.

$$
\begin{equation*}
\mathrm{ADC}_{\mathrm{NSD}}(\mathrm{dBc} / \mathrm{Hz})=\mathrm{PN}_{\mathrm{CLK}}(\mathrm{dBc} / \mathrm{Hz})-20 \times \log \left(\frac{\mathrm{f}_{\mathrm{S}}}{\mathrm{f}_{\mathrm{IN}}}\right) \tag{8}
\end{equation*}
$$

Using this information，the noise contribution resulting from the phase noise profile of the ADC sampling clock can be calculated．

### 9.1.4 Power Consumption in Different Modes

The ADC32RF8x consumes approximately 6.6 W of power when both channels are active with a divide-by-4 complex output. When different DDC options are used, the power consumption on the DVDD supply changes by a small amount but remains unaffected on other supplies. In the applications requiring just one channel to be active, channel A must be chosen as the active channel and channel B can be powered down. Power consumption reduces to approximately 4 W in single-channel operation with a divide-by-4 option at a 2949.12MSPS device clock rate.

表 9-3 shows power consumption in different DDC modes for dual-channel and single-channel operation.
表 9-3. Power Consumption in Different DDC Modes (Sampling Clock Frequency, $\mathrm{f}_{\mathrm{S}}=3$ GSPS)

| DECIMATION <br> OPTION | ACTIVE <br> CHANNEL | ACTIVE DDC | AVDD19 (mA) | AVDD (mA) | DVDD (mA) | TOTAL POWER <br> (mW) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Divide-by-4 | Channels A, B | Single | 1777 | 970 | 1785 | 6545 |
| Divide-by-8 | Channels A, B | Dual | 1777 | 973 | 1960 | 6749 |
| Divide-by-8 | Channels A, B | Single | 1777 | 973 | 1730 | 6485 |
| Divide-by-16 | Channels A, B | Dual | 1777 | 972 | 1971 | 6761 |
| Divide-by-16 | Channels A, B | Single | 1777 | 972 | 1705 | 6455 |
| Divide-by-24 | Channels A, B | Dual | 1771 | 975 | 1938 | 6715 |
| Divide-by-24 | Channels A, B | Single | 1771 | 972 | 1667 | 6400 |
| Divide-by-32 | Channels A, B | Dual | 1768 | 972 | 1835 | 6587 |
| Divide-by-32 | Channels A, B | Single | 1768 | 970 | 1574 | 6285 |
| Divide-by-4 | Channel A | Single | 961 | 796 | 1096 | 4002 |
| Divide-by-8 | Channel A | Dual | 961 | 790 | 1168 | 4078 |
| Divide-by-8 | Channel A | Single | 961 | 786 | 1047 | 3934 |
| Divide-by-16 | Channel A | Dual | 961 | 789 | 1172 | 4081 |
| Divide-by-16 | Channel A | Single | 961 | 786 | 1045 | 3932 |
| Divide-by-24 | Channel A | Dual | 958 | 785 | 1155 | 4051 |
| Divide-by-24 | Channel A | Single | 958 | 787 | 1016 | 3894 |
| Divide-by-32 | Channel A | Dual | 956 | 788 | 1104 | 3992 |
| Divide-by-32 | Channel A | Single | 956 | 786 | 978 | 3845 |

## 9．1．5 Using DC Coupling in the ADC32RF8x

The ADC32RF8x can be used in dc－coupling applications．However，the following points must be considered when designing the system：
1．Ensure that the correct common－mode voltage is used at the ADC analog inputs．
The analog inputs are internally self－biased to $\mathrm{V}_{\mathrm{CM}}$ through approximately a $33-\Omega$ resistor．The internal biasing resistors also function as a termination resistor．However，if a different termination is required，the external resistor $\mathrm{R}_{\text {TERM }}$ can be differentially placed between the analog inputs，as shown in 图 9－5．The amplifier $\mathrm{V}_{\text {OCM }}$ pin is recommended to be driven from the CM pin of the ADC to help the amplifier output common－mode voltage track the required common－mode voltage of the ADC．


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A．Set the INCR CM IMPEDANCE bit to increase the RCM from $0 \Omega$ to $>5000 \Omega$ ．
B．$R_{\mathrm{DC}}$ is approximately $65 \Omega$ ．

## 图 9－5．The ADC32RF8x in a DC－Coupling Application

2．Ensure that the correct SPI settings are written to the ADC．
As shown in 图 9－6，the ADC32RF8x has a digital block that estimates and corrects the offset mismatch among four interleaving ADC cores for a given channel．


图 9－6．Offset Corrector in the ADC32RF8x
The offset corrector block nullifies $\mathrm{dc}, \mathrm{f}_{\mathrm{S}} / 8, \mathrm{f}_{\mathrm{S}} / 4,3 \mathrm{f}_{\mathrm{S}} / 8$ ，and $\mathrm{f}_{\mathrm{S}} / 2$ ．The resulting spectrum becomes free from static spurs at these frequencies．The corrector continuously processes the data coming from the interleaving ADC cores and cannot distinguish if the tone at these frequencies is part of signal or if the tone originated from a mismatch among the interleaving ADC cores．Thus，in applications where the signal is present at these frequencies，the offset corrector block can be bypassed．

## 9．1．5．1 Bypassing the Offset Corrector Block

When the offset corrector is bypassed，offset mismatch among interleaving ADC cores appears in the ADC output spectrum．To correct the effects of mismatch，place the ADC in an idle channel state（no signal at the ADC inputs）and the corrector must be allowed to run for some time to estimate the mismatch，then the corrector is frozen so that the last estimated value is held．Required register writes are provided in 表 9－4．

表 9－4．Freezing and Bypassing the Offset Corrector Block

| STEP | REGISTER WRITE | COMMENT |
| :---: | :---: | :---: |
| STEPS FOR FREEZING THE CORRECTOR BLOCK |  |  |
| 1 | － | Signal source is turned off．The device detects an idle channel at its input． |
| 2 | － | Wait for at least 0.4 ms for the corrector to estimate the internal offset |
| 3 | Address 4001h，value 00h | Select Offset Corr Page Channel A |
|  | Address 4002h，value 00h |  |
|  | Address 4003h，value 00h |  |
|  | Address 4004h，value 61h |  |
|  | Address 6068h，value C2h | Freeze the corrector for channel A |
|  | Address 4003h，value 01h | Select Offset Corr Page Channel B |
|  | Address 6068h，value C2h | Freeze the corrector for channel B |
| 4 | － | Signal source can now be turned on |
| STEPS FOR BYPASSING THE CORRECTOR BLOCK |  |  |
| 1 | Address 4001h，value 00h | － |
|  | Address 4002h，value 00h |  |
|  | Address 4003h，value 00h |  |
|  | Address 4004h，value 61h | Select Offset Corr Page Channel A |
|  | Address 6068h，value 46h | Disable the corrector for channel A |
|  | Address 4003h，value 01h | Select Offset Corr Page Channel B |
|  | Address 6068h，value 46h | Disable the corrector for channel B |

## 9．1．5．1．1 Effect of Temperature

图 9－7 and 图 9－8 show the behavior of $\mathrm{nf}_{\mathrm{S}} / 8$ tones with respect to temperature when the offset corrector block is frozen or disabled．


## 9．2 Typical Application

The ADC32RF8x is designed for wideband receiver applications demanding high dynamic range over a large input frequency range．A typical schematic for an ac－coupled receiver is shown in 图 9－9．

Decoupling capacitors with low ESL are recommended to be placed as close as possible at the pins indicated in图 9－9．Additional capacitors can be placed on the remaining power pins．


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图 9－9．Typical Application Implementation Diagram

## 9．2．1 Design Requirements

## 9．2．1．1 Transformer－Coupled Circuits

Typical applications involving transformer－coupled circuits are discussed in this section．To ensure good amplitude and phase balance at the analog inputs，transformers（such as TC1－1－13 and TC1－1－43）can be used from the dc to $1000-\mathrm{MHz}$ range and from the $1000-\mathrm{MHz}$ to $4-\mathrm{GHz}$ range of input frequencies，respectively．When designing the driving circuits，the ADC input impedance（or SDD11）must be considered．

By using the simple drive circuit of 图9－10，uniform performance can be obtained over a wide frequency range． The buffers present at the analog inputs of the device help isolate the external drive source from the switching currents of the sampling circuit．


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图 9－10．Input Drive Circuit

## 9．2．2 Detailed Design Procedure

For optimum performance，the analog inputs must be driven differentially．This architecture improves common－ mode noise immunity and even－order harmonic rejection．A small resistor（ $5 \Omega$ to $10 \Omega$ ）in series with each input pin is recommended to damp out ringing caused by package parasitics，as shown in 图 9－10．

## 9．2．3 Application Curves

图 9－11 and 图 9－12 show the typical performance at 100 MHz and 1780 MHz ，respectively．


图 9－11．FFT for $100-\mathrm{MHz}$ Input Frequency


$$
\mathrm{SNR}=57.9 \mathrm{dBFS}, \mathrm{SINAD}=57.1 \mathrm{dBFS}, \mathrm{HD} 2=63 \mathrm{dBc}, \mathrm{HD} 3
$$

$$
=66 \mathrm{dBc}, \mathrm{SFDR}=63 \mathrm{dBc}, \mathrm{THD}=60 \mathrm{dBc}, \text { IL spur }=79 \mathrm{dBc}
$$

$$
\text { worst spur }=77 \mathrm{dBc}
$$

图 9－12．FFT for $\mathbf{1 7 8 0}-\mathrm{MHz}$ Input Frequency

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## 10 Power Supply Recommendations

The DVDD power supply ( 1.15 V ) must be stable before ramping up the AVDD19 supply ( 1.9 V ), as shown in 图 $10-1$. The AVDD supply ( 1.15 V ) can come up in any order during the power sequence. The power supplies can ramp up at any rate and there is no hard requirement for the time delay between DVDD ( 1.15 V ) ramping up to AVDD (1.9 V) ramping up (which can be in orders of microseconds but is recommended to be a few milliseconds).


图 10-1. Power Sequencing for the ADC32RF8x Family of Devices

## 11 Layout

## 11．1 Layout Guidelines

The device evaluation module（EVM）layout can be used as a reference layout to obtain the best performance．A layout diagram of the EVM top layer is provided in 图 11－1．The ADC32RF45／RF80 EVM Quick Startup Guide provides a complete layout of the EVM．Some important points to remember during board layout are：
－Analog inputs are located on opposite sides of the device pinout to ensure minimum crosstalk on the package level．To minimize crosstalk onboard，the analog inputs must exit the pinout in opposite directions，as shown in the reference layout of 图 11－1 as much as possible．
－In the device pinout，the sampling clock is located on a side perpendicular to the analog inputs in order to minimize coupling．This configuration is also maintained on the reference layout of 图11－1 as much as possible．
－Keep digital outputs away from the analog inputs．When these digital outputs exit the pinout，the digital output traces must not be kept parallel to the analog input traces because this configuration can result in coupling from the digital outputs to the analog inputs and degrade performance．All digital output traces to the receiver ［such as field－programmable gate arrays（FPGAs）or application－specific integrated circuits（ASICs）］must be matched in length to avoid skew among outputs．
－At each power－supply pin（AVDD，DVDD，or AVDD19），keep a $0.1-\mu \mathrm{F}$ decoupling capacitor close to the device．A separate decoupling capacitor group consisting of a parallel combination of $10-\mu \mathrm{F}, 1-\mu \mathrm{F}$ ，and $0.1-\mu \mathrm{F}$ capacitors can be kept close to the supply source．

## 11．2 Layout Example



图 11－1．ADC32RF8xEVM Layout

## 12 Device and Documentation Support

## 12．1 Documentation Support

## 12．1．1 Related Documentation

For related documentation see the following：
－ADC32RF45／RF80 EVM Quick Startup Guide
－Configuration Files for the ADC32RF45

## 12.2 接收文档更新通知

要接收文档更新通知，请导航至 ti．com 上的器件产品文件夹。点击订阅更新进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

## 12.3 支持资源

TI E2E ${ }^{T M}$ 支持论坛是工程师的重要参考资料，可直接从专家获得快速，经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者＂按原样＂提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的《使用条款》。

## 12．4 Trademarks

TI E2E ${ }^{\text {TM }}$ is a trademark of Texas Instruments．
所有商标均为其各自所有者的财产。

## 12．5 Electrostatic Discharge Caution

This integrated circuit can be damaged by ESD．Texas Instruments recommends that all integrated circuits be handled with appropriate precautions．Failure to observe proper handling and installation procedures can cause damage．
ESD damage can range from subtle performance degradation to complete device failure．Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications．

## 12.6 术语表

TI 术语表 本术语表列出并解释了术语，首字母缩略词和定义。

## 13 Mechanical，Packaging，and Orderable Information

The following pages include mechanical，packaging，and orderable information．This information is the most current data available for the designated devices．This data is subject to change without notice and revision of this document．For browser－based versions of this data sheet，refer to the left－hand navigation．

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InSTRUMENTS

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead finish/ Ball material <br> (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADC32RF80IRMPR | ACTIVE | VQFN | RMP | 72 | 1500 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | AZ32RF80 | Samples |
| ADC32RF80IRMPT | ACTIVE | VQFN | RMP | 72 | 250 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | AZ32RF80 | Samples |
| ADC32RF80IRRHR | ACTIVE | VQFN | RRH | 72 | 1500 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | AZ32RF80 | Samples |
| ADC32RF80IRRHT | ACTIVE | VQFN | RRH | 72 | 250 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | AZ32RF80 | Samples |
| ADC32RF83IRMPR | ACTIVE | VQFN | RMP | 72 | 1500 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | AZ32RF83 | Samples |
| ADC32RF83IRMPT | ACTIVE | VQFN | RMP | 72 | 250 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | AZ32RF83 | Samples |
| ADC32RF83IRRHR | ACTIVE | VQFN | RRH | 72 | 1500 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | AZ32RF83 | Samples |
| ADC32RF83IRRHT | ACTIVE | VQFN | RRH | 72 | 250 | RoHS \& Green | NIPDAU | Level-3-260C-168 HR | -40 to 85 | AZ32RF83 | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annul basis.

## TAPE AND REEL INFORMATION



TAPE DIMENSIONS


| A0 | Dimension designed to accommodate the component width |
| :--- | :--- |
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

Reel Width (W1)
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

| Device | Package <br> Type | Package <br> Drawing | Pins | SPQ | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> W1 (mm) | A0 <br> $(\mathbf{m m})$ | B0 <br> $(\mathbf{m m})$ | K0 <br> $(\mathbf{m m})$ | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADC32RF80IRRHR | VQFN | RRH | 72 | 1500 | 330.0 | 24.4 | 10.25 | 10.25 | 2.25 | 16.0 | 24.0 | Q2 |
| ADC32RF83IRMPR | VQFN | RMP | 72 | 1500 | 330.0 | 24.4 | 10.25 | 10.25 | 2.25 | 16.0 | 24.0 | Q2 |
| ADC32RF83IRRHR | VQFN | RRH | 72 | 1500 | 330.0 | 24.4 | 10.25 | 10.25 | 2.25 | 16.0 | 24.0 | Q2 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADC32RF80IRRHR | VQFN | RRH | 72 | 1500 | 350.0 | 350.0 | 43.0 |
| ADC32RF83IRMPR | VQFN | RMP | 72 | 1500 | 350.0 | 350.0 | 43.0 |
| ADC32RF83IRRHR | VQFN | RRH | 72 | 1500 | 350.0 | 350.0 | 43.0 |



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



NON SOLDER MASK DEFINED (PREFERRED)


SOLDER MASK DEFINED

SOLDER MASK DETAILS

NOTES: (continued)
4. This package is designed to be soldered to a thermal pad on the board. For more information, see QFN/SON PCB application report in literature No. SLUA271 (www.ti.com/lit/slua271).


NOTES: (continued)
5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.


NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.


SOLDER MASK DETAILS
NOTES: (continued)
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271)
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.


SOLDER PASTE EXAMPLE
BASED ON 0.125 MM THICK STENCIL
SCALE: 10X
EXPOSED PAD 73
60\% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE

NOTES: (continued)
6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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